USER'S MANUAL

S3CB519 8-Bit CMOS Microcontroller Revision 2



S3CB519

8-BIT CMOS MICROCONTROLLERS USER'S MANUAL

Revision 2



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S3CB519 8-Bit CMOS Microcontrollers User's Manual, Revision 2

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Preface

The S3CB519 Microcontroller User's Manual is designed for application designers and programmers who are using the S3CB519 microcontroller for application development. It is organized in two main parts:

Part I Programming Model Part II Hardware Descriptions

Part I contains software-related information to familiarize you with the microcontroller's architecture, programming model, instruction set, and interrupt structure. It has nine chapters:

Chapter 1	Product Overview	Chapter 5	Hardware Stack
Chapter 2	Address Spaces	Chapter 6	Exceptions
Chapter 3	Registers	Chapter 7	Coprocessor Interface
Chapter 4	Memory Map	Chapter 8	Instruction Set

Chapter 1, "Product Overview," is a high-level introduction to S3CB519 with general product descriptions, as well as detailed information about individual pin characteristics and pin circuit types.

Chapter 2, "Address Spaces," describes program and data memory spaces. Chapter 2 also describes ROM code option.

Chapter 3, "Register," describes the special registers.

Chapter 4, "Memory Map," describes the internal register file.

Chapter 5, "Hardware Stack," describes the S3CB519 hardware stack structure in detail.

Chapter 6, "Exceptions," describes the S3CB519 exception structure in detail.

A basic familiarity with the information in Part I will help you to understand the hardware module descriptions in Part II. If you are not yet familiar with the S3CB-series microcontroller family and are reading this manual for the first time, we recommend that you first read Chapters 1–3 carefully. Then, briefly look over the detailed information in Chapters 4, 5, 6, 7, 8, and 9. Later, you can reference the information in Part I as necessary.

Part II "Hardware descriptions," has detailed information about specific hardware components of the S3CB519 microcontroller. Also included in Part II are electrical, mechanical. It has 16 chapters:

Chapter 9	Clock Circuit	Chapter 18	LCD Controller/Driver
Chapter 10	nRESET and Power-Down	Chapter 19	A/D Converter
Chapter 11	I/O Ports	Chapter 20	D/A Converter
Chapter 12	Basic Timer/Watchdog Timer	Chapter 21	MAC 816
Chapter 13	Watch Timer	Chapter 22	Electrical Data
Chapter 14	16-Bit Timer (8-Bit Timer A & B)	Chapter 23	Mechanical Data
Chapter 15	8-Bit Timer (Timer 0)	Chapter 24	Development Tools
Chapter 16	Serial I/O Interface		
Chapter 17	Battery Level Detector		

Chapter 21, "MAC816" describes the MAC816 structure in detail, as well as instructions.

Two order forms are included at the back of this manual to facilitate customer order for S3CB519 microcontrollers: the Mask ROM Order Form, and the Mask Option Selection Form.

You can photocopy these forms, fill them out, and then forward them to your local Samsung Sales Representative.

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SWAP	Swap	8-94
SYS	System	8-95
TM	Test Multiple Bits	8-96
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S3CB519 PRODUCT OVERVIEW

1

PRODUCT OVERVIEW

OVERVIEW

The S3CB519 single-chip CMOS microcontroller is designed for high performance using Samsung's new 8-bit CPU core, CalmRISC.

CalmRISC is an 8-bit low power RISC microcontroller. Its basic architecture follows Harvard style, that is, it has separate program memory and data memory. Both instruction and data can be fetched simultaneously without causing a stall, using separate paths for memory access. Represented below is the top block diagram of the CalmRISC microcontroller.

PRODUCT OVERVIEW S3CB519

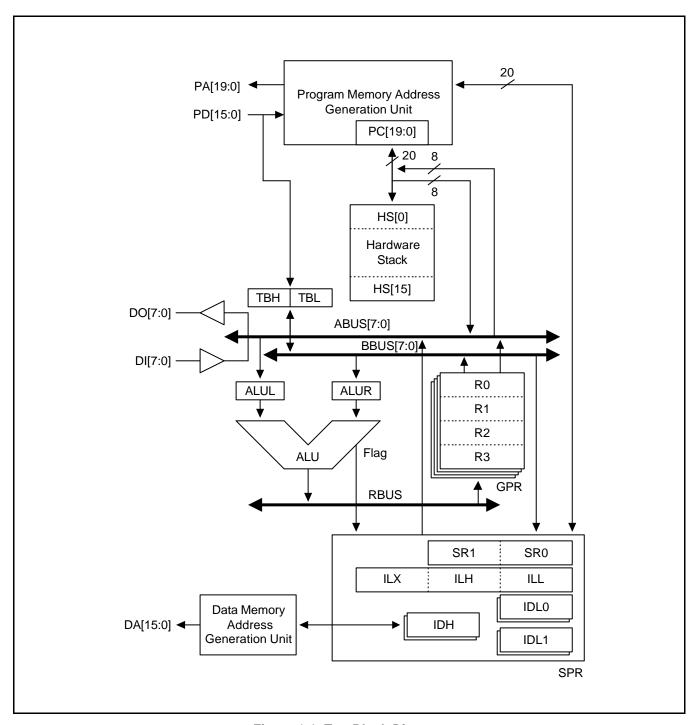


Figure 1-1. Top Block Diagram

S3CB519 PRODUCT OVERVIEW

The CalmRISC building blocks consist of:

- An 8-bit ALU
- 16 general purpose registers (GPR)
- 11 special purpose registers (SPR)
- 16-level hardware stack
- Program memory address generation unit
- Data memory address generation unit

Sixteen GPRs are grouped into four banks (Bank0 to Bank3), and each bank has four 8-bit registers (R0, R1, R2, and R3). SPRs, designed for special purposes, include status registers, link registers for branch-link instructions, and data memory index registers. The data memory address generation unit provides the data memory address (denoted as *DA[15:0]* in the top block diagram) for a data memory access instruction. Data memory contents are accessed through *DI[7:0]* for read operations and *DO[7:0]* for write operations. The program memory address generation unit contains a program counter, PC[19:0], and supplies the program memory address through *PA[19:0]* and fetches the corresponding instruction through *PD[15:0]* as the result of the program memory access. CalmRISC has a 16-level hardware stack for low power stack operations as well as a temporary storage area.

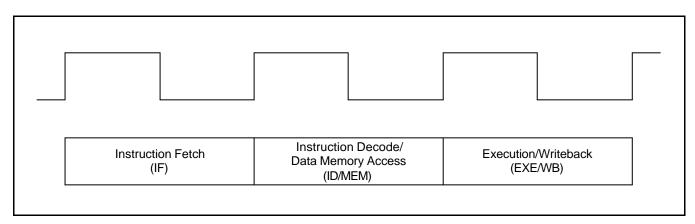


Figure 1-2. CalmRISC Pipeline Diagram

CalmRISC has a 3-stage pipeline as described below:

As can be seen in the pipeline scheme, CalmRISC adopts a register-memory instruction set. In other words, data memory where *R* is a GPR can be one operand of an ALU instruction as shown below:

The first stage (or cycle) is the Instruction fetch stage (IF for short), where the instruction pointed by the program counter, PC[19:0], is read into the Instruction Register (IR for short). The second stage is the Instruction Decode and Data Memory Access stage (ID/MEM for short), where the fetched instruction (stored in IR) is decoded and data memory access is performed, if necessary. The final stage is the Execute and Write-back stage (EXE/WB), where the required ALU operation is executed and the result is written back into the destination registers.

Since CalmRISC instructions are pipelined, the next instruction fetch is not postponed until the current instruction is completely finished but is performed immediately after completing the current instruction fetch. The pipeline stream of instructions is illustrated in the following diagram.

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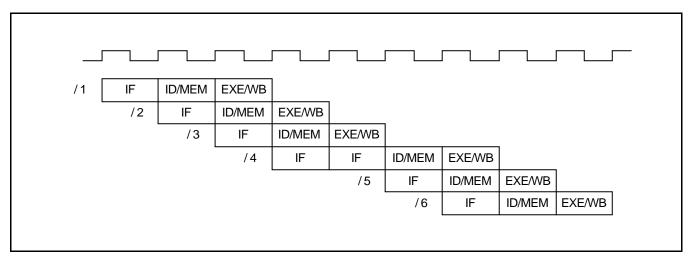


Figure 1-3. CalmRISC Pipeline Stream Diagram

Most CalmRISC instructions are 1-word instructions, while same branch instructions such as long "call" and "jp" instructions are 2-word instructions. In Figure 1-3, the instruction, *I4*, is a long branch instruction, and it takes two clock cycles to fetch the instruction. As indicated in the pipeline stream, the number of clocks per instruction (CPI) is 1 except for long branches, which take 2 clock cycles per instruction.

S3CB519 PRODUCT OVERVIEW

FEATURES

CPU

8-bit CalmRISC

Coprocessor

- MAC 816
- 8 × 16, 16 × 16 multiply and accumulation
- Arithmetic operation

Memory

ROM: 16K-word

RAM: 3K-byte

2048 (X-memory) 1024 (Y-memory)

I/O Pins

11 I/O: not include COM/SEG

35 I/O: include COM/SEG

Power-Down

Idle mode: only CPU clock stops

· Stop mode: main system oscillator stops

Sub-system clock stop mode

ROM Option

Basic timer counter clock source selection reset value

Watchdog timer enable/disable selection

8-Bit Basic Timer

- Programmable interval timer
- · 8 kinds of clock source

Watchdog Timer

System reset

Watch Timer

- Real time clock or interval time measurement
- Buzzer function (0.5/1/2/4 kHz at 4.19 MHz OSC)

Timer/Counters

- One 8-bit timer with PWM/Capture
- One 16-bit general-purpose timer/counter

LCD Controller/Driver

56 SEG × 16 COM terminals

- 8, 12 and 16 COM selectable
- 16-level contrast control
- · Key strobe output function

Battery Level Detector

- 2.4, 2.7, 3.0, 3.3, 4.0, 4.5 V detectable
- Internal level and/or external level selectable

8-Bit Serial I/O Interface

- 8-bit transmit/receive mode
- 8-bit receive mode
- LSB-first or MSB-first transmission selectable

A/D Converter

- Sigma delta ADC
- Linear 14-bit data (16-bit format)
- 256X over sampling
- Operation voltage: V_{DD} = 3.0 V–5.5 V

D/A Converter

- 8-bit resolution
- · Regulated output voltage
- Operation voltage: V_{DD} = 2.4 V–5.5 V

Oscillation Sources

- Crystal, ceramic, RC for main system clock
- Crystal or external oscillator for subsystem clock
- Main system clock frequency: Max 8.2 MHz
- Subsystem clock frequency: 32.768 kHz

Operating Voltage

2.2 V to 5.5 V

Operating Temperature Range

• −25 °C to 85 °C

Package Type

100-QFP-1420C, 100-TQFP-1414

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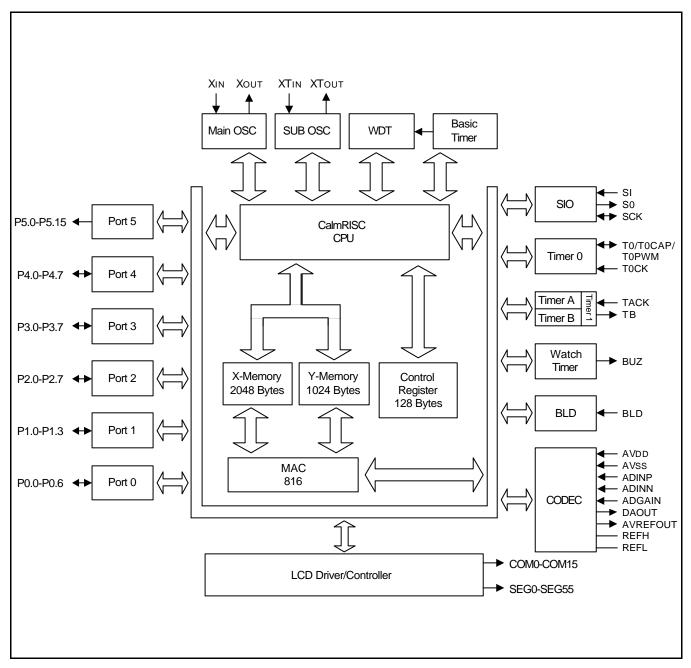


Figure 1-4. S3CB519 Block Diagram

S3CB519 PRODUCT OVERVIEW

PIN ASSIGNMENT

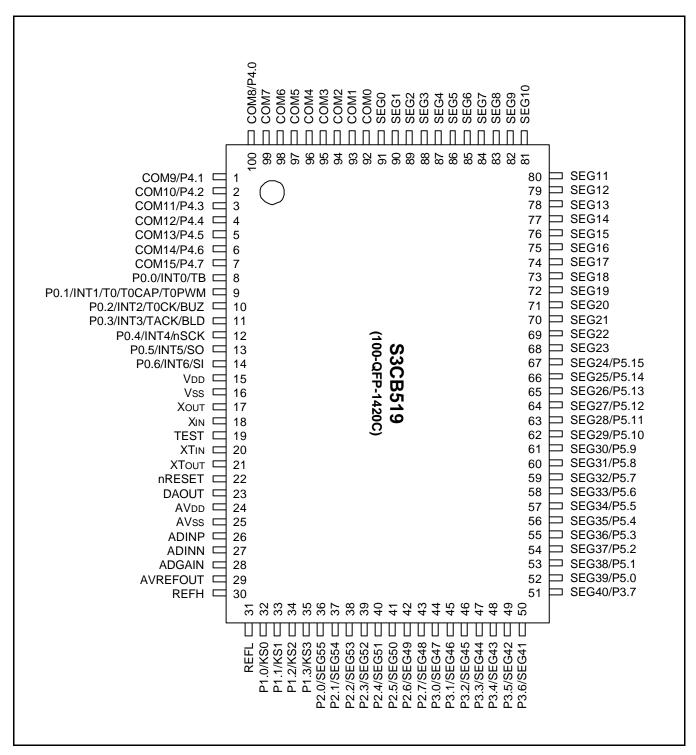


Figure 1-5. S3CB519 Pin Assignment Diagram (100-QFP)



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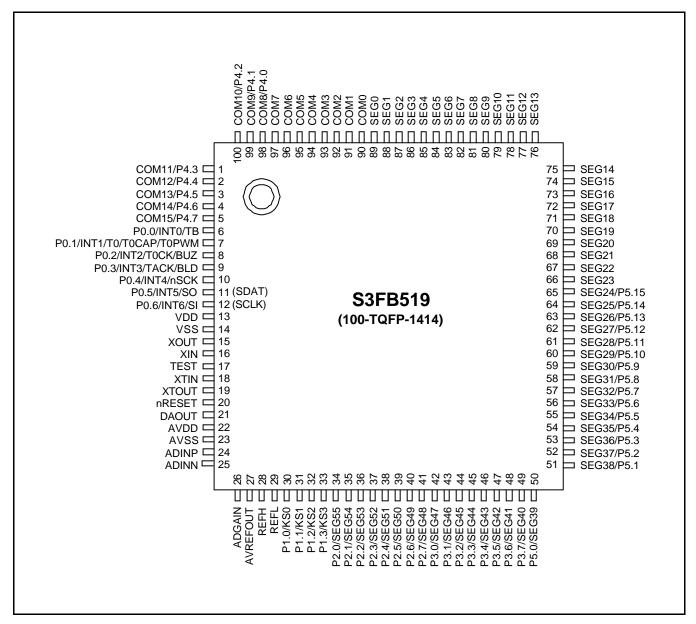


Figure 1-6. S3CB519 Pin Assignment Diagram (100-TQFP)

S3CB519 PRODUCT OVERVIEW

I/O PIN DESCRIPTION

Table 1-1. S3CB519 Pin Descriptions

Pin Name	Pin Type	Pin Description	Circuit Type	Share Pins
P0.0 P0.1 P0.2 P0.3 P0.4 P0.5 P0.6	I/O	I/O port with bit programmable pins; Input and output modes can be selected by software; Software assignable pull-up. Alternately, P0.0–P0.6 can be used as INT0–INT6, TB, T0, T0CAP, T0PWM, T0CK, BUZ, TACK, BLD, nSCK, SO, SI.	D-2 D-2 F-10 D-2 D-2 D-2	INTO/TB INT1/TO/TOCAP/T OPWM INT2/TOCK/BUZ INT3/TACK/BLD INT4/nSCK INT5/SO INT6/SI
P1.0-P1.3	I/O	I/O port with bit programmable pins; Input and output modes can be selected by software; Software assignable pull-up. Alternately, P1.0–P1.3 can be used as KS0–KS3.	D-2	KS0-KS3
P2.0-P2.7	I/O	I/O port with 4-bit programmable pins; Input and output modes can be selected by software; Software assignable pullup. Alternately, P2.0–P2.7 can be used as SEG55–SEG48.	H-35	SEG55-SEG48
P3.0-P3.7	I/O	I/O port with 4-bit programmable pins; Input and output modes can be selected by software; Software assignable pullup. Alternately, P3.0–P3.7 can be used as SEG47–SEG40.	H-35	SEG47-SEG40
P4.0-P4.7	I/O	I/O port with 4-bit programmable pins; Input and output modes can be selected by software; Software assignable pullup. Alternately, P4.0–P4.7 can be used as COM8–COM15.	H-35	COM8-COM15
P5.0–P5.15	0	Key strobe output port with 4-bit programmable pins. Push-pull and open-drain modes can be selected by software. Alternately, P5.0–P5.15 can be used as SEG39–SEG24.	H-34	SEG39-SEG24
SEG0- SEG23	0	LCD segment signal output.	H-29	-
SEG24- SEG39	0		H-34	P5.0-P5.15
SEG40- SEG55	I/O		H-35	P3.0–P3.7 P2.0–P2.7
COM0- COM7	0	LCD common signal output.	H-29	_
COM8- COM15	0		H-35	P4.0-P4.7
KS0-KS3	I/O	Key interrupt and/or external interrupt inputs.	D-2	P1.0-P1.3
INT0-INT2, INT4-INT6	I/O	External interrupt input.	D-2	P0.0–P0.2, P0.4–P0.6
INT3	I/O		F-10	P0.3

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PRODUCT OVERVIEW S3CB519

Table 1-1. S3CB519 Pin Descriptions (Continued)

Pin Name	Pin Type	Pin Description	Circuit Type	Share Pins
ТВ	I/O	Timer B clock output.	D-2	P0.0
T0	I/O	Timer 0 clock output.	D-2	P0.1
T0CAP	I/O	Timer 0 capture input.	D-2	P0.1
T0PWM	I/O	Timer 0 PWM output.	D-2	P0.1
T0CK	I/O	Timer 0 clock input.	D-2	P0.2
BUZ	I/O	Buzzer output.	D-2	P0.2
TACK	I/O	Timer A clock input.	F-10	P0.3
BLD	I/O	Battery level detector input.	F-10	P0.3
nSCK	I/O	Serial I/O interface clock signal.	D-2	P0.4
SO	I/O	Serial data output.	D-2	P0.5
SI	I/O	Serial data input.	D-2	P0.6
DAOUT	0	DAC analog output.	_	_
AV _{DD}	_	Analog power.	-	_
AV _{SS}	_	Analog ground.	_	_
ADINP	I	Analog input positive.	_	_
ADINN	I	Analog input negative.	_	_
ADGAIN	-	Analog input gain control.	_	_
AVREFOUT	0	Analog reference voltage output.	_	_
REFH	-	Analog reference power.	_	_
REFL	-	Analog reference ground.	_	_
V_{DD}	_	Main power supply.	_	_
V _{SS}	_	Ground	_	-
X _{IN} , X _{OUT}	_	Crystal, Ceramic or RC oscillator pins for system clock.	_	
XT _{IN} , XT _{OUT}	_	Crystal oscillator pins for subsystem clock.	_	_
TEST	I	Chip test input pin. Hold GND with the device is operating.	-	-
nRESET	I	Reset signal	В	_

S3CB519 PRODUCT OVERVIEW

PIN CIRCUIT DIAGRAMS

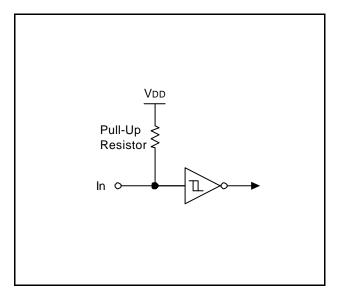


Figure 1-7. Pin Circuit Type B

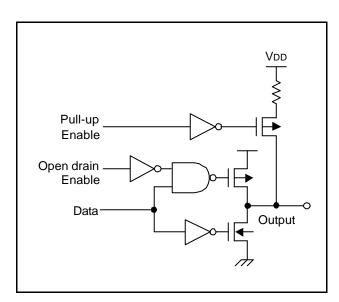


Figure 1-9. Pin Circuit Type E-2

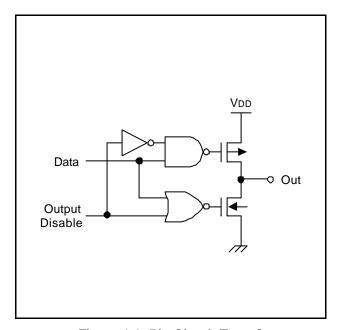


Figure 1-8. Pin Circuit Type C

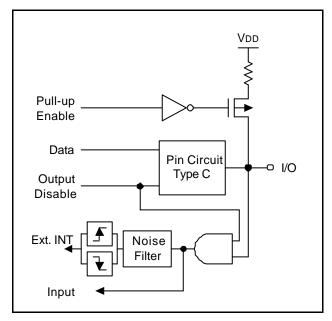


Figure 1-10. Pin Circuit Type D-2

PRODUCT OVERVIEW S3CB519

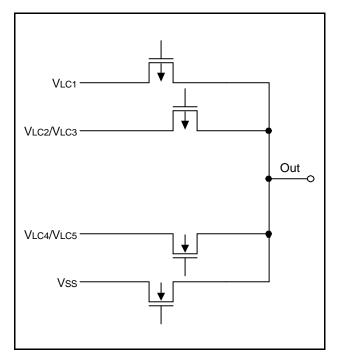


Figure 1-11. Pin Circuit Type H-29

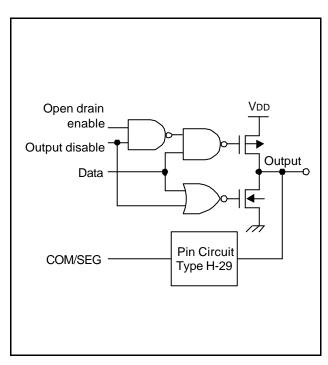


Figure 1-13. Pin Circuit Type H-34

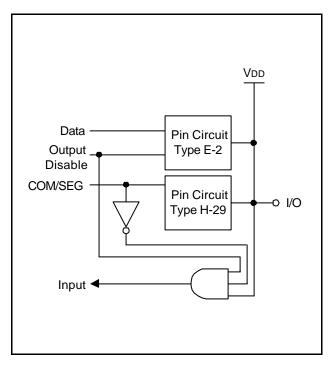


Figure 1-12. Pin Circuit Type H-35

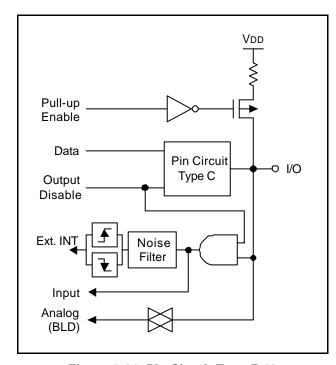


Figure 1-14. Pin Circuit Type F-10



S3CB519 ADDRESS SPACE

2 ADDRESS SPACE

OVERVIEW

CalmRISC has 20-bit program address lines, *PA[19:0]*, which support up to 1 Mwords of program memory. The 1 Mword program memory space is divided into 256 pages, and each page is 4 Kwords long as shown on the next page. The upper 8 bits of the program counter, PC[19:12], points to a specific page, and the lower 12 bits, PC[11:0], specify the offset address of the page.

CalmRISC also has 16-bit data memory address lines, DA[15:0], which support up to 64K-byte of data memory. The 64K-byte data memory space is divided into 256 pages, and each page has 256 bytes. The upper 8 bits of the data address, DA[15:8], points to a specific page, and the lower 8 bits, DA[7:0], specify the offset address of the page.



ADDRESS SPACE S3CB519

PROGRAM MEMORY (ROM)

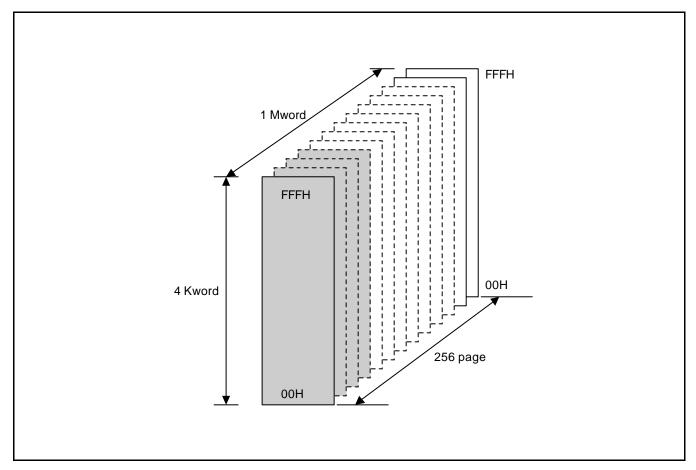


Figure 2-1. Program Memory Organization

For example, if PC[19:0] = 5F79AH, the page index pointed to by PC is 5FH, and the offset in the page is 79AH. If the current PC[19:0] = 5EFFFH and the instruction pointed to by the current PC (i.e., the instruction at the address 5EFFFH is *not* a branch instruction), the next PC becomes 5E000H, *not* 5F000H. In other words, the instruction sequence wraps around at the page boundary, unless the instruction at the boundary (in the above example, at 5EFFFH) is a long branch instruction. The only way to change the program page is by long branches (CALL, LNK, and JP), where the absolute branch target address is specified. For example, if the current PC[19:0] = 047ACH (the page index is 04H and the offset is 7ACH) and the instruction pointed to by the current PC (i.e., the instruction at the address 047ACH), is "JP A507FH" (jump to the program address A507FH), then the next PC[19:0] = A507FH, which means that the page and the offset are changed to A5H and 07FH, respectively. On the other hand, the short branch instructions cannot change the page indices.

S3CB519 ADDRESS SPACE

Suppose the current PC is 6FFFEH and its instruction is "JR 5H" (jump to the program address PC + 5H), then the next instruction address is 6F003H, not 70003H. In other words, the branch target address calculation also wraps around with respect to a page boundary. This situation is illustrated below:

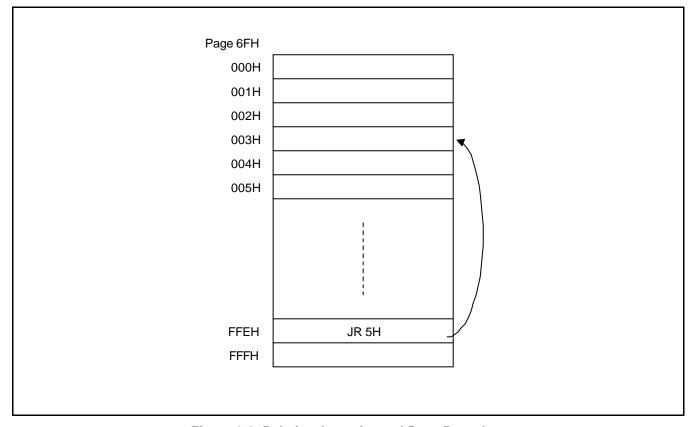


Figure 2-2. Relative Jump Around Page Boundary

Programmers do not have to manually calculate the offset and insert extra instructions for a jump instruction across page boundaries. The compiler and the assembler for CalmRISC are in charge of producing appropriate codes for them.

ADDRESS SPACE S3CB519

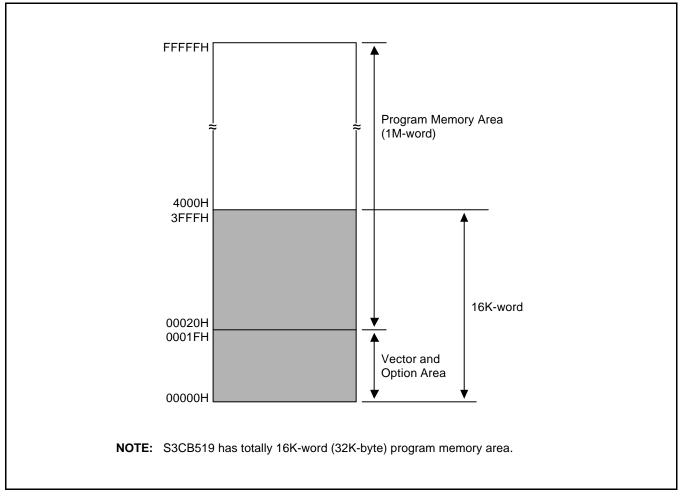


Figure 2-3. Program Memory Layout

From 00000H to 00004H addresses are used for vector addresses of exceptions, and 0001EH and 0001FH are used for only the option. Aside from these addresses others are reserved in the vector and option area. Program memory area from the address 00020H to FFFFFH can be used for normal programs.

Because the S3CB519's program memory is 16 Kword (32K-byte), the block of addresses from 00020H to 3FFFH is the program memory area.

S3CB519 ADDRESS SPACE

ROM CODE OPTION (RCOD_OPT)

Just after power on, the ROM data located at 0001EH and 0001FH is used as the ROM code option. S3CB519 has ROM code options like the Reset value of Basic timer and Watchdog timer enable.

For example, if you program as below:

opt_sec section CODE, abs 0001FH

opt_sec

dw 3FFH

fxx/32 is used as Reset value of basic timer (by bit.14, 13, 12)

Watch-dog timer is enabled (by bit.11)

If you don't program any values in these option areas, then the default value is "1".

In these cases, the address 0001EH would be the value of "FFFFH".

ADDRESS SPACE S3CB519

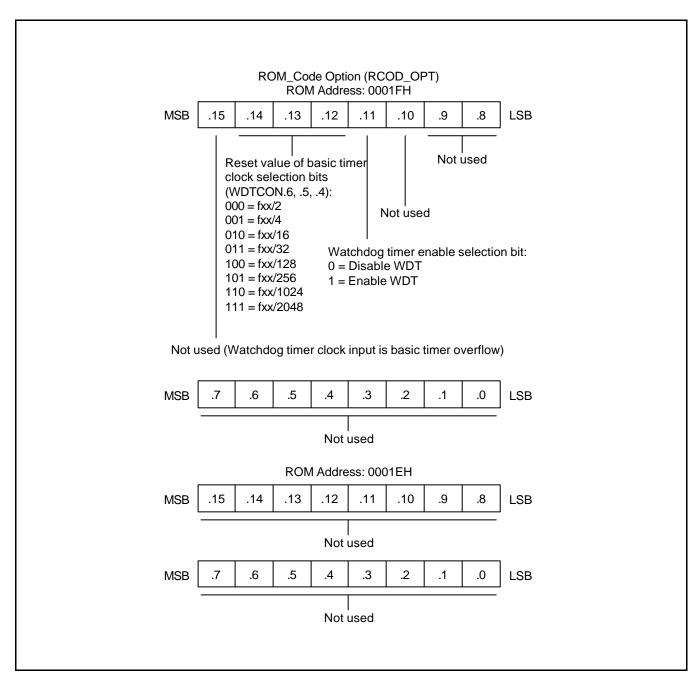


Figure 2-4. ROM Code Option (RCOD_OPT)

S3CB519 ADDRESS SPACE

DATA MEMORY ORGANIZATION

The total data memory address space is 64K-byte, addressed by *DA[15:0]*, and divided into 256 pages, Each page consists of 256 bytes as shown below.

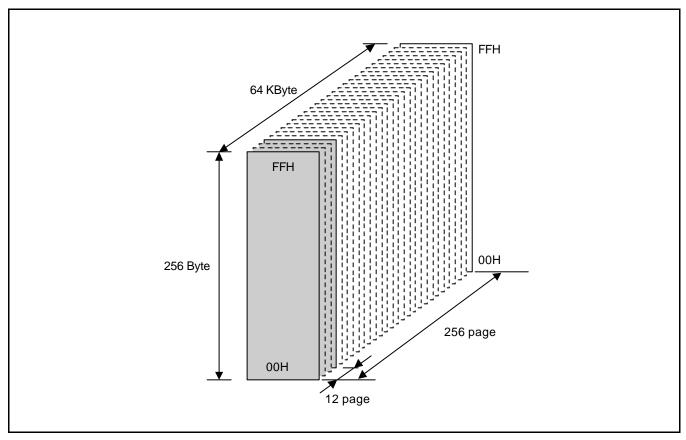


Figure 2-5. Data Memory Map

The data memory page is indexed by SPR and IDH. In data memory index addressing mode, 16-bit data memory address is composed of two 8-bit SPRs, IDH[7:0] and IDL0[7:0] (or IDH[7:0] and IDL1[7:0]). IDH[7:0] points to a page index, and IDL0[7:0] (or IDL1[7:0]) represents the page offset. In data memory direct addressing mode, an 8-bit direct address, adr[7:0], specifies the offset of the page pointed to by IDH[7:0] (See the details for direct addressing mode in the instruction sections). Unlike the program memory organization, data memory address does *not* wrap around. In other words, data memory index addressing with modification performs an addition or a subtraction operation on the whole 16-bit address of IDH[7:0] and IDL0[7:0] (or IDL1[7:0]) and updates IDH[7:0] and IDL0[7:0] (or IDL1[7:0]) accordingly. Suppose IDH[7:0] is 0FH and IDL0[7:0] is FCH and the modification on the index registers, IDH[7:0] and IDL0[7:0], is increment by 5H, then, after the modification (i.e., 0FFCH + 5 = 1001H), IDH[7:0] and IDL0[7:0] become 10H and 01H, respectively.

As for the MAC816 coprocessor, the data memory is a word unit (16-bit wide) and is divided to X-memory and Y-memory for DSP instruction.

The address 0080H in CalmRISC, for example, is viewed as 0040H by MAC816.



ADDRESS SPACE S3CB519

The S3CB519 has a total of 3072 bytes of data register address from 0080H to 0C7FH.

The area from 0000H to 007FH is for peripheral control, and LCD RAM area is from 0C80H to 0CEFH.

The MAC816 views the peripheral control register area as being from 0000H to 003FH, and X-memory from 0040H to 043FH, and Y-memory from 0440H to 063FH.

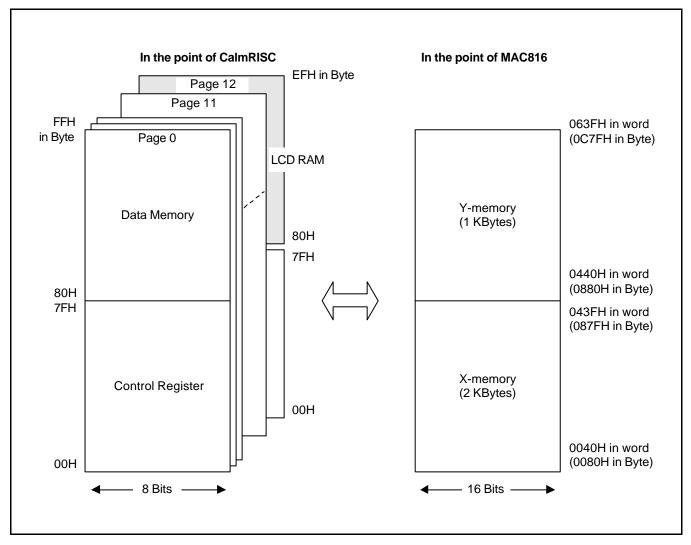


Figure 2-6. S3CB519 Data Memory Map

S3CB519 REGISTERS

3 REGISTERS

OVERVIEW

The registers of CalmRISC are grouped into 2 types: general purpose registers and special purpose registers.

Regi	sters	Mnemonics	Description	Reset Value
General	Purpose	R0	General Register 0	Unknown
Register	s (GPR)	R1	General Register 1	Unknown
		R2	General Register 2	Unknown
		R3	General Register 3	Unknown
Special Purpose	Group 0 (SPR0)	IDL0	Lower Byte of Index Register 0	Unknown
Registers (SPR)		IDL1	Lower Byte of Index Register 1	Unknown
		IDH	Higher Byte of Index Register	Unknown
		SR0	Status Register 0	00H
	Group 1 (SPR1)	ILX	Instruction Pointer Link Register for Extended Byte	Unknown
		ILH	Instruction Pointer Link Register for Higher Byte	Unknown
		ILL	Instruction Pointer Link Register for Lower Byte	Unknown
		SR1	Status Register 1	Unknown

Table 3-1. General and Special Purpose Registers

GPRs can be used in most instructions such as ALU instructions, stack instructions, load instructions, etc. (See the instruction set sections). From the programming standpoint, they have almost no restriction whatsoever. CalmRISC has 4 banks of GPRs, and each bank has 4 registers, R0, R1, R2, and R3. Hence, 16 GPRs in total are available. The GPR bank can be switched by setting an appropriate value in SR0[4:3] (See SR0 for details). The ALU operations between GPRs from different banks are not allowed.

SPRs are designed for their own dedicated purposes. They have some restrictions in terms of instructions that can access them. For example, direct ALU operations cannot be performed on SPRs. However, data transfers between a GPR and an SPR are allowed, and stack operations with SPRs are also possible (See the instruction sections for details).

REGISTERS S3CB519

INDEX REGISTERS: IDH, IDL0 AND IDL1

IDH in concatenation with IDL0 (or IDL1) forms a 16-bit data memory address. Note that CalmRISC's data memory address space is 64 Kbyte (addressable by 16-bit addresses). Basically, IDH points to a page index, and IDL0 (or IDL1) corresponds to an offset of the page. Like GPRs, the index registers are 2-way banked. There are 2 banks in total, each of which has its own index registers, IDH, IDL0 and IDL1. The banks of index registers can be switched by setting an appropriate value in SR0[2] (See SR0 for details). Normally, programmers can reserve an index register pair, IDH and IDL0 (or IDL1), for software stack operations.

LINK REGISTERS: ILX, ILH AND ILL

The link registers are specially designed for link-and-branch instructions (See LNK and LRET instructions in the instruction sections for details). When an LNK instruction is executed, the current PC[19:0] is saved into ILX, ILH and ILL registers (i.e., PC[19:16] into ILX[3:0], PC[15:8] into ILH [7:0]) and PC[7:0] into ILL[7:0], respectively. When an LRET instruction is executed, the PC value returned is recovered from ILX, ILH, and ILL (i.e., ILX[3:0] into PC[19:16], ILH[7:0] into PC[15:8] and ILL[7:0] into PC[7:0], respectively). These registers are used to access program memory by LDC instructions. When an LDC instruction is executed, the (code) data residing at the program address specified by ILX:ILH:ILL will be read into TBH:TBL.

There is a special core input pin signal, nP64KW, which is reserved for indicating that the program memory address space is only 64 Kword. By grounding the signal pin to zero, the upper 4 bits of PC, PC[19:16], is deactivated and therefore its program memory address signals from CalmRISC core are also deactivated. This, in turn, totally eliminates the power consumption due to manipulating the upper 4 bits of PC (See the core pin description section for details). From the programmer's standpoint, when nP64KW is tied to the ground level, then PC[19:16] is *not* saved into ILX for LNK instructions and ILX is *not* read back into PC[19:16] for LRET instructions. Therefore, ILX is totally unused in LNK and LRET instructions when nP64KW = 0.



S3CB519 REGISTERS

STATUS REGISTER 0: SR0

SR0 is mainly reserved for system control functions, and each bit of SR0 has its own dedicated function.

Flag Name	Bit	Description
eid	0	Data memory page selection in direct addressing
ie	1	Global interrupt enable
idb	2	Index register banking selection
grb[1:0]	4,3	GPR bank selection
exe	5	Stack overflow/underflow exception enable
ie0	6	Interrupt 0 enable
ie1	7	Interrupt 1 enable

Table 3-2. Status Register 0 Configuration

SR0[0] (or eid) selects which page index is to be used in direct addressing. If eid = 0, then page 0 (page index = 0) is used. Otherwise (eid = 1), IDH of the current index register bank is used for the page index. SR0[1] (or ie) is the global interrupt enable flag. As explained in the interrupt/exception section, CalmRISC has 3 interrupt sources (non-maskable interrupt, interrupt 0, and interrupt 1) and 1 stack exception. Both interrupt 0 and interrupt 1 are masked by setting SR0[1] to 0 (i.e., ie = 0). When an interrupt is serviced, the global interrupt enable flag ie is automatically cleared. The execution of an IRET instruction (return from an interrupt service routine) automatically sets ie = 1. SR0[2] (or idb) and SR0[4:3] (or grb[1:0]) selects an appropriate bank for index registers and GPRs, respectively, as shown below:

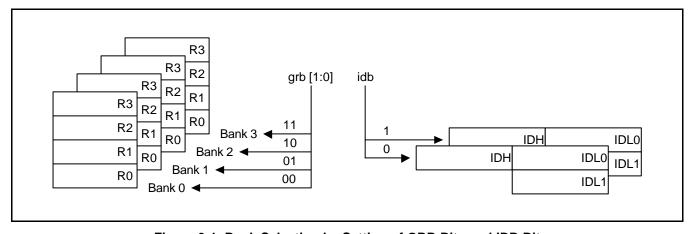


Figure 3-1. Bank Selection by Setting of GRB Bits and IDB Bit

SR0[5] (or exe) enables the stack exception, that is, the stack overflow/underflow exception. If exe = 0, the stack exception is disabled. The stack exception can be used for program debugging in the software development stage. SR0[6] (or ie0) and SR0[7] (or ie1) are enabled, by setting them to 1. Even though ie0 or ie1 are enabled, the interrupts are ignored (not serviced) if the global interrupt enable flag ie is set to 0.

REGISTERS S3CB519

STATUS REGISTER 1: SR1

SR1 is the register for status flags such as ALU execution flag and stack full flag.

Table 3-3. Status Register 1: SR1

Flag Name	Bit	Description					
С	0	Carry flag					
V	1	Overflow flag					
Z	2	Zero flag					
N	3	Negative flag					
SF	4	Stack Full flag					
_	5, 6, 7	Reserved					

SR1[0] (or C) is the carry flag of ALU executions. SR1[1] (or V) is the overflow flag of ALU executions. It is set to 1 if and only if the carry-in into the 8-th bit position of addition/subtraction differs from the carry-out from the 8-th bit position. SR1[2] (or Z) is the zero flag, which is set to 1 if and only if the ALU result is zero. SR1[3] (or N) is the negative flag. Basically, the most significant bit (MSB) of ALU results becomes the N flag. Note, a load instruction into a GPR is considered an ALU instruction. However, if an ALU instruction touches the overflow flag (V) like ADD, SUB, CP, etc, N flag is updated as exclusive-OR of V and the MSB of the ALU result. This implies that even if an ALU operation results in an overflow, N flag is still valid. SR1[4] (or SF) is the stack overflow flag. It is set when the hardware stack is overflowed or underflowed. Programmers can check if the hardware stack has any abnormalities through the stack exception or testing if SF is set (See the hardware stack section for more details).

NOTE

When an interrupt occurs, the hardware does not save SR0 and SR1, so the software must save the SR1 register values.



S3CB519 MEMORY MAP

4

MEMORY MAP

OVERVIEW

To support the control of peripheral hardware, the addresses of peripheral control registers are memory-mapped to page 0 of the RAM. Memory mapping lets you use a mnemonic as the operand of an instruction at a specific memory location.

In this section, detailed descriptions of the S3CB519 control registers are presented in an easy-to-read format. You can use this section as a quick-reference source when writing application programs.

This memory area can be accessed with the whole method of data memory access.

- If SR0 bit 0 is "0" then the accessed register area is always page 0.
- If SR0 bit 0 is "1" then the accessed register page is controlled by the proper value of the IDH register.

So if you want to access the memory map area, clear the SR0.0 and use the direct addressing mode. This method is used for most cases.

The control register is divided into five areas. Here, the system control register area is same in every device.

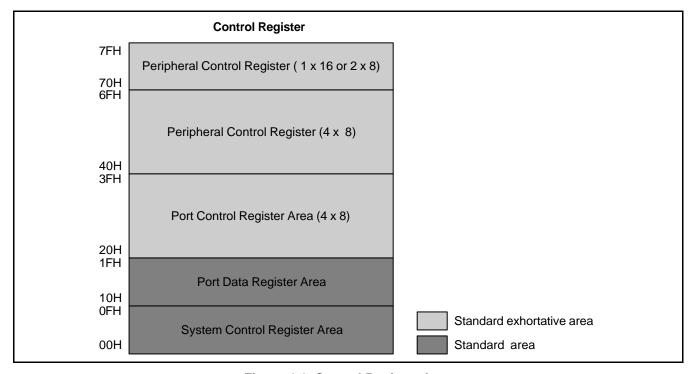


Figure 4-1. Control Register Area

MEMORY MAP S3CB519

Table 4-1. Control Registers

Register Name	Mnemonic	Decimal	Hex	Reset	R/W								
Location 16H-1FH is not mapped													
Port 5 data register	P5	21	15H	0FH	R								
Port 4 data register	P4	20	14H	00H	R/W								
Port 3 data register	P3	19	13H	00H	R/W								
Port 2 data register	P2	18	12H	00H	R/W								
Port 1 data register	P1	17	11H	00H	R/W								
Port 0 data register	P0	16	10H	00H	R/W								
Loca	tions 0EH and 0FH are n	ot mapped											
Watchdog timer control register	WDTCON	13	0DH	X0H	R/W								
Basic timer counter	BTCNT	12	0CH	00H	R								
Interrupt ID register 1	IIR1	11	0BH	_	R/W								
Interrupt priority register 1	IPR1	10	0AH	_	R/W								
Interrupt mask register 1	IMR1	9	09H	00H	R/W								
Interrupt request register 1	IRQ1	8	08H	_	R								
Interrupt ID register 00	IIR00	7	07H	_	R/W								
Interrupt priority register 00	IPR00	6	06H	_	R/W								
Interrupt mask register 00	IMR00	5	05H	00H	R/W								
Interrupt request register 00	IRQ00	4	04H		R								
Oscillator control register	OSCCON	3	03H	00H	R/W								
Power control register	PCON	2	02H	04H	R/W								
Loca	ations 00H and 01H are no	ot mapped											

NOTES

^{1.} All the unused and unmapped registers and bits read "0".

^{2. &}quot;-" means undefined.

S3CB519 MEMORY MAP

Table 4-1. Control Registers (Continued)

Register Name	Mnemonic	Decimal	Hex	Reset	R/W								
Locations 35H–3FH are not mapped													
Port 5 control register	P5CON	52	34H	00H	R/W								
Loca	itions 31H–33H are not i	mapped											
Port 4 control register	P4CON	48	30H	00H	R/W								
Loca	tions 2DH-2FH are not	mapped											
Port 3 control register	P3CON	44	2CH	00H	R/W								
Loca	tions 29H–2BH are not	mapped											
Port 2 control register	P2CON	40	28H	00H	R/W								
Loca	itions 26H–27H are not i	mapped											
Port 1 interrupt control register	P1INT	37	25H	00H	R/W								
Port 1 control register	P1CON	36	24H	00H	R/W								
Port 0 interrupt edge control register	P0EDGE	35	23H	00H	R/W								
Port 0 interrupt control register	POINT	34	22H	00H	R/W								
Port 0 control register low	P0CONL	33	21H	00H	R/W								
Port 0 control register high	P0CONH	32	20H	00H	R/W								

NOTE: All unused and unmapped registers and bits read "0".

MEMORY MAP S3CB519

Table 4-1. Control Registers (Concluded)

Register Name	Mnemonic	Decimal	Hex	Reset	R/W
Location	s 74H–7FH are not r	napped			
D/A converter data register	DADATA	115	73H	00H	R/W
D/A converter control register	DACON	114	72H	00H	R/W
Battery level detector register	BLDCON	113	71H	40H	R/W
Watch timer control register	WTCON	112	70H	00H	R/W
Location	s 5FH–6FH are not r	napped			
LCD contrast register	LCNST	94	5EH	00H	R/W
LCD mode register	LMOD	93	5DH	00H	R/W
LCD control register	LCON	92	5CH	00H	R/W
Interrupt ID register 01	IIR01	91	5BH	_	R/W
Interrupt priority register 01	IPR01	90	5AH	_	R/W
Interrupt mask register 01	IMR01	89	59H	00H	R/W
Interrupt request register 01	IRQ01	88	58H	_	R
Location	ns 53H–57H are not r	napped		•	
Timer 0 counter	T0CNT	82	52H	_	R
Timer 0 data register	TODATA	81	51H	FFH	R/W
Timer 0 control register	T0CON	80	50H	00H	R/W
Loca	ation 4FH is not map	ped			
A/D Converter data register, Low byte	ADDATAL	78	4EH	00H	R
A/D Converter data register, High byte	ADDATAH	77	4DH	00H	R
A/D Converter control register	ADCON	76	4CH	00H	R/W
Loca	ation 4BH is not map	ped			
Serial I/O data register	SIODATA	74	4AH	00H	R/W
Serial I/O pre-scale register	SIOPS	73	49H	00H	R/W
Serial I/O control register	SIOCON	72	48H	00H	R/W
Loca	ation 47H is not mapp	oed			
Timer B counter	TBCNT	70	46H	_	R
Timer B data register	TBDATA	69	45H	FFH	R/W
Timer B control register	TBCON	68	44H	00H	R/W
Loca	ation 43H is not mapp	ped			
Timer A counter	TACNT	66	42H	_	R
Timer A data register	TADATA	65	41H	FFH	R/W
Timer A control register	TACON	64	40H	00H	R/W

NOTES

- 1. All unused and unmapped registers and bits read "0".
- 2. "-" means undefined.

S3CB519 HARDWARE STACK

5 HARDWARE STACK

OVERVIEW

The hardware stack in CalmRISC has two usages:

- To save and restore the return PC[19:0] on CALL, CALLS, RET, and IRET instructions.
- Temporary storage space for registers on PUSH and POP instructions.

When PC[19:0] is saved into or restored from the hardware stack, the access should be 20 bits wide. On the other hand, when a register is pushed into or popped from the hardware stack, the access should be 8 bits wide. Hence, to maximize the efficiency of the stack usage, the hardware stack is divided into 3 parts: the extended stack bank (XSTACK, 4-bits wide), the odd bank (8-bits wide), and the even bank (8-bits wide).

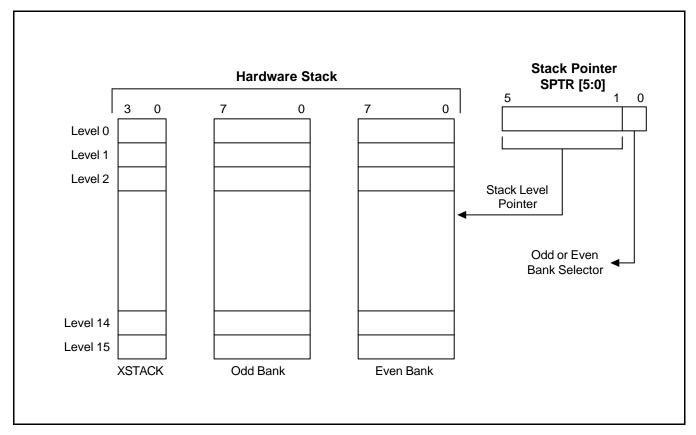


Figure 5-1. Hardware Stack



HARDWARE STACK S3CB519

The top of the stack (TOS) is pointed to by a stack pointer, called **sptr[5:0]**. The upper 5 bits of the stack pointer, sptr[5:1], points to the stack level into which either PC[19:0] or a register is saved. For example, if sptr[5:1] is 5H or TOS is 5, then level 5 of XSTACK is empty and either level 5 of the odd bank or level 5 of the even bank is empty. In fact, sptr[0], the stack bank selection bit, indicates which bank(s) is empty. If sptr[0] = 0, both level 5 of the even and the odd banks are empty. On the other hand, if sptr[0] = 1, level 5 of the odd bank is empty, but level 5 of the even bank is occupied. This situation is well illustrated in the figure below.

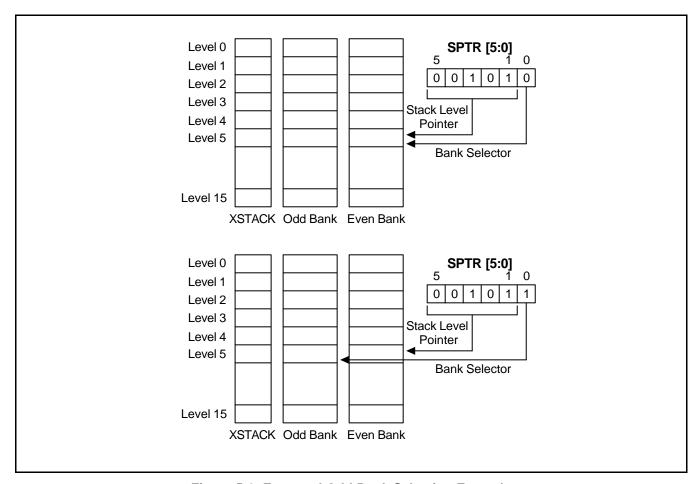


Figure 5-2. Even and Odd Bank Selection Example

As can be seen in the above example, sptr[5:1] is used as the hardware stack pointer when PC[19:0] is pushed or popped and sptr[5:0] as the hardware stack pointer when a register is pushed or popped. Note that XSTACK is used only for storing and retrieving PC[19:16]. Let us consider the cases where PC[19:0] is pushed into the hardware stack (by executing CALL/CALLS instructions or by interrupts/exceptions being served) or is retrieved from the hardware stack (by executing RET/IRET instructions). Regardless of the stack bank selection bit (sptr[0]), TOS of the even bank and the odd bank stores or returns PC[7:0] or PC[15:8], respectively. This is illustrated in the following figures.



S3CB519 HARDWARE STACK

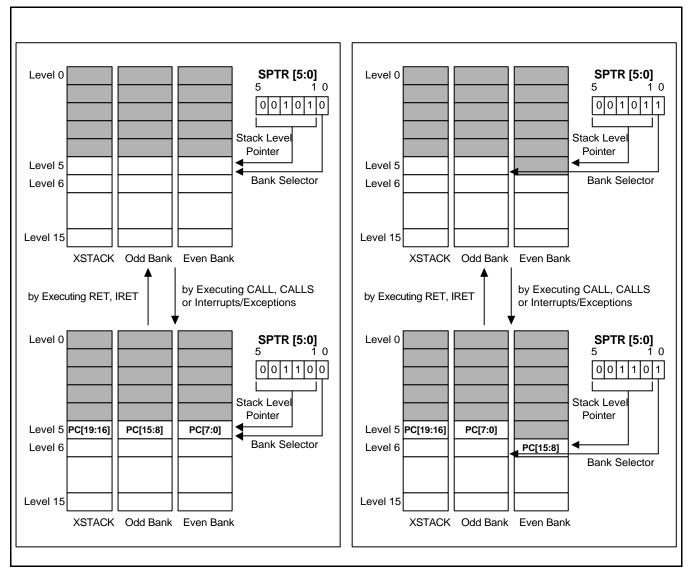


Figure 5-3. Stack Operation with PC [19:0]

As can be seen in the figures, when stack operations with PC[19:0] are performed, the stack level pointer sptr[5:1] (not sptr[5:0]) is either incremented by 1 (when PC[19:0] is pushed into the stack) or decremented by 1 (when PC[19:0] is popped from the stack). The stack bank selection bit (sptr[0]) is unchanged. If a CalmRISC core input signal nP64KW is 0, which signifies that only PC[15:0] is meaningful, then any access to XSTACK is totally deactivated from the stack operations with PC. Therefore, XSTACK has no meaning when the input pin signal, nP64KW, is tied to 0. In that case, XSTACK doesn't have to even exist. As a matter of fact, XSTACK is not included in CalmRISC core itself and it is interfaced through some specially reserved core pin signals (nPUSH, nSTACK, XHSI[3:0], XSHO[3:0]), if the program address space is more than 64K words (See the core pin signal section for details).

With regards to stack operations with registers, a similar argument can be made. The only difference is that the data written into or read from the stack are a byte. Hence, the even bank and the odd bank are accessed alternately as shown below.



HARDWARE STACK S3CB519

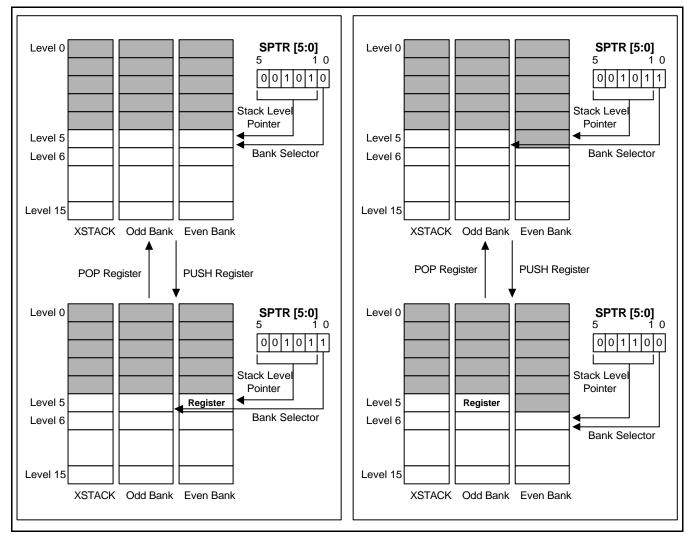


Figure 5-4. Stack Operation with Registers

When the bank selection bit (sptr[0]) is 0, then the register is pushed into the even bank and the bank selection bit is set to 1. In this case, the stack level pointer is unchanged. When the bank selection bit (sptr[0]) is 1, then the register is pushed into the odd bank, the bank selection bit is set to 0, and the stack level pointer is incremented by 1. Unlike the push operations of PC[19:0], any data are not written into XSTACK in the register push operations. This is illustrated in the example figures. When a register is pushed into the stack, sptr[5:0] is incremented by 1 (*not* the stack level pointer sptr[5:1]). The register pop operations are the reverse processes of the register push operations. When a register is popped out of the stack, sptr[5:0] is decremented by 1 (*not* the stack level pointer sptr[5:1]).

Hardware stack overflow/underflow happens when the MSB of the stack level pointer, sptr[5], is 1. This is obvious from the fact that the hardware stack has only 16 levels and the following relationship holds for the stack level pointer in a normal case.

Suppose the stack level pointer sptr[5:1] = 15 (or 01111B in binary format) and the bank selection bit sptr[0] = 1. Here if either PC[19:0] or a register is pushed, the stack level pointer is incremented by 1. Therefore, sptr[5:1] = 16 (or 10000B in binary format) and sptr[5] = 1, which implies that the stack is overflowed. The situation is depicted in the following figure.



S3CB519 HARDWARE STACK

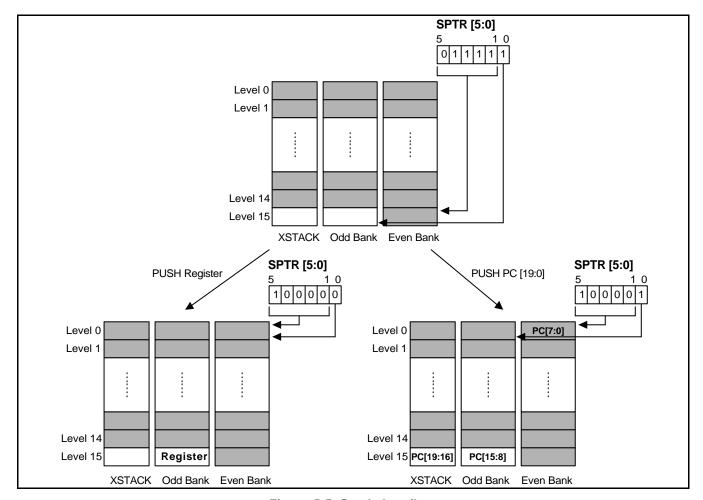


Figure 5-5. Stack Overflow

The first overflow happens due to a register push operation. As explained earlier, a register push operation increments sptr[5:0] (not sptr[5:1]), which results in sptr[5] = 1, sptr[4:1] = 0 and sptr[0] = 0. As indicated by sptr[5] = 1, an overflow happens. Note that this overflow doesn't overwrite any data in the stack. On the other hand, when PC[19:0] is pushed, sptr[5:1] is incremented by 1 instead of sptr[5:0], and as expected, an overflow results. Unlike the first overflow, PC[7:0] is pushed into level 0 of the even bank and the data that has been there before the push operation is *overwritten*. A similar argument can be made about stack underflows. Note that any stack operation, which causes the stack to overflow or underflow, doesn't necessarily mean that any data in the stack are lost, as is observed in the first example.

In SR1, there is a status flag, SF (Stack Full Flag), which is exactly the same as sptr[5]. In other words, the value of sptr[5] can be checked by reading SF (or SR1[4]). SF is not a sticky flag in the sense that if there was a stack overflow/underflow but any following stack access instructions clear sptr[5] to 0, then SF = 0 and programmers cannot tell whether there was a stack overflow/underflow by reading SF. For example, if a program pushes a register 64 times in a row, sptr[5:0] is exactly the same as sptr[5:0] before the push sequence. Therefore, special attention should be paid.

Another mechanism to detect a stack overflow/underflow is through a stack exception. A stack exception happens only when the execution of any stack access instruction results in SF = 1 (or sptr[5] = 1). Suppose a register push operation makes SF = 1 (the SF value before the push operation doesn't matter). Then the stack exception due to the push operation is immediately generated and served If the stack exception enable flag (exe of SR0) is 1. If the stack exception enable flag is 0, then the generated interrupt is not served but pending. Sometime later when the stack exception enable flag is set to 1, the pending exception request is served even if SF = 0. More details are available in the stack exception section.



HARDWARE STACK S3CB519

NOTES



S3CB519 EXCEPTIONS

6

EXCEPTIONS

OVERVIEW

Exceptions in CalmRISC are listed in the table below. Exception handling routines, residing at the given addresses in the table, are invoked when the corresponding exception occurs. The starting address of each exception routine is specified by concatenating 0H (leading 4 bits of 0) and the 16-bit data in the exception vector listed in the table. For example, the interrupt service routine for NMI starts from 0H:PM[00001H]. Note that ":" means concatenation and PM[*] stands for the 16-bit content at the address * of the program memory. Aside from the exception due to reset release, the current PC is pushed in the stack on an exception. When an exception is executed due to NMI/IRQ[1:0]/IEXP, the global interrupt enable flag, ie bit (SR0[1]), is set to 0, whereas ie is set to 1 when IRET or an instruction that explicitly sets ie is executed.

Table 6-1. Exceptions

Name	Address	Priority	Description
Reset	00000H	1 st	Exception due to rest release.
NMI	00001H	2 nd	Exception due to <i>nNMI</i> signal. Non-maskable. Not used.
IRQ[0]	00002H	4 th	Exception due to nIRQ[0] signal. Maskable by setting ie/ie0.
IRQ[1]	00003H	5 th	Exception due to nIRQ[1] signal. Maskable by setting ie/ie1.
IEXP	00004H	3 rd	Exception due to stack full. Maskable by setting exe.
_	00005H	-	Reserved.
_	00006H	-	Reserved.
_	00007H	-	Reserved.

NOTE: Break mode due to BKREQ has a higher priority than all the exceptions above. That is, when BKREQ is active, even the exception due to reset release is not executed.

HARDWARE RESET

When Hardware Reset is active (the reset input signal pin nRES = 0), the control pins in the CalmRISC core are initialized to be disabled, and SR0 and sptr (the hardware stack pointer) are initialized to be 0. Additionally, the interrupt sensing block is cleared. When Hardware Reset is released (nRES = 1), the reset exception is executed by loading the JP instruction in IR (Instruction Register) and 0h:0000h in PC. Therefore, when Hardware Reset is released, the "JP {0h:PM[00000h]}" instruction is executed. When the reset exception is executed, a core output signal nEXPACK is generated to acknowledge the exception.

EXCEPTIONS S3CB519

NMI EXCEPTION (EDGE SENSITIVE)

On the falling edge of a core input signal *nNMI*, the NMI exception is executed by loading the CALL instruction in IR and 0h:0001h in PC. Therefore, when NMI exception is activated, the "CALL {0h:PM[00001h]}" instruction is executed. When the NMI exception is executed, the ie bit (SR0[1]) becomes 0 and a core output signal *nEXPACK* is generated to acknowledge the exception.

IRQ[0] EXCEPTION (LEVEL-SENSITIVE)

When a core input signal *nIRQ[0]* is low, SR0[6] (ie0) is high, and SR0[1] (ie) is high, IRQ[0] exception is generated, and this will load the CALL instruction in IR (Instruction Register) and 0h:0002h in PC. Therefore, on an IRQ[0] exception, the "CALL {0h:PM[00002h]}" instruction is executed. When the IRQ[0] exception is executed, SR0[1] (ie) is set to 0 and a core output signal *nEXPACK* is generated to acknowledge the exception.

IRQ[1] EXCEPTION (LEVEL-SENSITIVE)

When a core input signal *nIRQ[1]* is low, SR0[7] (ie1) is high, and SR0[1] (ie) is high, IRQ[1] exception is generated, and this will load the CALL instruction in IR (Instruction Register) and 0h:0003h in PC. Therefore, on an IRQ[1] exception, the "CALL {0h:PM[00003h]}" instruction is executed. When the IRQ[1] exception is executed, SR0[1] (ie) is set to 0 and a core output signal *nEXPACK* is generated to acknowledge the exception.

HARDWARE STACK FULL EXCEPTION

A Stack Full exception occurs when a stack operation is performed and as a result of the stack operation sptr[5] (SF) is set to 1. If the stack exception enable bit, exe (SR0[5]), is 1, the Stack Full exception is served. One exception to this rule is when nNMI causes a stack operation that sets sptr[5] (SF), since it has higher priority.

Handling a Stack Full exception may cause another Stack Full exception. In this case, the new exception is ignored. On a Stack Full exception, the CALL instruction is loaded in IR (Instruction Register) and 0h:0004h in PC. Therefore, when the Stack Full exception is activated, the "CALL {0h:PM[00004h]}" instruction is executed. When the exception is executed, SR0[1] (ie) is set to 0, and a core output signal *nEXPACK* is generated to acknowledge the exception.

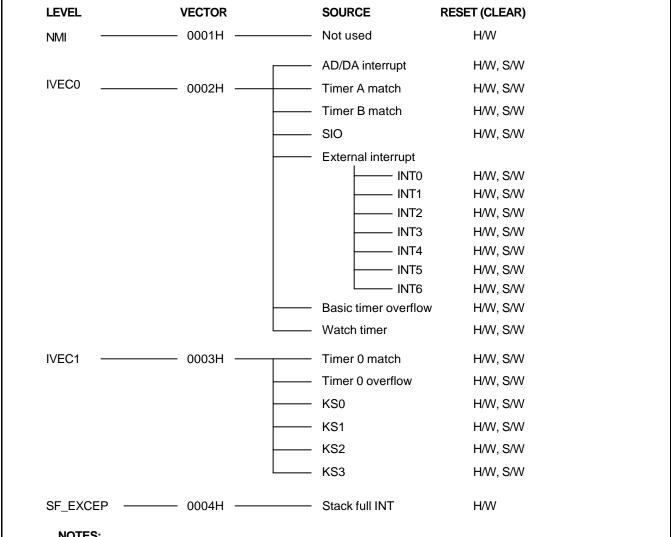
BREAK EXCEPTION

Break exception is reserved only for an in-circuit debugger. When a core input signal, *BKREQ*, is high, the CalmRISC core is halted or in the break mode, until *BKREQ* is deactivated. Another way to drive the CalmRISC core into the break mode is by executing a break instruction, BREAK. When BREAK is fetched, it is decoded in the fetch cycle (IF stage) and the CalmRISC core output signal *nBKACK* is generated in the second cycle (ID/MEM stage). An in-circuit debugger generates *BKREQ* active by monitoring *nBKACK* to be active. BREAK instruction is exactly the same as the NOP (no operation) instruction except that it does not increase the program counter and activates nBKACK in the second cycle (or ID/MEM stage of the pipeline). There, once BREAK is encountered in the program execution, it falls into a deadlock. BREAK instruction is reserved for in-circuit debuggers only, so it should not be used in user programs.



S3CB519 **EXCEPTIONS**

EXCEPTIONS (or INTERRUPTS)



NOTES:

- There are two interrupt vectors, and the one interrupt vector have several interrupt sources. The priority of the sources is controlled by setting the IPR register.
- IMR00, IPR00, IRQ00, is responsible for AD/DA interrupt, Timer A, Timer B, SIO, External, Basic timer, Watch timer interrupt. IMR01, IPR01, IRQ01 is responsible for INT0-INT6 interrupt. IMR1, IPR1, IRQ1 is responsible for Timer 0 Match, Timer 0 Overflow, Key scan interrupts.
- 3. External interrupts are triggered by a rising or falling edge, depending on the corresponding control register setting.
- The NMI has the most higher priority in the interrupt levels. And the priority of SF_EXCEP is next but higher then IVEC0, IVEC1's priority is the last.
- 5. When system reset occurs, IPR register value is undefined. After reset, the interrupt priority can be changed by setting of IPR register.
- The pending bit is cleared by Hardware when CPU reads the IIR register value.
- If you write "LD IIRx, #8H", all bits of IRQx are cleared. (Where x is 1, 00, 01)

Figure 6-1. Interrupt Structure



6-3

EXCEPTIONS S3CB519

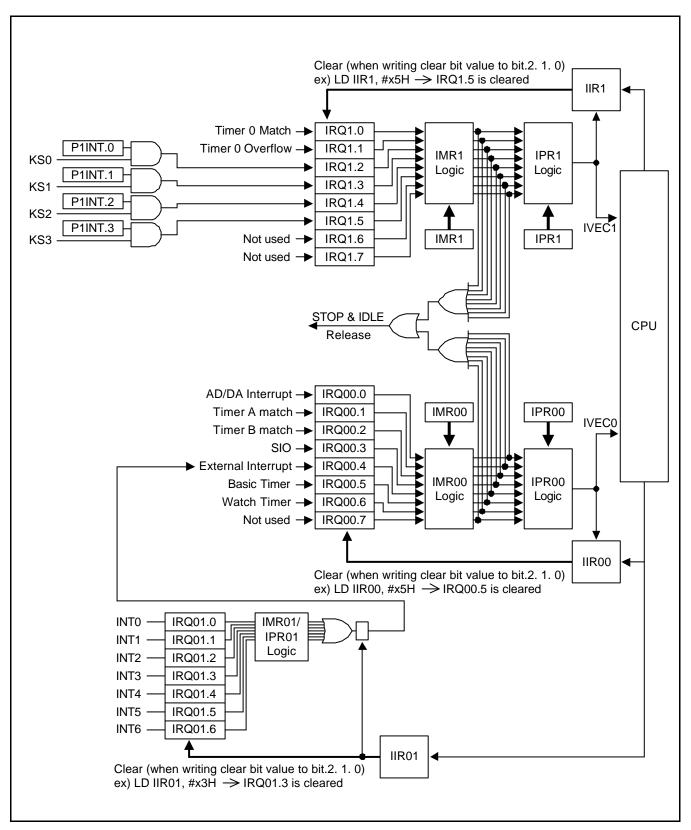


Figure 6-2. Interrupt Structure



S3CB519 EXCEPTIONS

INTERRUPT MASK REGISTERS

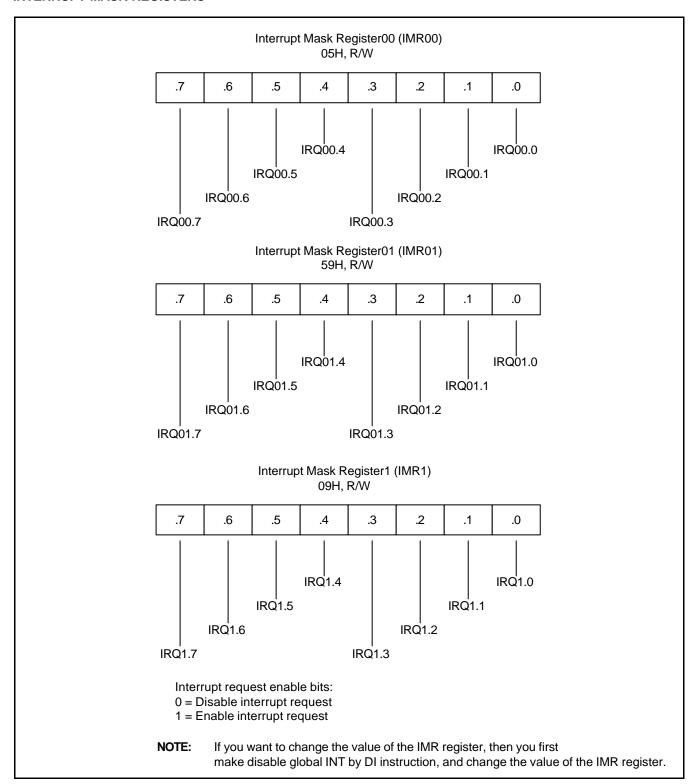


Figure 6-3. Interrupt Mask Register

EXCEPTIONS S3CB519

INTERRUPT PRIORITY REGISTER

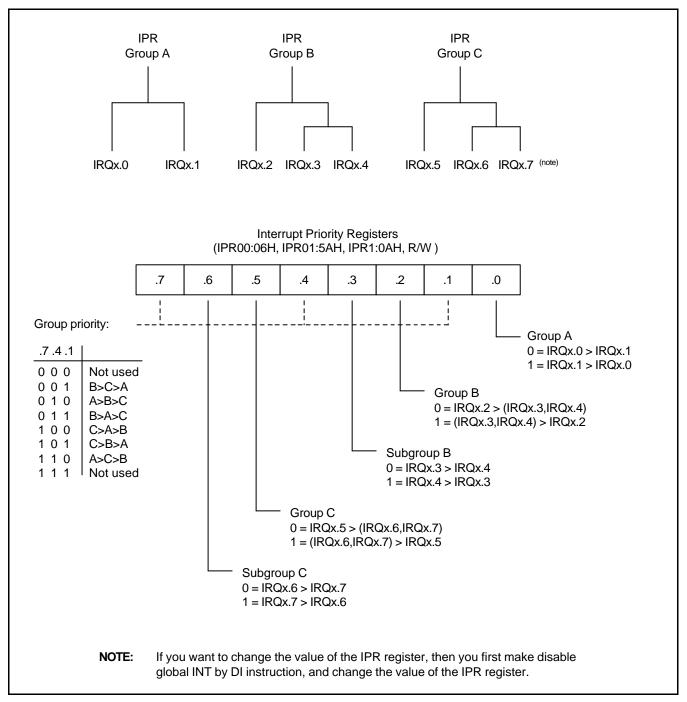


Figure 6-4. Interrupt Priority Register

S3CB519 **EXCEPTIONS**

F PROGRAMMING TIP — Interrupt Programming Tip 1

PUSH SR1 **PUSH** R0 R0, IIR00 LD CP R0, #03h ULE, LTE03 JR CP R0, #05h JR ULE, LTE05 CP R0, #06h JΡ EQ, IRQ6 srv JΡ T, IRQ7_srv LTE05 CP R0, #04 JΡ EQ, IRQ4_srv JΡ T, IRQ5_srv LTE03 CP R0, #01 JR ULE, LTE01 CP R0, #02 JΡ EQ, IRQ2_srv JΡ T, IRQ3_srv

R0, #00h

EQ, IRQ0_srv JΡ

JΡ T, IRQ1_srv

CP

Jumped from vector 2

LTE01

IRQ0_srv ; \rightarrow service for IRQ0

> POP R0 POP SR1 **IRET**

IRQ1_srv service for IRQ1

> POP R0 POP SR1 **IRET**

IRQ7_srv ; \rightarrow service for IRQ7

POP R0 POP SR1 **IRET**

NOTE: If the SR0 register is changed in the interrupt service routine, then the SR0 register must be pushed and popped in the interrupt service routine.

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EXCEPTIONS S3CB519

F

PROGRAMMING TIP — Interrupt Programming Tip 2

Jumped from vector 2

```
SR1
             PUSH
            PUSH
                         R0
            PUSH
                         R1
                         R0, IIR00
            LD
             SL
                         R0
            LD
                         R1, < TBL_INTx
            ADD
                         R0, > TBL_INTx
                         ILH, R1
            LD
            LD
                         ILL, R0
            LRET
TBL_INTx
            LJP
                         IRQ0_svr
            LJP
                         IRQ1_svr
            LJP
                         IRQ2_svr
            LJP
                         IRQ3_svr
            LJP
                         IRQ4_svr
            LJP
                         IRQ5_svr
            LJP
                         IRQ6 svr
                         IRQ7_svr
            LJP
IRQ0_srv
                                                   \rightarrow service for IRQ0
            POP
                         R1
             POP
                         R0
            POP
                         SR1
            IRET
IRQ1_srv
                                                   ; → service for IRQ1
            POP
                         R1
            POP
                         R0
            POP
                         SR1
            IRET
IRQ7_srv
                                                   ; \rightarrow service for IRQ7
             POP
                         R1
             POP
                         R0
                         SR1
            POP
            IRET
```

NOTES:

- 1. If the SR0 register is changed in the interrupt service routine, then the SR0 register must be pushed and popped in the interrupt service routine.
- 2. Above example is assumed that ROM size is less than 64K-word and all the LJP instructions in the jump table (TBL_INTx) is in the same page.



S3CB519 COPROCESSOR INTERFACE

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COPROCESSOR INTERFACE

OVERVIEW

CalmRISC supports an efficient and seamless interface with coprocessors. By integrating a MAC (multiply and accumulate) DSP coprocessor engine with the CalmRISC core, not only the microcontroller functions but also complex digital signal processing algorithms can be implemented in a single development platform (or MDS). CalmRISC has a set of dedicated signal pins, through which data/command/status are exchanged to and from a coprocessor. Depicted below are the coprocessor signal pins and the interface between two processors.

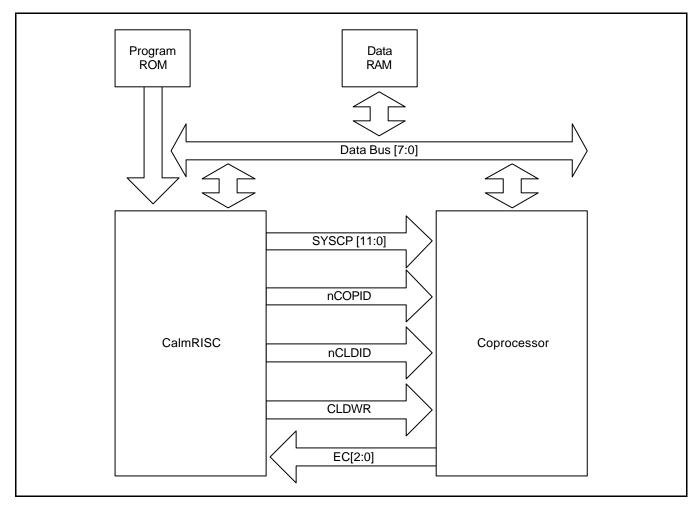


Figure 7-1. Coprocessor Interface Diagram



COPROCESSOR INTERFACE S3CB519

As shown in the coprocessor interface diagram above, the coprocessor interface signals of CalmRISC are: SYSCP[11:0], nCOPID, nCLDID, nCLDWR, and EC[2:0]. The data are exchanged through data buses, DI[7:0] and DO[7:0]. A command is issued from CalmRISC to a coprocessor through SYSCP[11:0] in COP instructions. The status of a coprocessor can be sent back to CalmRISC through EC[2:0] and these flags can be checked in the condition codes of branch instructions. The coprocessor instructions are listed in the following table

Mnemonic	Op 1	Op 2	Description
COP	#imm:12	_	Coprocessor operation
CLD	GPR	imm:8	Data transfer from coprocessor into GPR
CLD	imm:8	GPR	Data transfer of GPR to coprocessor
JP(or JR)	EC2-EC0	label	Conditional branch with coprocessor status flags
CALL			
LNK			

Table 7-1. Coprocessor instructions

The coprocessor of CalmRISC does not have its own program memory (i.e., it is a passive coprocessor) as shown in Figure 7 -1. In fact, the coprocessor instructions are fetched and decoded by CalmRISC, and CalmRISC issues the command to the coprocessor through the interface signals. For example, if "COP #imm:12" instruction is fetched, then the 12-bit immediate value (imm:12) is loaded on \$\textit{SYSCP[11:0]}\$ signal with \$nCOPID\$ active in ID/MEM stage, to request the coprocessor to perform the designated operation. The interpretation of the 12-bit immediate value is totally up to the coprocessor. By arranging the 12-bit immediate field, the instruction set of the coprocessor is determined. In other words, CalmRISC only provides a set of generic coprocessor instructions, and its installation to a specific coprocessor instruction set can differ from one coprocessor to another. CLD Write instructions ("CLD imm:8, GPR") put the content of a GPR register of CalmRISC on the data bus (\$DO[7:0]\$) and issue the address(imm:8) of the coprocessor internal register on \$\textit{SYSCP[7:0]}\$ with \$nCLDID\$ active and \$CLDWR\$ active. CLD Read instructions ("CLD GPR, imm:8" in Table 7-1) work similarly, except that the content of the coprocessor internal register addressed by the 8-bit immediate value is read into a GPR register through \$DI[7:0]\$ with \$nCLDID\$ active and \$CLDWR\$ deactivated.

The timing diagram given below is a coprocessor instruction pipeline and shows when the coprocessor performs the required operations. Suppose l_2 is a coprocessor instruction. First, it is fetched and decoded by CalmRISC (at t = T(i-1)). Once it is identified as a coprocessor instruction, CalmRISC indicates to the coprocessor the appropriate command through the coprocessor interface signals (at t = T(i)). Then the coprocessor performs the designated tasks at t = T(i) and t = T(i+1). Hence IF from CalmRISC and then ID/MEM and EX from the coprocessor constitute the pipeline for l_2 . Similarly, if l_3 is a coprocessor instruction, the coprocessor's ID/MEM and EX stages replace the corresponding stages of CalmRISC.



S3CB519 COPROCESSOR INTERFACE

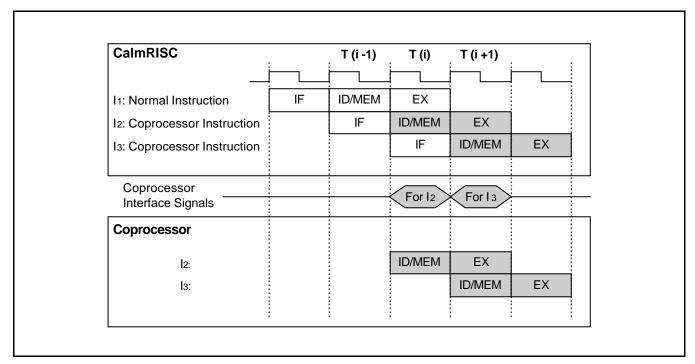


Figure 7-2. Coprocessor Instruction Pipeline

In a multi-processor system, the data transfer between processors is an important factor to determine the efficiency of the overall system. Suppose an input data stream is accepted by a processor, in order for the data to be shared by another processors. There should be some efficient mechanism to transfer the data to the processors. In CalmRISC, data transfers are accomplished through a single shared data memory. The shared data memory in a multi-processor has some inherent problems such as data hazards and deadlocks. However, the coprocessor in CalmRISC accesses the shared data memory only at the designated time by CalmRISC at which time CalmRISC is guaranteed not to access the data memory, and therefore there is no contention over the shared data memory. Another advantage of the scheme is that the coprocessor can access the data memory in its own bandwidth.

COPROCESSOR INTERFACE S3CB519

NOTES



S3CB519 INSTRUCTION SET

8

INSTRUCTION SET

OVERVIEW

GLOSSARY

This chapter describes the CalmRISC instruction set and the details of each instruction are listed in alphabetical order. The following notations are used for the description.

Table 8-1. Instruction Notation Conventions

Notation	Interpretation
<opn></opn>	Operand N. N can be omitted if there is only one operand. Typically, <op1> is the destination (and source) operand and <op2> is a source operand.</op2></op1>
GPR	General Purpose Register
SPR	Special Purpose Register (IDL0, IDL1, IDH, SR0, ILX, ILH, ILL, SR1)
adr:N	N-bit address specifier
@idm	Content of memory location pointed by ID0 or ID1
(adr:N)	Content of memory location specified by adr:N
cc:4	4-bit condition code. Table 8-6 describes cc:4.
imm:N	N-bit immediate number
&	Bit-wise AND
	Bit-wise OR
~	Bit-wise NOT
۸	Bit-wise XOR
N**M	Mth power of N
(N) _M	M-based number N

As additional note, only the affected flags are described in the tables in this section. That is, if a flag is not affected by an operation, it is NOT specified.

INSTRUCTION SET S3CB519

INSTRUCTION SET MAP

Table 8-2.Overall Instruction Set Map

IR	[12:10]000	001	010	011	100	101	110	111
[15:13,7:2] 000 xxxxxx	ADD GPR, #imm:8	SUB GPR, #imm:8	CP GPR, #imm8	LD GPR, #imm:8	TM GPR, #imm:8	AND GPR, #imm:8	OR GPR, #imm:8	XOR GPR, #imm:8
001 xxxxxx	ADD GPR, @idm	SUB GPR, @idm	CP GPR, @idm			@idm GPR GPR,		XOR GPR, @idm
010 xxxxxx	ADD GPR, adr:8	SUB GPR, adr:8	CP GPR, adr:8	LD GPR, adr:8	BITT a	dr:8.bs	BITS a	dr:8.bs
011 xxxxxx	ADC GPR, adr:8	SBC GPR, adr:8	CPC GPR, adr:8	LD adr:8, GPR	BITR a	dr:8.bs	BITC a	dr:8.bs
100 000000	ADD GPR, GPR	SUB GPR, GPR	CP GPR, GPR	BMS/BMC	LD SPR0, #imm:8	AND GPR, adr:8	OR GPR, adr:8	XOR GPR, adr:8
100 000001	ADC GPR, GPR	SBC GPR, GPR	CPC GPR, GPR	invalid				
100 000010	invalid	invalid	invalid	invalid				
100 000011	AND GPR, GPR	OR GPR, GPR	XOR GPR, GPR	invalid				
100 00010x	SLA/SL/ RLC/RL/ SRA/SR/ RRC/RR/ GPR	INC/INCC/ DEC/ DECC/ COM/ COM2/ COMC GPR	invalid	invalid				
100 00011x	LD SPR, GPR	LD GPR, SPR	SWAP GPR, SPR	LD TBH/TBL, GPR				
100 00100x	PUSH SPR	POP SPR	invalid	invalid				
100 001010	PUSH GPR	POP GPR	LD GPR, GPR	LD GPR, TBH/TBL				

S3CB519 INSTRUCTION SET

Table 8-2. Overall Instruction Set Map (Continued)

IR	[12:10]000	001	010	011	100	101	110	111
100 001011	POP	invalid	LDC	invalid	LD SPR0, #imm:8	AND GPR, adr:8	OR GPR, adr:8	XOR GPR, adr:8
100 00110x	RET/LRET/I RET/NOP/ BREAK	invalid	invalid	invalid				
100 00111x	invalid	invalid	invalid	invalid				
100 01xxxx	LD GPR:bank, GPR:bank	AND SR0, #imm:8	OR SR0, #imm:8	BANK #imm:2				
100 100000	invalid	invalid	invalid	invalid				
100 110011								
100 1101xx	LCALL cc:4,	imm:20 (2-w	ord instruction	on)				
100 1110xx	LLNK cc:4, ii	mm:20 (2-wo	rd instructior	٦)				
100 1111xx	LJP cc:4, im	m:20 (2-word	l instruction)					
[15:10] 101 xxx				JR cc:4	, imm:9			
110 0xx				CALLS	imm:12			
110 1xx				LNKS i	mm:12			
111 xxx	CLD GI	PR, imm:8 / 0	CLD imm:8,	GPR / JNZD	GPR, imm:8	3 / SYS #imn	n:8 / COP #ir	mm:12

NOTE: "invalid" - invalid instruction.

INSTRUCTION SET S3CB519

Table 8-3. Instruction Encoding

Instruction	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ADD GPR, #imm:8		000			000			PR				imm	[7:0]			-
SUB GPR, #imm:8					001											
CP GPR, #imm:8					010											
LD GPR, #imm:8					011											
TM GPR, #imm:8					100											
AND GPR, #imm:8					101											
OR GPR, #imm:8					110											
XOR GPR, #imm:8					111											
ADD GPR, @idm		001			000		GF	PR	idx	m	od		of	fset[4	:0]	
SUB GPR, @idm					001											
CP GPR, @idm					010											
LD GPR, @idm					011											
LD @idm, GPR					100											
AND GPR, @idm					101											
OR GPR, @idm					110											
XOR GPR, @idm					111											
ADD GPR, adr:8		010			000		GF	PR				adr[7:0]			
SUB GPR, adr:8					001											
CP GPR, adr:8					010											
LD GPR, adr:8					011											
BITT adr:8.bs				1	0		bs									
BITS adr:8.bs				1	1											
ADC GPR, adr:8		011			000		GF	PR				adr[7:0]			
SBC GPR, adr:8					001											
CPC GPR, adr:8					010											
LD adr:8, GPR					011											
BITR adr:8.bs				1	0		bs									
BITC adr:8.bs				1	1											

S3CB519 INSTRUCTION SET

Table 8-3. Instruction Encoding (Continued)

Instruction	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ADD GPRd, GPRs		100			000 GPRd 000000			GPRs								
SUB GPRd, GPRs					001											
CP GPRd, GPRs					010											
BMS/BMC					011											
ADC GPRd, GPRs					000						000	001				
SBC GPRd, GPRs					001											
CPC GPRd, GPRs					010											
invalid					011											
invalid					ddd						000	010				
AND GPRd, GPRs					000						000	011				
OR GPRd, GPRs					001											
XOR GPRd, GPRs					010											
invalid					011											
ALUop1					000		GF	PR	00010		P	ALUop1				
ALUop2					001		GF	PR	Γ		ALUop2					
invalid				0	10–01	1	X	Х				XXX				
LD SPR, GPR					000		GPR 00011		SPR							
LD GPR, SPR					001		GPR			SPR						
SWAP GPR, SPR					010		GF	PR							SPR	
LD TBL, GPR					011		GF	PR						х	0	х
LD TBH, GPR														х	1	х
PUSH SPR					000		X	Х			00100)			SPR	
POP SPR					001		X	Х							SPR	
invalid				0	10–01	1	X	Х							xxx	
PUSH GPR					000		GF	PR			001	010			G	PR
POP GPR					001		GF	PR				G	PR			
LD GPRd, GPRs					010		GPRd				GF	PRs				
LD GPR, TBL					011		GPR			0	Х					
LD GPR, TBH												1	Х			
POP				000		X	x	001011			xx					
LDC @IL					010										0	Х
LDC @IL+															1	Х
Invalid				0(01, 01	1									>	ΚX

NOTE: "x" means not applicable.



INSTRUCTION SET S3CB519

Table 8-3. Instruction Encoding (Concluded)

Instruction	15-13	12	11	10	9	8	7	6	5	4	3	2	1	0	2 nd word
MODop1	100		000 xx				00110 MODop1				1	-			
Invalid		0	001–011		xx			xxx							
Invalid			000		xx		01 xxxxxx			xxx					
AND SR0, #imm:8			001		imm	[7:6]					imm	[5:0]			
OR SR0, #imm:8			010		imm	[7:6]									
BANK #imm:2			011		х	Х			x imm			XXX			
										[1	:0]				
Invalid		0		XX	XX				1000	0000	-1100	1111			
LCALL cc, imm:20				С	С			11	101 imm[19:16]					imm[15:0]	
LLNK cc, imm:20															
LJP cc, imm:20															
LD SPR0, #imm:8		1	0	0	SP	R0	IMM[7:0]					_			
AND GPR, adr:8			0	1	GF	PR				ADR	[7:0]				
OR GPR, adr:8			1	0											
XOR GPR, adr:8			1	1											
JR cc, imm:9	101	imm		С	С					imm	[7:0]				
		[8]													
CALLS imm:12	110	0						imm[11:0]						
LNKS imm:12		1													
CLD GPR, imm:8	111	0	0	0	GI	PR				imm	[7:0]				
CLD imm:8, GPR			0	1	GI	PR									
JNZD GPR, imm:8			1	0	GI	PR									
SYS #imm:8			1	1	Х	Х									
COP #imm:12		1						imm[11:0]						

NOTES:

- 1. "x" means not applicable.
- 2. There are several MODop1 codes that can be used, as described in table 8-9.
- 3. The operand 1(GPR) of the instruction JNZD is Bank 3's register.



S3CB519 INSTRUCTION SET

Table 8-4. Index Code Information ("idx")

Symbol	Code	Description
ID0	0	Index 0 IDH:IDL0
ID1	1	Index 1 IDH:IDL1

Table 8-5. Index Modification Code Information ("mod")

Symbol	Code	Function		
@IDx + offset:5	00	$DM[IDx], IDx \leftarrow IDx + offset$		
@[IDx - offset:5]	01	DM[IDx + (2's complement of offset:5)],		
		$IDx \leftarrow IDx + (2's complement of offset:5)$		
@[IDx + offset:5]!	10	$DM[IDx + offset], IDx \leftarrow IDx$		
@[IDx - offset:5]!	11	$DM[IDx + (2's complement of offset:5)], IDx \leftarrow IDx$		

NOTE: Carry from IDL is propagated to IDH. In case of @[IDx - offset:5] or @[IDx - offset:5]!, the assembler should convert offset:5 to the 2's complement format to fill the operand field (offset[4:0]).

Furthermore, @[IDx - 0] and @[IDx - 0]! are converted to @[IDx + 0] and @[IDx + 0]!, respectively.

Table 8-6. Condition Code Information ("cc")

Symbol (cc:4)	Code	Function
Blank	0000	always
NC or ULT	0001	C = 0, unsigned less than
C or UGE	0010	C = 1, unsigned greater than or equal to
Z or EQ	0011	Z = 1, equal to
NZ or NE	0100	Z = 0, not equal to
OV	0101	V = 1, overflow - signed value
ULE	0110	~C Z, unsigned less than or equal to
UGT	0111	C & ~Z, unsigned greater than
ZP	1000	N = 0, signed zero or positive
MI	1001	N = 1, signed negative
PL	1010	~N & ~Z, signed positive
ZN	1011	Z N, signed zero or negative
SF	1100	Stack Full
EC0-EC2	1101-1111	EC[0] = 1/EC[1] = 1/EC[2] = 1

NOTE: EC[2:0] is an external input (CalmRISC core's point of view) and used as a condition.

INSTRUCTION SET S3CB519

Table 8-7. "ALUop1" Code Information

Symbol	Code	Function			
SLA	000	arithmetic shift left			
SL	001	shift left			
RLC	010	rotate left with carry			
RL	011	rotate left			
SRA	100	arithmetic shift right			
SR	101	shift right			
RRC	110	rotate right with carry			
RR	111	rotate right			

Table 8-8. "ALUop2" Code Information

Symbol	Code	Function
INC	000	increment
INCC	001	increment with carry
DEC	010	decrement
DECC	011	decrement with carry
СОМ	100	1's complement
COM2	101	2's complement
COMC	110	1's complement with carry
_	111	reserved

Table 8-9. "MODop1" Code Information

Symbol	Code	Function
LRET	000	return by IL
RET	001	return by HS
IRET	010	return from interrupt (by HS)
NOP	011	no operation
BREAK	100	reserved for debugger use only
_	101	reserved
_	110	reserved
_	111	reserved

S3CB519 INSTRUCTION SET

QUICK REFERENCE

Operation	op1	op2	Function	Flag	# of word / cycle
AND	GPR	adr:8	op1 ← op1 & op2	z,n	1W1C
OR		#imm:8	op1 ← op1 op2	z,n	
XOR		GPR	op1 ← op1 ^ op2	z,n	
ADD		@idm	op1 ← op1 + op2	c,z,v,n	
SUB			op1 ← op1 + ~op2 + 1	c,z,v,n	
CP			op1 + ~op2 + 1	c,z,v,n	
ADC	GPR	GPR	op1 ← op1 + op2 + c	c,z,v,n	
SBC		adr:8	op1 ← op1 + ~op2 + c	c,z,v,n	
CPC			op1 + ~op2 + c	c,z,v,n	
TM	GPR	#imm:8	op1 & op2	z,n	
BITS	R3	adr:8.bs	$op1 \leftarrow (op2[bit] \leftarrow 1)$	Z	
BITR			$op1 \leftarrow (op2[bit] \leftarrow 0)$	z	
BITC			op1 ← ~(op2[bit])	z	
BITT			$z \leftarrow \sim (op2[bit])$	Z	
BMS/BMC	ı	_	TF ← 1 / 0	ı	
PUSH	GPR	_	$HS[sptr] \leftarrow GPR$, $(sptr \leftarrow sptr + 1)$	-	
POP	_		$GPR \leftarrow HS[sptr - 1], (sptr \leftarrow sptr - 1)$	z,n	
PUSH	SPR	_	$HS[sptr] \leftarrow SPR, (sptr \leftarrow sptr + 1)$	_	
POP	_		$SPR \leftarrow HS[sptr-1], (sptr \leftarrow sptr-1)$		
POP	_	_	sptr ← sptr – 2	_	

Ī				
SLA	GPR	_	$c \leftarrow op1[7], op1 \leftarrow \{op1[6:0], 0\}$	c,z,v,n
SL			$c \leftarrow op1[7], op1 \leftarrow \{op1[6:0], 0\}$	c,z,n
RLC			$c \leftarrow op1[7], op1 \leftarrow \{op1[6:0], c\}$	c,z,n
RL			$c \leftarrow op[7], op1 \leftarrow \{op1[6:0], op1[7]\}$	c,z,n
SRA			$c \leftarrow op[0], op1 \leftarrow \{op1[7], op1[7:1]\}$	c,z,n
SR			$c \leftarrow op1[0], op1 \leftarrow \{0, op1[7:1]\}$	c,z,n
RRC			$c \leftarrow op1[0], op1 \leftarrow \{c, op1[7:1]\}$	c,z,n
RR			$c \leftarrow op1[0], op1 \leftarrow \{op1[0], op1[7:1]\}$	c,z,n
INC			op1 ← op1 + 1	c,z,v,n
INCC			op1 ← op1 + c	c,z,v,n
DEC			op1 ← op1 + 0FFh	c,z,v,n
DECC			op1 ← op1 + 0FFh + c	c,z,v,n
СОМ			op1 ← ~op1	z,n
COM2			op1 ← ~op1 + 1	c,z,v,n
COMC			op1 ← ~op1 + c	c,z,v,n

QUICK REFERENCE (Continued)

Operation	op1	op2	Function	Flag	# of word / cycle
LD	GPR :bank	GPR :bank	op1 ← op2	z,n	1W1C
LD	SPR0	#imm:8	op1 ← op2	_	
LD	GPR	GPR SPR adr:8 @idm #imm:8 TBH/TBL	op1 ← op2	z,n	
LD	SPR TBH/TBL	GPR	op1 ← op2	ı	
LD	adr:8	GPR	op1 ← op2	1	
LD	@idm	GPR	op1 ← op2	_	
LDC	@IL @IL+	ı	$ \begin{aligned} & (TBH:TBL) \leftarrow PM[(ILX:ILH:ILL)], \\ & ILL++ \text{ if } @ IL+ \end{aligned} $	ı	1W2C
AND OR	SR0	#imm:8	SR0 ← SR0 & op2 SR0 ← SR0 op2	_	1W1C
BANK	#imm:2	-	SR0[4:3] ← op2	-	1
SWAP	GPR	SPR	$op1 \leftarrow op2$, $op2 \leftarrow op1$ (excluding SR0/SR1)	_]
LCALL cc	imm:20	-	If branch taken, push XSTACK, $ \begin{aligned} &\text{HS}[15:0] \leftarrow \{\text{PC}[15:12], \text{PC}[11:0] + 2\} \text{ and} \\ &\text{PC} \leftarrow \text{op1} \\ &\text{else PC}[11:0] \leftarrow \text{PC}[11:0] + 2 \end{aligned} $	_	2W2C
LLNK cc	imm:20	-	If branch taken, IL[19:0] \leftarrow {PC[19:12], PC[11:0] + 2} and PC \leftarrow op1 else PC[11:0] \leftarrow PC[11:0] + 2	-	
CALLS	imm:12	ı	push XSTACK, HS[15:0] \leftarrow {PC[15:12], PC[11:0] + 1} and PC[11:0] \leftarrow op1	I	1W2C
LNKS	imm:12	I	IL[19:0] \leftarrow {PC[19:12], PC[11:0] + 1} and PC[11:0] \leftarrow op1	I	
JNZD	Rn	imm:8	if (Rn == 0) PC ← PC[delay slot] - 2's complement of imm:8, Rn else PC ← PC[delay slot]++, Rn	_	
LJP cc	imm:20	_	If branch taken, PC ← op1	_	2W2C
			else PC[11:0] < PC[11:0] + 2		
JR cc	imm:9	_	If branch taken, PC[11:0] ← PC[11:0] + op1 else PC[11:0] ← PC[11:0] + 1	_	1W2C

NOTE: op1 - operand1, op2 - operand2, 1W1C - 1-Word 1-Cycle instruction, 1W2C - 1-Word 2-Cycle instruction, 2W2C - 2-Word 2-Cycle instruction. The Rn of instruction JNZD is Bank 3's GPR.



QUICK REFERENCE (Concluded)

Operation	op1	op2	Function	Flag	# of word / cycle
LRET	_	_	PC ← IL[19:0]	_	1W2C
RET			$PC \leftarrow HS[sptr - 2], (sptr \leftarrow sptr - 2)$		1W2C
IRET			$PC \leftarrow HS[sptr - 2], (sptr \leftarrow sptr - 2)$		1W2C
NOP			no operation		1W1C
BREAK			no operation and hold PC		1W1C
SYS	#imm:8	-	no operation but generates SYSCP[7:0] and nSYSID	-	1W1C
CLD	imm:8	GPR	op1 \leftarrow op2, generates SYSCP[7:0], nCLDID, and CLDWR	-	
CLD	GPR	imm:8	op1 \leftarrow op2, generates SYSCP[7:0], nCLDID, and CLDWR	z,n	
COP	#imm:12	_	generates SYSCP[11:0] and nCOPID	_	

NOTES:

1. op1 - operand1, op2 - operand2, sptr - stack pointer register, 1W1C - 1-Word 1-Cycle instruction, 1W2C - 1-Word 2-Cycle instruction

- 2. Pseudo instructions
 - SCF/RCF
 - Carry flag set or reset instruction
 - STOP/IDLE
 - MCU power saving instructions
 - FI/D
 - Exception enable and disable instructions
 - JP/LNK/CALL

If JR/LNKS/CALLS commands (1 word instructions) can access the target address, there is no conditional code in the case of CALL/LNK, and the JP/LNK/CALL commands are assembled to JR/LNKS/CALLS in linking time,

or

else the JP/LNK/CALL commands are assembled to LJP/LLNK/LCALL (2 word instructions) instructions.



INSTRUCTION GROUP SUMMARY

ALU INSTRUCTIONS

"ALU instructions" refer to the operations that use ALU to generate results. ALU instructions update the values in Status Register 1 (SR1), namely carry (C), zero (Z), overflow (V), and negative (N), depending on the operation type and the result.

ALUop GPR, adr:8

Performs an ALU operation on the value in GPR and the value in DM[adr:8] and stores the result into GPR.

ALUop = ADD, SUB, CP, AND, OR, XOR

For SUB and CP, GPR+(not DM[adr:8])+1 is performed.

adr:8 is the offset in a specific data memory page.

The data memory page is 0 or the value of IDH (Index of Data Memory Higher Byte Register), depending on the value of eid in Status Register 0 (SR0).

Operation

```
GPR \leftarrow GPR ALUop DM[00h:adr:8] if eid = 0 GPR \leftarrow GPR ALUop DM[IDH:adr8] if eid = 1 Note that this is an 8-bit operation.
```

Example

```
ADD R0, 80h // Assume eid = 1 and IDH = 01H // R0 \leftarrow R0 + DM[0180h]
```

ALUop GPR, #imm:8

Stores the result of an ALU operation on GPR and an 8-bit immediate value into GPR. ALUop = ADD, SUB, CP, AND, OR, XOR For SUB and CP, GPR+(not #imm:8)+1 is performed. #imm:8 is an 8-bit immediate value.

Operation

GPR ← GPR ALUop #imm:8

Example

ADD R0, #7Ah // R0 \leftarrow R0 + 7Ah

ALUop GPRd, GPRs

Store the result of ALUop on GPRs and GPRd into GPRd. ALUop = ADD, SUB, CP, AND, OR, XOR For SUB and CP, GPRd + (not GPRs) + 1 is performed. GPRs and GPRd need not be distinct.

Operation

```
GPRd ← GPRd ALUop GPRs
GPRd - GPRs when ALUop = CP (comparison only)
```

Example

ADD R0, R1 // R0 \leftarrow R0 + R1

ALUop GPR, @idm

Performs ALUop on the value in GPR and DM[ID] and stores the result into GPR. Index register ID is IDH:IDL (IDH:IDL0 or IDH:IDL1).

```
ALUop = ADD, SUB, CP, AND, OR, XOR
For SUB and CP, GPR+(not DM[idm])+1 is performed.
idm = IDx+off:5, [IDx-offset:5], [IDx+offset:5]!, [IDx-offset:5]!
(IDx = ID0 or ID1)
```

Operation

```
GPR - DM[idm] when ALUop = CP (comparison only) GPR \leftarrow GPR ALUop DM[IDx], IDx \leftarrow IDx + offset:5 when idm = IDx + offset:5 GPR \leftarrow GPR ALUop DM[IDx - offset:5], IDx \leftarrow IDx - offset:5 when idm = [IDx - offset:5] GPR \leftarrow GPR ALUop DM[IDx + offset:5] when idm = [IDx + offset:5]! GPR \leftarrow GPR ALUop DM[IDx - offset:5] when idm = [IDx - offset:5]!
```

When carry is generated from IDL (on a post-increment or pre-decrement), it is propagated to IDH.



ALUopc GPRd, GPRs

Performs ALUop with carry on GPRd and GPRs and stores the result into GPRd. ALUopc = ADC, SBC, CPC GPRd and GPRs need not be distinct.

Operation

```
GPRd ← GPRd + GPRs + C when ALUopc = ADC
GPRd ← GPRd + (not GPRs) + C when ALUopc = SBC
GPRd + (not GPRs) + C when ALUopc = CPC (comparison only)
```

Example

```
ADD R0, R2  // assume R1:R0 and R3:R2 are 16-bit signed or unsigned numbers.

ADC R1, R3  // to add two 16-bit numbers, use ADD and ADC.

SUB R0, R2  // assume R1:R0 and R3:R2 are 16-bit signed or unsigned numbers.

SBC R1, R3  // to subtract two 16-bit numbers, use SUB and SBC.

CP R0, R2  // assume both R1:R0 and R3:R2 are 16-bit unsigned numbers.

CPC R1, R3  // to compare two 16-bit unsigned numbers, use CP and CPC.
```

ALUopc GPR, adr:8

Performs ALUop with carry on GPR and DM[adr:8].

Operation

```
\label{eq:GPR} \begin{split} \mathsf{GPR} \leftarrow \mathsf{GPR} + \mathsf{DM}[\mathsf{adr}:8] + \mathsf{C} \ \mathsf{when} \ \mathsf{ALUopc} &= \mathsf{ADC} \\ \mathsf{GPR} \leftarrow \mathsf{GPR} + (\mathsf{not} \ \mathsf{DM}[\mathsf{adr}:8]) + \mathsf{C} \ \mathsf{when} \ \mathsf{ALUopc} &= \mathsf{SBC} \\ \mathsf{GPR} + (\mathsf{not} \ \mathsf{DM}[\mathsf{adr}:8]) + \mathsf{C} \ \mathsf{when} \ \mathsf{ALUopc} &= \mathsf{CPC} \ (\mathsf{comparison} \ \mathsf{only}) \end{split}
```

CPLop GPR (Complement Operations)

CPLop = COM, COM2, COMC

Operation

COM GPR	not GPR (logical complement)
COM2 GPR	not GPR + 1 (2's complement of GPR)
COMC GPR	not GPR + C (logical complement of GPR with carry)

```
COM2 R0 // assume R1:R0 is a 16-bit signed number.

COMC R1 // COM2 and COMC can be used to get the 2's complement of it.
```

IncDec GPR (Increment/Decrement Operations)

IncDec = INC, INCC, DEC, DECC

Operation

INC GPR Increase GPR, i.e., $GPR \leftarrow GPR + 1$

INCC GPR Increase GPR if carry = 1, i.e., $GPR \leftarrow GPR + C$

 $\mbox{DEC GPR} \qquad \qquad \mbox{Decrease GPR, i.e., GPR} \leftarrow \mbox{GPR} + \mbox{FFh}$

DECC GPR Decrease GPR if carry = 0, i.e., $GPR \leftarrow GPR + FFh + C$

Example

INC R0 // assume R1:R0 is a 16-bit number INCC R1 // to increase R1:R0, use INC and INCC.

DEC R0 // assume R1:R0 is a 16-bit number

DECC R1 // to decrease R1:R0, use DEC and DECC.



SHIFT/ROTATE INSTRUCTIONS

Shift (Rotate) instructions shift (rotate) the given operand by 1 bit. Depending on the operation performed, a number of Status Register 1 (SR1) bits, namely Carry (C), Zero (Z), Overflow (V), and Negative (N), are set.

SL GPR

Operation



Carry (C) is the MSB of GPR before shifting, Negative (N) is the MSB of GPR after shifting. Overflow (V) is not affected. Zero (Z) will be 1 if the result is 0.

SLA GPR

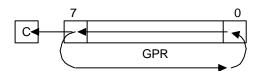
Operation



Carry (C) is the MSB of GPR before shifting, Negative (N) is the MSB of GPR after shifting. Overflow (V) will be 1 if the MSB of the result is different from C. Z will be 1 if the result is 0.

RL GPR

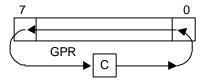
Operation



Carry (C) is the MSB of GPR before rotating. Negative (N) is the MSB of GPR after rotatin/g. Overflow (V) is not affected. Zero (Z) will be 1 if the result is 0.

RLC GPR

Operation



Carry (C) is the MSB of GPR before rotating, Negative (N) is the MSB of GPR after rotating. Overflow (V) is not affected. Zero (Z) will be 1 if the result is 0.

SR GPR

Operation



Carry (C) is the LSB of GPR before shifting, Negative (N) is the MSB of GPR after shifting. Overflow (V) is not affected. Zero (Z) will be 1 if the result is 0.

SRA GPR

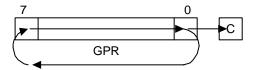
Operation



Carry (C) is the LSB of GPR before shifting, Negative (N) is the MSB of GPR after shifting. Overflow (V) is not affected. Z will be 1 if the result is 0.

RR GPR

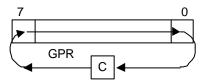
Operation



Carry (C) is the LSB of GPR before rotating. Negative (N) is the MSB of GPR after rotating. Overflow (V) is not affected. Zero (Z) will be 1 if the result is 0.

RRC GPR

Operation



Carry (C) is the LSB of GPR before rotating, Negative (N) is the MSB of GPR after rotating. Overflow (V) is not affected. Zero (Z) will be 1 if the result is 0.

LOAD INSTRUCTIONS

Load instructions transfer data from data memory to a register or from a register to data memory, or assigns an immediate value into a register. As a side effect, a load instruction placing a value into a register sets the Zero (Z) and Negative (N) bits in Status Register 1 (SR1), if the placed data is 00h and the MSB of the data is 1, respectively.

LD GPR, adr:8

Loads the value of DM[adr:8] into GPR. Adr:8 is offset in the page specified by the value of eid in Status Register 0 (SR0).

Operation

```
GPR \leftarrow DM[00h:adr:8] if eid = 0 GPR \leftarrow DM[IDH:adr:8] if eid = 1
```

Note that this is an 8-bit operation.

Example

```
LD R0, 80h // assume eid = 1 and IDH= 01H // R0 \leftarrow DM[0180h]
```

LD GPR, @idm

Loads a value from the data memory location specified by @idm into GPR. idm = IDx+off:5, [IDx-offset:5], [IDx+offset:5]!, [IDx-offset:5]! (IDx = ID0 or ID1)

Operation

```
\begin{split} \mathsf{GPR} \leftarrow \mathsf{DM[IDx]}, \ \mathsf{IDx} \leftarrow \mathsf{IDx} + \mathsf{offset:5} \ \mathsf{when} \ \mathsf{idm} = \mathsf{IDx} + \mathsf{offset:5} \\ \mathsf{GPR} \leftarrow \mathsf{DM[IDx} - \mathsf{offset:5}], \ \mathsf{IDx} \leftarrow \mathsf{IDx} - \mathsf{offset:5} \ \mathsf{when} \ \mathsf{idm} = [\mathsf{IDx} - \mathsf{offset:5}] \\ \mathsf{GPR} \leftarrow \mathsf{DM[IDx} + \mathsf{offset:5}] \ \mathsf{when} \ \mathsf{idm} = [\mathsf{IDx} + \mathsf{offset:5}]! \\ \mathsf{GPR} \leftarrow \mathsf{DM[IDx} - \mathsf{offset:5}] \ \mathsf{when} \ \mathsf{idm} = [\mathsf{IDx} - \mathsf{offset:5}]! \end{split}
```

When carry is generated from IDL (on a post-increment or pre-decrement), it is propagated to IDH.

```
LD R0, @[ID0 + 03h]!  // assume IDH:IDL0 = 0270h  // R0 \leftarrow DM[0273h], IDH:IDL0 \leftarrow 0270h
```

LD REG, #imm:8

Loads an 8-bit immediate value into REG. REG can be either GPR or an SPR0 group register - IDH (Index of Data Memory Higher Byte Register), IDL0 (Index of Data Memory Lower Byte Register)/ IDL1, and Status Register 0 (SR0). #imm:8 is an 8-bit immediate value.

Operation

REG ← #imm:8

Example

```
LD R0 #7Ah // R0 \leftarrow 7Ah LD IDH, #03h // IDH \leftarrow 03h
```

LD GPR:bs:2, GPR:bs:2

Loads a value of a register from a specified bank into another register in a specified bank.

Example

LD R0:1, R2:3 // R0 in bank 1, R2 in bank 3

LD GPR, TBH/TBL

Loads the value of TBH or TBL into GPR. TBH and TBL are 8-bit long registers used exclusively for LDC instructions that access program memory. Therefore, after an LDC instruction, LD GPR, TBH/TBL instruction will usually move the data into GPRs, to be used for other operations.

Operation

 $GPR \leftarrow TBH (or TBL)$

Example

LDC @IL // gets a program memory item residing @ ILX:ILH:ILL LD R0, TBH LD R1, TBL

LD TBH/TBL, GPR

Loads the value of GPR into TBH or TBL. These instructions are used in pair in interrupt service routines to save and restore the values in TBH/TBL as needed.

Operation

TBH (or TBL) \leftarrow GPR

LD GPR, SPR

Loads the value of SPR into GPR.

Operation

GPR ← SPR

Example

LD R0, IDH // R0 \leftarrow IDH



LD SPR, GPR

Loads the value of GPR into SPR.

Operation

 $SPR \leftarrow GPR$

Example

LD IDH, R0 // IDH \leftarrow R0

LD adr:8, GPR

Stores the value of GPR into data memory (DM). adr:8 is offset in the page specified by the value of eid in Status Register 0 (SR0).

Operation

```
DM[00h:adr:8] \leftarrow GPR if eid = 0
DM[IDH:adr:8] \leftarrow GPR if eid = 1
```

Note that this is an 8-bit operation.

Example

```
LD 7Ah, R0 // assume eid = 1 and IDH = 02h. 
 // DM[027Ah] \leftarrow R0
```

LD @idm, GPR

Loads a value into the data memory location specified by @idm from GPR. idm = IDx+off:5, [IDx-offset:5], [IDx+offset:5]!, [IDx-offset:5]! (IDx = ID0 or ID1)

Operation

```
\begin{split} &DM[IDx] \leftarrow GPR, \ IDx \leftarrow IDx + offset:5 \ when \ idm = IDx + offset:5 \\ &DM[IDx - offset:5] \leftarrow GPR, \ IDx \leftarrow IDx - offset:5 \ when \ idm = [IDx - offset:5] \\ &DM[IDx + offset:5] \leftarrow GPR \ when \ idm = [IDx + offset:5]! \\ &DM[IDx - offset:5] \leftarrow GPR \ when \ idm = [IDx - offset:5]! \end{split}
```

When carry is generated from IDL (on a post-increment or pre-decrement), it is propagated to IDH.

BRANCH INSTRUCTIONS

Branch instructions can be categorized into jump instruction, link instruction, and call instruction. A jump instruction does not save the current PC, whereas a call instruction saves ("pushes") the current PC onto the stack and a link instruction saves the PC in the link register IL. Status registers are not affected. Each instruction type has a 2-word format that supports a 20-bit long jump.

JR cc:4, imm:9

imm:9 is a signed number (2's complement), an offset to be added to the current PC to compute the target (PC[19:12]:(PC[11:0] + imm:9)).

Operation

```
PC[11:0] \leftarrow PC[11:0] + imm:9 if branch taken (i.e., cc:4 resolves to be true) PC[11:0] \leftarrow PC[11:0] + 1 otherwise
```

Example

```
L18411:  // assume current PC = 18411h.

JR Z, 107h  // next PC is 18518 (18411h + 107h) if Zero (Z) bit is set.
```

LJP cc:4, imm:20

Jumps to the program address specified by imm:20. If program size is less than 64K word, PC[19:16] is not affected.

Operation

```
PC[15:0] \leftarrow imm[15:0] if branch taken and program size is less than 64K word PC[19:0] \leftarrow imm[19:0] if branch taken and program size is equal to 64K word or more PC[11:0] \leftarrow PC[11:0] + 1 otherwise
```

Example

```
L18411: // assume current PC = 18411h. 
LJP Z, 10107h // next instruction's PC is 10107h If Zero (Z) bit is set
```

JNZD Rn, imm:8

Jumps to the program address specified by imm:8 if the value of the bank 3 register Rn is not zero. JNZD performs only backward jumps, with the value of Rn automatically decreased. There is one delay slot following the JNZD instruction that is always executed, regardless of whether JNZD is taken or not.

Operation

```
If (Rn == 0) PC \leftarrow PC[delay slot] (-) 2's complement of imm:8, Rn \leftarrow Rn - 1 else PC \leftarrow PC[delay slot] + 1, Rn \leftarrow Rn - 1.
```



Example

```
LOOP_A: // start of loop body

•

•

JNZD R0, LOOP_A // jump back to LOOP_A if R0 is not zero
ADD R1, #2 // delay slot, always executed (you must use one cycle instruction only)
```

CALLS imm:12

Saves the current PC on the stack ("pushes" PC) and jumps to the program address specified by imm:12. The current page number PC[19:12] is not changed. Since this is a 1-word instruction, the return address pushed onto the stack is (PC + 1). If nP64KW is low when PC is saved, PC[19:16] is not saved in the stack.

Operation

```
HS[sptr][15:0] \leftarrow current PC + 1 and sptr \leftarrow sptr + 2 (push stack) if nP64KW = 0 HS[sptr][19:0] \leftarrow current PC + 1 and sptr \leftarrow sptr + 2 (push stack) if nP64KW = 1 PC[11:0] \leftarrow imm:12
```

Example

```
L18411: // assume current PC = 18411h. CALLS 107h // call the subroutine at 18107h, with the current PC pushed // onto the stack (HS \leftarrow 18412h) if nP64KW = 1.
```

LCALL cc:4, imm:20

Saves the current PC onto the stack (pushes PC) and jumps to the program address specified by imm:20. Since this is a 2-word instruction, the return address saved in the stack is (PC + 2). If nP64KW, a core input signal is low when PC is saved, 00001111111PC[19:16] is not saved in the stack and PC[19:16] is not set to imm[19:16].

Operation

```
HS[sptr][15:0] \leftarrow current PC + 2 and sptr + 2 (push stack) if branch taken and nP64KW = 0 HS[sptr][19:0] \leftarrow current PC + 2 and sptr + 2 (push stack) if branch taken and nP64KW = 0 PC[15:0] \leftarrow imm[15:0] if branch taken and nP64KW = 0 PC[19:0] \leftarrow imm[19:0] if branch taken and nP64KW = 1 PC[11:0] \leftarrow PC[11:0] + 2 otherwise
```

```
L18411: // assume current PC = 18411h. LCALL NZ, 10107h // call the subroutine at 10107h with the current PC pushed // onto the stack (HS \leftarrow 18413h)
```

LNKS imm:12

Saves the current PC in IL and jumps to the program address specified by imm:12. The current page number PC[19:12] is not changed. Since this is a 1-word instruction, the return address saved in IL is (PC + 1). If the program size is less than 64K word when PC is saved, PC[19:16] is not saved in ILX.

Operation

```
\begin{array}{ll} \text{IL}[15:0] \leftarrow \text{current PC + 1} & \text{if program size is less than 64K word} \\ \text{IL}[19:0] \leftarrow \text{current PC + 1} & \text{if program size is equal to 64K word or more} \\ \text{PC}[11:0] \leftarrow \text{imm:12} & \text{if program size is equal to 64K word or more} \\ \end{array}
```

Example

```
L18411: // assume current PC = 18411h. LNKS 107h // call the subroutine at 18107h, with the current PC saved // in IL (IL[19:0] \leftarrow 18412h) if program size is 64K word or more.
```

LLNK cc:4, imm:20

Saves the current PC in IL and jumps to the program address specified by imm:20. Since this is a 2-word instruction, the return address saved in IL is (PC + 2). If the program size is less than 64K word when PC is saved, PC[19:16] is not saved in ILX.

Operation

```
IL[15:0] \leftarrow \text{current PC} + 2 if branch taken and program size is less than 64K word IL[19:0] \leftarrow \text{current PC} + 2 if branch taken and program size is 64K word or more PC[15:0] \leftarrow \text{imm}[15:0] if branch taken and program size is less than 64K word PC[19:0] \leftarrow \text{imm}[19:0] if branch taken and program size is 64K word or more PC[11:0] \leftarrow PC[11:0] + 2 otherwise
```

Example

```
L18411: // assume current PC = 18411h. 
LLNK NZ, 10107h // call the subroutine at 10107h with the current PC saved 
// in IL (IL[19:0] \leftarrow 18413h) if program size is 64K word or more
```

RET, IRET

Returns from the current subroutine. IRET sets ie (SR0[1]) in addition. If the program size is less than 64K word, PC[19:16] is not loaded from HS[19:16].

Operation

```
PC[15:0] \leftarrow HS[sptr - 2] and sptr \leftarrow sptr - 2 (pop stack) if program size is less than 64K word PC[19:0] \leftarrow HS[sptr - 2] and sptr \leftarrow sptr - 2 (pop stack) if program size is 64K word or more
```

```
RET // assume sptr = 3h and HS[1] = 18407h.
// the next PC will be 18407h and sptr is set to 1h
```



LRET

Returns from the current subroutine, using the link register IL. If the program size is less than 64K word, PC[19:16] is not loaded from ILX.

Operation

```
PC[15:0] \leftarrow IL[15:0] if program size is less than 64K word PC[19:0] \leftarrow IL[19:0] if program size is 64K word or more
```

Example

```
LRET // assume IL = 18407h.

// the next instruction to execute is at PC = 18407h

// if program size is 64K word or more
```

JP/LNK/CALL

JP/LNK/CALL instructions are pseudo instructions. If JR/LNKS/CALLS commands (1 word instructions) can access the target address, there is no conditional code in the case of CALL/LNK and the JP/LNK/CALL commands are assembled to JR/LNKS/CALLS in linking time or else the JP/LNK/CALL commands are assembled to LJP/LLNK/LCALL (2 word instructions) instructions.

BIT MANIPULATION INSTRUCTIONS

BITop adr:8.bs

Performs a bit operation specified by op on the value in the data memory pointed by adr:8 and stores the result into R3 of current GPR bank or back into memory depending on the value of TF bit.

```
BITop = BITS, BITR, BITC, BITT
```

BITS: bit set BITR: bit reset

BITC: bit complement

BITT: bit test (R3 is not touched in this case)

bs: bit location specifier, 0 - 7.

Operation

```
R3 \leftarrow DM[00h:adr:8] BITop bs if eid = 0
```

R3 ← DM[IDH:adr:8] BITop bs if eid = 1 (no register transfer for BITT)

Set the Zero (Z) bit if the result is 0.

Example

```
BITS 25h.3 // assume eid = 0. set bit 3 of DM[00h:25h] and store the result in R3. BITT 25h.3 // check bit 3 of DM[00h:25h] if eid = 0.
```

BMC/BMS

Clears or sets the TF bit, which is used to determine the destination of BITop instructions. When TF bit is clear, the result of BITop instructions will be stored into R3 (fixed); if the TF bit is set, the result will be written back to memory.

Operation

$$TF \leftarrow 0$$
 (BMC)
 $TF \leftarrow 1$ (BMS)

TM GPR, #imm:8

Performs AND operation on GPR and imm:8 and sets the Zero (Z) and Negative (N) bits. No change in GPR.

Operation

BITop GPR.bs

Performs a bit operation on GPR and stores the result in GPR.

Since the equivalent functionality can be achieved using OR GPR, #imm:8, AND GPR, #imm:8, and XOR GPR, #imm:8, this instruction type doesn't have separate op codes.



AND SR0, #imm:8/OR SR0, #imm:8

Sets/resets bits in SR0 and stores the result back into SR0.

Operation

```
SR0 \leftarrow SR0 \& \#imm:8

SR0 \leftarrow SR0 \mid \#imm:8
```

BANK #imm:2

Loads SR0[4:3] with #imm[1:0].

Operation

 $SR0[4:3] \leftarrow \#imm[1:0]$

MISCELLANEOUS INSTRUCTION

SWAP GPR, SPR

Swaps the values in GPR and SPR. SR0 and SR1 can NOT be used for this instruction. No flag is updated, even though the destination is GPR.

Operation

```
temp \leftarrow SPR \\ SPR \leftarrow GPR \\ GPR \leftarrow temp
```

Example

```
SWAP R0, IDH // assume IDH = 00h and R0 = 08h.
// after this, IDH = 08h and R0 = 00h.
```

PUSH REG

Saves REG in the stack (Pushes REG into stack). REG = GPR, SPR

Operation

```
HS[sptr][7:0] \leftarrow REG \text{ and } sptr \leftarrow sptr + 1
```

```
PUSH R0 // assume R0 = 08h and sptr = 2h // then HS[2][7:0] \leftarrow 08h and sptr \leftarrow 3h
```

POP REG

Pops stack into REG. REG = GPR, SPR

Operation

REG \leftarrow HS[sptr-1][7:0] and sptr \leftarrow sptr – 1

Example

```
POP R0 // assume sptr = 3h and HS[2] = 18407h
// R0 \leftarrow 07h and sptr \leftarrow 2h
```

POP

Pops 2 bytes from the stack and discards the popped data.

NOP

Does no work but increase PC by 1.

BREAK

Does nothing and does NOT increment PC. This instruction is for the debugger only. When this instruction is executed, the processor is locked since PC is not incremented. Therefore, this instruction should not be used under any mode other than the debug mode.

SYS #imm:8

Does nothing but increase PC by 1 and generates SYSCP[7:0] and nSYSID signals.

CLD GPR, imm:8

GPR ← (imm:8) and generates SYSCP[7:0], nCLDID, and nCLDWR signals.

CLD imm:8, GPR

(imm:8) \leftarrow GPR and generates SYSCP[7:0], nCLDID, and nCLDWR signals.

COP #imm:12

Generates SYSCP[11:0] and nCOPID signals.



LDC

Loads program memory item into register.

Operation

```
 \begin{split} & [\mathsf{TBH}:\mathsf{TBL}] \leftarrow \mathsf{PM}[\mathsf{ILX}:\mathsf{ILH}:\mathsf{ILL}] & (\mathsf{LDC} \ @ \mathsf{IL}) \\ & [\mathsf{TBH}:\mathsf{TBL}] \leftarrow \mathsf{PM}[\mathsf{ILX}:\mathsf{ILH}:\mathsf{ILL}], \ \mathsf{ILL}++ & (\mathsf{LDC} \ @ \mathsf{IL}+) \end{split}
```

TBH and TBL are temporary registers to hold the transferred program memory items. These can be accessed only by LD GPR and TBL/TBH instruction.

```
LD ILX, R1 // assume R1:R2:R3 has the program address to access LD ILH, R2 LD ILL, R3 LDC @IL // get the program data @(ILX:ILH:ILL) into TBH:TBL
```

PSEUDO INSTRUCTIONS

EI/DI

Exceptions enable and disable instruction.

Operation

```
SR0 \leftarrow OR SR0,\#00000010b (EI) SR0 \leftarrow AND SR0,\#111111101b (DI)
```

Exceptions are enabled or disabled through this instruction. If there is an EI instruction, the SR0.1 is set and reset, when DI instruction.

Example

DI

- •
- •
- ΕI

SCF/RCF

Carry flag set and reset instruction.

Operation

CP R0,R0 (SCF) AND R0,R0 (RCF)

Carry flag is set or reset through this instruction. If there is an SCF instruction, the SR1.0 is set and reset, when RCF instruction.

Example

SCF

RCF

STOP/IDLE

MCU power saving instruction.

Operation

SYS #0Ah (STOP) SYS #05h (IDLE)

The STOP instruction stops the both CPU clock and system clock and causes the microcontroller to enter STOP mode. The IDLE instruction stops the CPU clock while allowing system clock oscillation to continue.

Example

STOP(or IDLE)

NOP

NOP

NOP

- •
- _



ADC — Add with Carry

Format: ADC <op1>, <op2>

<op1>: GPR
<op2>: adr:8, GPR

Operation: $\langle op1 \rangle \leftarrow \langle op1 \rangle + \langle op2 \rangle + C$

ADC adds the values of <op1> and <op2> and carry (C) and stores the result back into <op1>

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.
N: exclusive OR of V and MSB of result.

Example:

ADC R0, R1 // R0 \leftarrow R0 + R1 + C

ADD R0, R2 ADC R1, R3

In the last two instructions, assuming that register pair R1:R0 and R3:R2 are 16-bit signed or unsigned numbers. Even if the result of "ADD R0, R2" is not zero, Z flag can be set to '1' if the result of "ADC R1,R3" is zero. Note that zero (Z) flag do not exactly reflect result of 16-bit operation. Therefore when programming 16-bit addition, take care of the change of Z flag.



ADD — Add

Format: ADD <op1>, <op2>

<op1>: GPR

<op2>: adr:8, #imm:8, GPR, @idm

Operation: $\langle op1 \rangle \leftarrow \langle op1 \rangle + \langle op2 \rangle$

ADD adds the values of <op1> and <op2> and stores the result back into <op1>.

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

R0, @[ID0 + 2]!

R0, @[ID0 - 2]!

V: set if overflow is generated. Reset if not. N: exclusive OR of V and MSB of result.

Example: Given: IDH:IDL0 = 80FFh, eid = 1

ADD

ADD

In the last two instructions, the value of IDH:IDL0 is not changed. Refer to Table 8-5 for more detailed explanation about this addressing mode.

// R0 \leftarrow R0 + DM[8101h], IDH \leftarrow 80h, IDL0 \leftarrow FFh

// R0 \leftarrow R0 + DM[80FDh], IDH \leftarrow 80h, IDL0 \leftarrow FFh

idm = IDx+offset:5, [IDx-offset:5], [IDx+offset:5]!, [IDx-offset:5]! (IDx = ID0 or ID1)

AND — Bit-wise AND

Format: AND <pp1>, <pp2>

<op1>: GPR

<op2>: adr:8, #imm:8, GPR, @idm

Operation: $\langle op1 \rangle \leftarrow \langle op1 \rangle \& \langle op2 \rangle$

AND performs bit-wise AND on the values in <op1> and <op2> and stores the result in <op1>.

Flags: Z: set if result is zero. Reset if not.

N: set if the MSB of result is 1. Reset if not.

Example: Given: IDH:IDL0 = 01FFh, eid = 1

In the first instruction, if eid bit in SR0 is zero, register R0 has garbage value because data memory DM[0051h-007Fh] are not mapped in S3CB519/S3FB519. In the last two instructions, the value of IDH:IDL0 is not changed. Refer to Table 8-5 for more detailed explanation about this addressing mode.

idm = IDx+offset:5, [IDx-offset:5], [IDx+offset:5]!, [IDx-offset:5]! (IDx = ID0 or ID1)



AND SR0 — Bit-wise AND with SR0

Format: AND SR0, #imm:8

Operation: SR0 \leftarrow SR0 & imm:8

AND SR0 performs the bit-wise AND operation on the value of SR0 and imm:8 and stores the

result in SR0.

Flags: –

Example: Given: SR0 = 11000010b

nlE EQU ~02h nlE0 EQU ~40h nlE1 EQU ~80h

AND SR0, #nIE | nIE0 | nIE1

AND SR0, #11111101b

In the first example, the statement "AND SR0, #nIE|nIE0|nIE1" clear all of bits of the global interrupt, interrupt 0 and interrupt 1. On the contrary, cleared bits can be set to '1' by instruction "OR SR0, #imm:8". Refer to instruction OR SR0 for more detailed explanation about enabling bit.

In the second example, the statement "AND SR0, #11111101b" is equal to instruction DI, which is disabling interrupt globally.

BANK — GPR Bank selection

Format: BANK #imm:2

Operation: $SR0[4:3] \leftarrow imm:2$

Flags: -

NOTE: For explanation of the CalmRISC banked register file and its usage, please refer to chapter 3.

Example:

BANK #1 // Select register bank 1 LD R0, #11h // Bank1's R0 \leftarrow 11h

BANK #2 // Select register bank 2 LD R1, #22h // Bank2's R1 \leftarrow 22h



BITC — Bit Complement

Format: BITC adr:8.bs

bs: 3-digit bit specifier

Operation: R3 \leftarrow ((adr:8) \land (2**bs)) if (TF == 0)

 $(adr:8) \leftarrow ((adr:8) \land (2**bs))$ if (TF == 1)

BITC complements the specified bit of a value read from memory and stores the result in R3 or back into memory, depending on the value of TF. TF is set or clear by BMS/BMC instruction.

Flags: Z: set if result is zero. Reset if not.

NOTE: Since the destination register R3 is fixed, it is not specified explicitly.

Example: Given: IDH = 01, DM[0180h] = FFh, eid = 1

BMC // TF \leftarrow 0

BITC 80h.0 $// R3 \leftarrow FEh, DM[0180h] = FFh$

BMS // TF \leftarrow 1

BITC 80h.1 // DM[0180h] \leftarrow FDh

BITR — Bit Reset

Format: BITR adr:8.bs

bs: 3-digit bit specifier

Operation: R3 \leftarrow ((adr:8) & ((111111111)₂ - (2**bs))) if (TF == 0)

 $(adr:8) \leftarrow ((adr:8) \& ((111111111)_2 - (2**bs)))$ if (TF == 1)

BITR resets the specified bit of a value read from memory and stores the result in R3 or back into memory, depending on the value of TF. TF is set or clear by BMS/BMC instruction.

Flags: Z: set if result is zero. Reset if not.

NOTE: Since the destination register R3 is fixed, it is not specified explicitly.

Example: Given: IDH = 01, DM[0180h] = FFh, eid = 1

BMC // TF \leftarrow 0

BITR 80h.1 $// R3 \leftarrow FDh, DM[0180h] = FFh$

BMS // TF \leftarrow 1

BITR 80h.2 // DM[0180h] ← FBh

BITS - Bit Set

Format: BITS adr:8.bs

bs: 3-digit bit specifier.

Operation: R3 \leftarrow ((adr:8) | (2**bs)) if (TF == 0)

 $(adr:8) \leftarrow ((adr:8) \mid (2^{**}bs))$ if (TF == 1)

BITS sets the specified bit of a value read from memory and stores the result in R3 or back into

memory, depending on the value of TF. TF is set or clear by BMS/BMC instruction.

Flags: Z: set if result is zero. Reset if not.

NOTE: Since the destination register R3 is fixed, it is not specified explicitly.

Example: Given: IDH = 01, DM[0180h] = F0h, eid = 1

BMC // TF \leftarrow 0

BITS 80h.1 // R3 \leftarrow 0F2h, DM[0180h] = F0h

BMS // TF \leftarrow 1

BITS 80h.2 // DM[0180h] \leftarrow F4h

BITT — Bit Test

Format: BITT adr:8.bs

bs: 3-digit bit specifier.

Operation: $Z \leftarrow \sim ((adr:8) \& (2^{**}bs))$

BITT tests the specified bit of a value read from memory.

Flags: Z: set if result is zero. Reset if not.

Example: Given: DM[0080h] = F7h, eid = 0

BITT 80h.3 // Z flag is set to '1'

JR Z, %1 // Jump to label %1 because condition is true.

•

•

%1 BITS 80h.3

NOP

•

•

BMC/BMS - TF bit clear/set

Format: BMS/BMC

Operation: BMC/BMS clears (sets) the TF bit.

 $TF \leftarrow 0 \;\; \text{if BMC}$

 $TF \leftarrow 1$ if BMS

TF is a single bit flag which determines the destination of bit operations, such as BITC, BITR, and

BITS.

Flags: -

NOTE: BMC/BMS are the only instructions that modify the content of the TF bit.

Example:

BMS // TF \leftarrow 1

BITS 81h.1

BMC // TF \leftarrow 0

BITR 81h.2 LD R0, R3

CALL — Conditional Subroutine Call (Pseudo Instruction)

Format: CALL cc:4, imm:20

CALL imm:12

Operation: If CALLS can access the target address and there is no conditional code (cc:4), CALL command is

assembled to CALLS (1-word instruction) in linking time, else the CALL is assembled to LCALL (2-word

instruction).

Example:

// 1-word instruction

•

Wait: NOP // Address at 0088h

NOP NOP NOP RET

CALLS — Call Subroutine

Format: CALLS imm:12

Operation: HS[sptr][15:0] \leftarrow current PC + 1, sptr \leftarrow sptr + 2 if the program size is less than 64K word.

 $HS[sptr][19:0] \leftarrow current PC + 1$, $sptr \leftarrow sptr + 2$ if the program size is equal to or over 64K word.

 $PC[11:0] \leftarrow imm:12$

CALLS unconditionally calls a subroutine residing at the address specified by imm:12.

Flags: –

Example:

CALLS Wait

•

.

Wait: NOP

NOP

NOP

RET

Because this is a 1-word instruction, the saved returning address on stack is (PC + 1).

${f CLD}-{f Load}$ into Coprocessor

Format: CLD imm:8, <op>

<op>: GPR

Operation: (imm:8) \leftarrow <op>

CLD loads the value of <op> into (imm:8), where imm:8 is used to access the external

coprocessor's address space.

Flags: -

Example:

```
ΑН
           EQU
                   00h
ΑL
           EQU
                   01h
ВН
           EQU
                   02h
BL
           EQU
                   03h
           CLD
                   AH, R0
                                      // A[15:8] \leftarrow R0
           CLD
                   AL, R1
                                      // A[7:0] \leftarrow R1
           CLD
                   BH, R2
                                       // B[15:8] ← R2
           CLD
                   BL, R3
                                       // B[7:0] \leftarrow R3
```

The registers A[15:0] and B[15:0] are Arithmetic Unit (AU) registers of MAC816. Above instructions generate SYSCP[7:0], nCLDID and CLDWR signals to access MAC816.

${f CLD}-{f Load}$ from Coprocessor

Format: CLD <op>, imm:8

<op>: GPR

Operation: $\langle op \rangle \leftarrow (imm:8)$

CLD loads a value from the coprocessor, whose address is specified by imm:8.

Flags: Z: set if the loaded value in <op1> is zero. Reset if not.

N: set if the MSB of the loaded value in <op1> is 1. Reset if not.

Example:

```
AH
            EQU
                     00h
AL
            EQU
                     01h
ВН
            EQU
                     02h
BL
            EQU
                     03h
            CLD
                                          // R0 \leftarrow A[15:8]
                     R0, AH
            CLD
                     R1, AL
                                          // R1 \leftarrow A[7:0]
            CLD
                                          // R2 \leftarrow B[15:8]
                     R2, BH
            CLD
                     R3, BL
                                          // R3 \leftarrow B[7:0]
```

The registers A[15:0] and B[15:0] are Arithmetic Unit (AU) registers of MAC816. Above instructions generate SYSCP[7:0], nCLDID and CLDWR signals to access MAC816.

COM — 1's or Bit-wise Complement

Format: COM <op>

<op>: GPR

Operation: $< op > \leftarrow \sim < op >$

COM takes the bit-wise complement operation on <op> and stores the result in <op>.

Flags: Z: set if result is zero. Reset if not.

N: set if the MSB of result is 1. Reset if not.

Example: Given: R1 = 5Ah

COM R1 // R1 \leftarrow A5h, N flag is set to '1'

COM2 — 2's Complement

Format: COM2 <op>

<op>: GPR

Operation: $< op > \leftarrow \sim < op > + 1$

COM2 computes the 2's complement of <op> and stores the result in <op>.

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.

N: set if result is negative.

Example: Given: R0 = 00h, R1 = 5Ah

COM2 R0 // R0 \leftarrow 00h, Z and C flags are set to '1'.

COM2 R1 // R1 \leftarrow A6h, N flag is set to '1'.

COMC — Bit-wise Complement with Carry

Format: COMC <op>

<op>: GPR

Operation: $\langle op \rangle \leftarrow \langle op \rangle + C$

COMC takes the bit-wise complement of <op>, adds carry and stores the result in <op>.

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.N: set if result is negative. Reset if not.

Example: If register pair R1:R0 is a 16-bit number, then the 2's complement of R1:R0 can be obtained by

COM2 and COMC as following.

COM2 R0 COMC R1

Note that Z flag do not exactly reflect result of 16-bit operation. For example, if 16-bit register pair R1: R0 has value of FF01h, then 2's complement of R1: R0 is made of 00FFh by COM2 and COMC. At this time, by instruction COMC, zero (Z) flag is set to '1' as if the result of 2's complement for 16-bit number is zero. Therefore when programming 16-bit comparison, take care of the change of Z flag.



${\color{red}\textbf{COP}}-{\color{blue}\textbf{Coprocessor}}$

Format: COP #imm:12

Operation: COP passes imm:12 to the coprocessor by generating SYSCP[11:0] and nCOPID signals.

Flags: –

Example:

COP #0D01h // generate 1 word instruction code(FD01h)
COP #0234h // generate 1 word instruction code(F234h)

The above two instructions are equal to statement "ELD A, #1234h" for MAC816 operation. The microcode of MAC instruction "ELD A, #1234h" is "FD01F234", 2-word instruction. In this, code 'F'

indicates 'COP' instruction.

CP—Compare

Format: CP <op1>, <op2>

<op1>: GPR

<op2>: adr:8, #imm:8, GPR, @idm

Operation: $\langle op1 \rangle + \langle op2 \rangle + 1$

CP compares the values of <op1> and <op2> by subtracting <op2> from <op1>. Contents of <op1>

and <op2> are not changed.

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero (i.e., <op1> and <op2> are same). Reset if not.

V: set if overflow is generated. Reset if not.N: set if result is negative. Reset if not.

Example: Given: R0 = 73h, R1 = A5h, IDH:IDL0 = 0123h, DM[0123h] = A5, eid = 1

CP R0, 80h // C flag is set to '1'

CP R0, #73h // Z and C flags are set to '1'

CP R0, R1 // V flag is set to '1'

CP R1, @ID0 // Z and C flags are set to '1'

CP R1, @[ID0 - 5] CP R2, @[ID0 + 7]! CP R2, @[ID0 - 2]!

In the last two instructions, the value of IDH:IDL0 is not changed. Refer to Table 8-5 for more detailed explanation about this addressing mode.

idm = IDx+offset:5, [IDx-offset:5], [IDx+offset:5]!, [IDx-offset:5]! (IDx = ID0 or ID1)



CPC — Compare with Carry

Format: CPC <op1>, <op2>

<op1>: GPR

<op2>: adr:8, GPR

Operation: $\langle op1 \rangle \leftarrow \langle op1 \rangle + \langle op2 \rangle + C$

CPC compares <op1> and <op2> by subtracting <op2> from <op1>. Unlike CP, however, CPC

adds (C - 1) to the result. Contents of <op1> and <op2> are not changed.

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.N: set if result is negative. Reset if not.

Example: If register pair R1:R0 and R3:R2 are 16-bit signed or unsigned numbers, then use CP and CPC

to compare two 16-bit numbers as follows.

CP R0, R1 CPC R2, R3

Because CPC considers C when comparing <pp1> and <pp2>, CP and CPC can be used in pair to compare 16-bit operands. But note that zero (Z) flag do not exactly reflect result of 16-bit operation.

Therefore when programming 16-bit comparison, take care of the change of Z flag.

DEC — Decrement

Format: DEC <op>

<op>: GPR

Operation: $< op > \leftarrow < op > + 0FFh$

DEC decrease the value in <op> by adding 0FFh to <op>.

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.N: set if result is negative. Reset if not.

Example: Given: R0 = 80h, R1 = 00h

DEC R0 // R0 \leftarrow 7Fh, C, V and N flags are set to '1'

DEC R1 // R1 \leftarrow FFh, N flags is set to '1'

DECC — Decrement with Carry

Format: DECC <op>

<op>: GPR

Operation: $\langle op \rangle \leftarrow \langle op \rangle + 0 FFh + C$

DECC decrease the value in <op> when carry is not set. When there is a carry, there is no

change in the value of <op>.

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.N: set if result is negative. Reset if not.

Example: If register pair R1:R0 is 16-bit signed or unsigned number, then use DEC and DECC to

decrement 16-bit number as follows.

DEC R0 DECC R1

Note that zero (Z) flag do not exactly reflect result of 16-bit operation. Therefore when programming

16-bit decrement, take care of the change of Z flag.

DI — Disable Interrupt (Pseudo Instruction)

Format: DI

Operation: Disables interrupt globally. It is same as "AND SR0, #0FDh".

DI instruction sets bit1 (ie: global interrupt enable) of SR0 register to "0"

Flags: –

Example: Given: SR0 = 03h

DI // SR0 \leftarrow SR0 & 11111101b

DI instruction clears SR0[1] to '0', disabling interrupt processing.

EI — Enable Interrupt (Pseudo Instruction)

Format: EI

Operation: Enables interrupt globally. It is same as "OR SR0, #02h".

EI instruction sets the bit1 (ie: global interrupt enable) of SR0 register to "1"

Flags: –

Example: Given: SR0 = 01h

EI // SR0 \leftarrow SR0 | 00000010b

The statement "EI" sets the SR0[1] to '1', enabling all interrupts.

IDLE — Idle Operation (Pseudo Instruction)

Format: IDLE

Operation: The IDLE instruction stops the CPU clock while allowing system clock oscillation to continue.

Idle mode can be released by an interrupt or reset operation.

The IDLE instruction is a pseudo instruction. It is assembled as "SYS #05H", and this generates the SYSCP[7-0] signals. Then these signals are decoded and the decoded signals execute the idle

operation.

Flags: -

NOTE: The next instruction of IDLE instruction is executed, so please use the NOP instruction after the IDLE

instruction.

Example:

NOP NOP NOP

•

•

•

The IDLE instruction stops the CPU clock but not the system clock.

INC — Increment

Format: INC <op>

<op>: GPR

Operation: $<op> \leftarrow <op> + 1$

INC increase the value in <op>.

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.N: set if result is negative. Reset if not.

Example: Given: R0 = 7Fh, R1 = FFh

INC R0 // R0 \leftarrow 80h, V flag is set to '1'

INC R1 // R1 \leftarrow 00h, Z and C flags are set to '1'

INCC — Increment with Carry

Format: INCC <op>

<op>: GPR

Operation: $\langle op \rangle \leftarrow \langle op \rangle + C$

INCC increase the value of <op> only if there is carry. When there is no carry, the value of

<op> is not changed.

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not. N: exclusive OR of V and MSB of result.

Example: If register pair R1:R0 is 16-bit signed or unsigned number, then use INC and INCC to increment

16-bit number as following.

INC R0 INCC R1

Assume R1:R0 is 0010h, statement "INC R0" increase R0 by one without carry and statement "INCC R1" set zero (Z) flag to '1' as if the result of 16-bit increment is zero. Note that zero (Z) flag do not exactly reflect result of 16-bit operation. Therefore when programming 16-bit increment, take

care of the change of Z flag.



IRET — Return from Interrupt Handling

Format: IRET

Operation: $PC \leftarrow HS[sptr - 2], sptr \leftarrow sptr - 2$

IRET pops the return address (after interrupt handling) from the hardware stack and assigns it to

PC. The ie (i.e., SR0[1]) bit is set to allow further interrupt generation.

Flags: –

NOTE: The program size (indicated by the nP64KW signal) determines which portion of PC is updated.

When the program size is less than 64K word, only the lower 16 bits of PC are updated

(i.e., $PC[15:0] \leftarrow HS[sptr - 2]$).

When the program size is 64K word or more, the action taken is $PC[19:0] \leftarrow HS[sptr - 2]$.

Example:

SF_EXCEP: NOP // Stack full exception service routine

•

IRET

JNZD — Jump Not Zero with Delay slot

Format: JNZD <op>, imm:8

<op>: GPR (bank 3's GPR only)

imm:8 is an signed number

Operation: PC ← PC[delay slot] - 2's complement of imm:8

<op> ← <op> - 1

JNZD performs a backward PC-relative jump if evaluates to be non-zero. Furthermore, JNZD decrease the value of . The instruction immediately following JNZD (i.e., in delay slot) is always executed, and this instruction must be 1 cycle instruction.

Flags: -

NOTE: Typically, the delay slot will be filled with an instruction from the loop body. It is noted, however, that

the chosen instruction should be "dead" outside the loop for it executes even when the loop is exited

(i.e., JNZD is not taken).

Example: Given: IDH = 03h, eid = 1

```
BANK
                  #3
       LD
                  R0, #0FFh
                                             // R0 is used to loop counter
        LD
                  R1, #0
%1
       LD
                  IDL0, R0
        JNZD
                  R0, %B1
                                             // If R0 of bank3 is not zero, jump to %1.
       LD
                  @ID0, R1
                                             // Clear register pointed by ID0
```

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This example can be used for RAM clear routine. The last instruction is executed even if the loop is exited.



JP — Conditional Jump (Pseudo Instruction)

Format: JP cc:4 imm:20

JP cc:4 imm:9

Operation: If JR can access the target address, JP command is assembled to JR (1 word instruction) in linking

time, else the JP is assembled to LJP (2 word instruction) instruction.

There are 16 different conditions that can be used, as described in table 8-6.

Example:

In the above example, the statement "JP Z, %B1" is assembled to JR instruction. Assuming that current PC is 0264h and condition is true, next PC is made by PC[11:0] \leftarrow PC[11:0] + offset, offset value is "64h + A9h" without carry. 'A9' means 2's complement of offset value to jump backward. Therefore next PC is 020Dh. On the other hand, statement "JP C, %F2" is assembled to LJP instruction because offset address exceeds the range of imm:9.

JR — Conditional Jump Relative

Format: JR cc:4 imm:9

cc:4: 4-bit condition code

Operation: PC[11:0] ← PC[11:0] + imm:9 if condition is true. imm:9 is a signed number, which is sign-

extended to 12 bits when added to PC.

There are 16 different conditions that can be used, as described in table 8-6.

Flags: -

NOTE: Unlike LJP, the target address of JR is PC-relative. In the case of JR, imm:9 is added to PC to

compute the actual jump address, while LJP directly jumps to imm:20, the target.

Example:

JR Z, %1 // Assume current PC = 1000h

_

•

%1 LD R0, R1 // Address at 10A5h

•

•

After the first instruction is executed, next PC has become 10A5h if Z flag bit is set to '1'. The range of the relative address is from +255 to -256 because imm:9 is signed number.



LCALL — Conditional Subroutine Call

Format: LCALL cc:4, imm:20

Operation: HS[sptr][15:0] \leftarrow current PC + 2, sptr \leftarrow sptr + 2, PC[15:0] \leftarrow imm[15:0] if the condition holds

and the program size is less than 64K word.

 $HS[sptr][19:0] \leftarrow current PC + 2$, $sptr \leftarrow sptr + 2$, $PC[19:0] \leftarrow imm:20$ if the condition holds and

the program size is equal to or over 64K word.

 $PC[11:0] \leftarrow PC[11:0] + 2$ otherwise.

LCALL instruction is used to call a subroutine whose starting address is specified by imm:20.

Flags: -

Example:

LCALL L1

LCALL C, L2

Label L1 and L2 can be allocated to the same or other section. Because this is a 2-word instruction, the saved returning address on stack is (PC + 2).

LD adr:8 — Load into Memory

Format: LD adr:8, <op>

<op>: GPR

Operation: DM[00h:adr:8] \leftarrow <op> if eid = 0

 $DM[IDH:adr:8] \leftarrow \mathsf{<}\mathsf{op}\mathsf{>} \mathsf{if} \mathsf{\; eid} = 1$

LD adr:8 loads the value of <op> into a memory location. The memory location is determined by

the eid bit and adr:8.

Flags: -

Example: Given: IDH = 01h

LD 80h, R0

If eid bit of SR0 is zero, the statement "LD 80h, R0" load value of R0 into DM[0080h], else eid bit

was set to '1', the statement "LD 80h, R0" load value of R0 into DM[0180h]

LD @idm — Load into Memory Indexed

Format: LD @idm, <op>

<op>: GPR

Operation: (@idm) \leftarrow <op>

LD @idm loads the value of <op> into the memory location determined by @idm. Details of the

@idm format and how the actual address is calculated can be found in chapter 2.

Flags: –

Example: Given R0 = 5Ah, IDH:IDL0 = 8023h, eid = 1

In the last two instructions, the value of IDH:IDL0 is not changed. Refer to Table 8-5 for more detailed explanation about this addressing mode.

idm = IDx+offset:5, [IDx-offset:5], [IDx+offset:5]!, [IDx-offset:5]! (IDx = ID0 or ID1)

LD — Load Register

Format: LD <op1>, <op2>

<op1>: GPR

<op2>: GPR, SPR, adr:8, @idm, #imm:8

Operation: $< op1 > \leftarrow < op2 >$

LD loads a value specified by <op2> into the register designated by <op1>.

Flags: Z: set if result is zero. Reset if not.

N: exclusive OR of V and MSB of result.

Example: Given: R0 = 5Ah, R1 = AAh, IDH:IDL0 = 8023h, eid = 1

LD R0, R1 $/\!/$ R0 \leftarrow AAh

LD R1, IDH // R1 \leftarrow 80h

LD R2, 80h // R2 \leftarrow DM[8080h]

LD R0, #11h // R0 \leftarrow 11h

In the last two instructions, the value of IDH:IDL0 is not changed. Refer to Table 8-5 for more detailed explanation about this addressing mode.

idm = IDx+offset:5, [IDx-offset:5], [IDx+offset:5]!, [IDx-offset:5]! (IDx = ID0 or ID1)

$\boldsymbol{LD} = \mathsf{Load} \; \mathsf{GPR:bankd}, \; \mathsf{GPR:banks}$

Format: LD <op1>, <op2>

<op1>: GPR: bankd
<op2>: GPR: banks

Operation: $\langle op1 \rangle \leftarrow \langle op2 \rangle$

LD loads a value of a register in a specified bank (banks) into another register in a specified bank

(bankd).

Flags: Z: set if result is zero. Reset if not.

N: exclusive OR of V and MSB of result.

Example:

LD R2:1, R0:3 // Bank1's R2 \leftarrow bank3's R0

LD R0:0, R0:2 // Bank0's R0 \leftarrow bank2's R0

$\boldsymbol{LD} \! = \! \mathsf{Load} \, \mathsf{GPR}, \mathsf{TBH/TBL}$

Format: LD <op1>, <op2>

<op1>: GPR
<op2>: TBH/TBL

Operation: $\langle op1 \rangle \leftarrow \langle op2 \rangle$

LD loads a value specified by <op2> into the register designated by <op1>.

Flags: Z: set if result is zero. Reset if not.

N: exclusive OR of V and MSB of result.

Example: Given: register pair R1:R0 is 16-bit unsigned data.

 $\label{eq:local_local_local_local_local_local} \text{LDC} \qquad @\text{IL} \qquad // \ \text{TBH:TBL} \leftarrow \text{PM[ILX:ILH:ILL]}$

 $\begin{array}{lll} LD & R1,\,TBH & /\!\!/\,R1 \leftarrow TBH \\ LD & R0,\,TBL & /\!\!/\,R0 \leftarrow TBL \end{array}$

$\boldsymbol{LD} \! = \! \mathsf{Load} \, \mathsf{TBH/TBL}, \mathsf{GPR}$

Format: LD <op1>, <op2>

<op1>: TBH/TBL
<op2>: GPR

Operation: $\langle op1 \rangle \leftarrow \langle op2 \rangle$

LD loads a value specified by <op2> into the register designated by <op1>.

Flags: -

Example: Given: register pair R1:R0 is 16-bit unsigned data.

LD SPR — Load SPR

Format: LD <op1>, <op2>

<op1>: SPR
<op2>: GPR

Operation: $< op1 > \leftarrow < op2 >$

LD SPR loads the value of a GPR into an SPR.

Refer to Table 3-1 for more detailed explanation about kind of SPR.

Flags: -

Example: Given: register pair R1:R0 = 1020h

LD SPR0 — Load SPR0 Immediate

Format: LD SPR0, #imm:8

Operation: SPR0 \leftarrow imm:8

LD SPR0 loads an 8-bit immediate value into SPR0.

Flags: –

Example: Given: eid = 1, idb = 0 (index register bank 0 selection)

LD IDH, #80h // IDH point to page 80h

LD IDL1, #44h LD IDL0, #55h LD SR0, #02h

The last instruction set ie (global interrupt enable) bit to '1'.

Special register group 1 (SPR1) registers are not supported in this addressing mode.

LDC — Load Code

Format: LDC <op1>

<op1>: @IL, @IL+

Operation: TBH:TBL \leftarrow PM[ILX:ILH:ILL]

 $ILL \leftarrow ILL + 1$ (@IL+ only)

LDC loads a data item from program memory and stores it in the TBH:TBL register pair.

@IL+ increase the value of ILL, efficiently implementing table lookup operations.

Flags: –

Example:

The statement "LDC @IL" do not increase, but if you use statement "LDC @IL+", ILL register is increased by one after instruction execution.



LJP — Conditional Jump

Format: LJP cc:4, imm:20

cc:4: 4-bit condition code

Operation: $PC[15:0] \leftarrow imm[15:0]$ if condition is true and the program size is less than 64K word. If the program

is equal to or larger than 64K word, PC[19:0] ← imm[19:0] as long as the condition is true. There

are 16 different conditions that can be used, as described in table 8-6.

Flags: -

NOTE: LJP cc:4 imm:20 is a 2-word instruction whose immediate field directly specifies the target address

of the jump.

Example:

LJP C, %1 // Assume current PC = 0812h

•

•

•

%1 LD R0, R1 // Address at 10A5h

•

_

After the first instruction is executed, LJP directly jumps to address 10A5h if condition is true.

LLNK — Linked Subroutine Call Conditional

Format: LLNK cc:4, imm:20

cc:4: 4-bit condition code

Operation: If condition is true, $IL[19:0] \leftarrow \{PC[19:12], PC[11:0] + 2\}.$

Further, when the program is equal to or larger than 64K word, PC[19:0] ← imm[19:0] as long as the

condition is true. If the program is smaller than 64K word, $PC[15:0] \leftarrow imm[15:0]$. There are 16 different conditions that can be used, as described in table 8-6.

Flags:

NOTE: LLNK is used to conditionally to call a subroutine with the return address saved in the link register

(IL) without stack operation. This is a 2-word instruction.

Example:

```
// Address at 005Ch, ILX:ILH:ILL ← 00:00:5Eh
LLNK
          Z, %1
NOP
                                    // Address at 005Eh
```

%1 LD R0, R1

LRET

LNK — Linked Subroutine Call (Pseudo Instruction)

Format: LNK cc:4, imm:20

LNK imm:12

Operation: If LNKS can access the target address and there is no conditional code (cc:4), LNK command is

assembled to LNKS (1 word instruction) in linking time, else the LNK is assembled to LLNK (2

word instruction).

Example:

LNK Z, Link1 // Equal to "LLNK Z, Link1" LNK Link2 // Equal to "LNKS Link2"

NOP

•

•

Link2: NOP

•

•

LRET

Subroutines section CODE, ABS 0A00h

Subroutines

Link1: NOP

•

•

LRET

LNKS — Linked Subroutine Call

Format: LNKS imm:12

Operation: $IL[19:0] \leftarrow \{PC[19:12], PC[11:0] + 1\} \text{ and } PC[11:0] \leftarrow imm:12$

LNKS saves the current PC in the link register and jumps to the address specified by imm:12.

Flags: -

NOTE: LNKS is used to call a subroutine with the return address saved in the link register (IL) without stack

operation.

Example:

LNKS Link1 // Address at 005Ch, ILX:ILH:ILL ← 00:00:5Dh

NOP // Address at 005Dh

•

•

Link1: NOP

•

•

LRET

LRET — Return from Linked Subroutine Call

Format: LRET

Operation: $PC \leftarrow IL[19:0]$

LRET returns from a subroutine by assigning the saved return address in IL to PC.

Flags: –

Example:

LNK Link1

Link1: NOP

•

•

LRET ; $PC[19:0] \leftarrow ILX:ILH:ILL$

NOP — No Operation

Format: NOP

Operation: No operation.

When the instruction NOP is executed in a program, no operation occurs. Instead, the instruction time is delayed by approximately one machine cycle per each NOP instruction encountered.

Flags: -

Example:

NOP



OR — Bit-wise OR

Format: OR <op1>, <op2>

<op1>: GPR

<op2>: adr:8, #imm:8, GPR, @idm

Operation: $\langle op1 \rangle \leftarrow \langle op1 \rangle | \langle op2 \rangle$

OR performs the bit-wise OR operation on <op1> and <op2> and stores the result in <op1>.

Flags: Z: set if result is zero. Reset if not.

N: exclusive OR of V and MSB of result.

Example: Given: IDH:IDL0 = 031Eh, eid = 1

```
OR
             R0, 80h
                                              // R0 \leftarrow R0 \mid DM[0380h]
OR
             R1, #40h
                                              // Mask bit6 of R1
OR
                                              // R1 \leftarrow R1 \mid R0
             R1, R0
OR
             R0, @ID0
                                              // R0 \leftarrow R0 | DM[031Eh], IDL0 \leftarrow 1Eh
OR
             R1, @[ID0-1]
                                              // R1 \leftarrow R1 \mid DM[031Dh], IDL0 \leftarrow 1Dh
OR
             R2, @[ID0+1]!
                                              // R2 \leftarrow R2 | DM[031Fh], IDL0 \leftarrow 1Eh
OR
             R3, @[ID0-1]!
                                              // R3 \leftarrow R3 | DM[031Dh], IDL0 \leftarrow 1Eh
```

In the last two instructions, the value of IDH:IDL0 is not changed. Refer to Table 8-5 for more detailed explanation about this addressing mode.

idm = IDx+offset:5, [IDx-offset:5], [IDx+offset:5]!, [IDx-offset:5]! (IDx = ID0 or ID1)

OR SR0 — Bit-wise OR with SR0

Format: OR SR0, #imm:8

Operation: SR0 \leftarrow SR0 | imm:8

OR SR0 performs the bit-wise OR operation on SR0 and imm:8 and stores the result in SR0.

Flags: –

Example: Given: SR0 = 00000000b

EID	EQU	01h
IE	EQU	02h
IDB1	EQU	04h
IE0	EQU	40h
IE1	EQU	80h

OR SR0, #IE | IE0 | IE1
OR SR0, #00000010b

In the first example, the statement "OR SR0, #EID|IE|IE0" set global interrupt(ie), interrupt 0(ie0) and interrupt 1(ie1) to '1' in SR0. On the contrary, enabled bits can be cleared with instruction "AND SR0, #imm:8". Refer to instruction AND SR0 for more detailed explanation about disabling bit.

In the second example, the statement "OR SR0, #00000010b" is equal to instruction EI, which is enabling interrupt globally.



POP - POP

Format: POP

Operation: $sptr \leftarrow sptr - 2$

POP decrease sptr by 2. The top two bytes of the hardware stack are therefore invalidated.

Flags: –

Example: Given: sptr[5:0] = 001010b

POP

This POP instruction decrease sptr[5:0] by 2. Therefore sptr[5:0] is 001000b.

POP — POP to Register

Format: POP <op>

<op>: GPR, SPR

Operation: $\langle op \rangle \leftarrow HS[sptr - 1], sptr \leftarrow sptr - 1$

POP copies the value on top of the stack to <op> and decrease sptr by 1.

Flags: Z: set if the value copied to <op> is zero. Reset if not.

N: set if the value copied to <op> is negative. Reset if not.

When <op> is SPR, no flags are affected, including Z and N.

Example:

POP R0 // R0 \leftarrow HS[sptr-1], sptr \leftarrow sptr-1

POP IDH // IDH \leftarrow HS[sptr-1], sptr \leftarrow sptr-1

In the first instruction, value of HS[sptr-1] is loaded to R0 and the second instruction "POP IDH" load value of HS[sptr-1] to register IDH. Refer to chapter 5 for more detailed explanation about POP operations for hardware stack.

PUSH — Push Register

Format: PUSH <op>

<op>: GPR, SPR

Operation: $HS[sptr] \leftarrow \langle op \rangle$, $sptr \leftarrow sptr + 1$

PUSH stores the value of <op> on top of the stack and increase sptr by 1.

Flags: –

Example:

PUSH R0 // $HS[sptr] \leftarrow R0$, $sptr \leftarrow sptr + 1$

PUSH IDH // $HS[sptr] \leftarrow IDH$, $sptr \leftarrow sptr + 1$

In the first instruction, value of register R0 is loaded to HS[sptr-1] and the second instruction "PUSH IDH" load value of register IDH to HS[sptr-1]. Current HS pointed by stack point sptr[5:0] be emptied. Refer to chapter 5 for more detailed explanation about PUSH operations for hardware stack.

RET — Return from Subroutine

Format: RET

Operation: $PC \leftarrow HS[sptr - 2], sptr \leftarrow sptr - 2$

RET pops an address on the hardware stack into PC so that control returns to the subroutine call

site.

Flags: –

Example: Given: sptr[5:0] = 001010b

CALLS Wait // Address at 00120h

•

Wait: NOP // Address at 01000h

NOP NOP NOP NOP RET

After the first instruction CALLS execution, "PC+1", 0121h is loaded to HS[5] and hardware stack pointer sptr[5:0] have 001100b and next PC became 01000h. The instruction RET pops value 0121h on the hardware stack HS[sptr-2] and load to PC then stack pointer sptr[[5:0] became 001010b.



RL — Rotate Left

Format: RL <op>

<op>: GPR

Operation: $C \leftarrow \langle op \rangle[7], \langle op \rangle \leftarrow \{\langle op \rangle[6:0], \langle op \rangle[7]\}$

RL rotates the value of <op> to the left and stores the result back into <op>.

The original MSB of <op> is copied into carry (C).

Flags: C: set if the MSB of <op> (before rotating) is 1. Reset if not.

Z: set if result is zero. Reset if not.

N: set if the MSB of <op> (after rotating) is 1. Reset if not.

Example: Given: R0 = 01001010b, R1 = 10100101b

RL R0 // N flag is set to '1', R0 \leftarrow 10010100b

RL R1 // C flag is set to '1', R1 \leftarrow 01001011b

RLC—Rotate Left with Carry

Format: RLC <op>

<op>: GPR

Operation: $C \leftarrow \langle op \rangle [7], \langle op \rangle \leftarrow \{\langle op \rangle [6:0], C\}$

RLC rotates the value of <op> to the left and stores the result back into <op>.

The original MSB of <op> is copied into carry (C), and the original C bit is copied into <op>[0].

Flags: C: set if the MSB of <op> (before rotating) is 1. Reset if not.

Z: set if result is zero. Reset if not.

N: set if the MSB of <op> (after rotating) is 1. Reset if not.

Example: Given: R2 = A5h, if C = 0

RLC R2 // R2 \leftarrow 4Ah, C flag is set to '1'

RL R0 RLC R1

In the second example, assuming that register pair R1:R0 is 16-bit number, then RL and RLC are used for 16-bit rotate left operation. But note that zero (Z) flag do not exactly reflect result of 16-bit operation. Therefore when programming 16-bit decrement, take care of the change of Z flag.



RR — Rotate Right

Format: RR <op>

<op>: GPR

Operation: $C \leftarrow \langle op \rangle [0], \langle op \rangle \leftarrow \{\langle op \rangle [0], \langle op \rangle [7:1]\}$

RR rotates the value of <op> to the right and stores the result back into <op>. The original LSB of

<op> is copied into carry (C).

Flags: C: set if the LSB of <op> (before rotating) is 1. Reset if not.

Z: set if result is zero. Reset if not.

N: set if the MSB of <op> (after rotating) is 1. Reset if not.

Example: Given: R0 = 01011010b, R1 = 10100101b

RR R0 // No change of flag, R0 \leftarrow 00101101b

RR R1 // C and N flags are set to '1', R1 \leftarrow 11010010b

RRC — Rotate Right with Carry

Format: RRC <op>

<op>: GPR

Operation: $C \leftarrow \langle op \rangle[0], \langle op \rangle \leftarrow \{C, \langle op \rangle[7:1]\}$

RRC rotates the value of <op> to the right and stores the result back into <op>. The original LSB of

<op> is copied into carry (C), and C is copied to the MSB.

Flags: C: set if the LSB of <op> (before rotating) is 1. Reset if not.

Z: set if result is zero. Reset if not.

N: set if the MSB of <op> (after rotating) is 1. Reset if not.

Example: Given: R2 = A5h, if C = 0

RRC R2 // R2 \leftarrow 52h, C flag is set to '1'

RR R0 RRC R1

In the second example, assuming that register pair R1:R0 is 16-bit number, then RR and RRC are used for 16-bit rotate right operation. But note that zero (Z) flag do not exactly reflect result of 16-bit operation. Therefore when programming 16-bit decrement, take care of the change of Z flag.



SBC — Subtract with Carry

Format: SBC <op1>, <op2>

<op1>: GPR
<op2>: adr:8, GPR

Operation: $\langle op1 \rangle \leftarrow \langle op1 \rangle + \langle op2 \rangle + C$

SBC computes (<op1> - <op2>) when there is carry and (<op1> - <op2> - 1) when there is no

carry.

SBC

Flags: C: set if carry is generated. Reset if not.

R1, R3

Z: set if result is zero. Reset if not.V: set if overflow is generated.

N: set if result is negative. Reset if not.

Example:

In the last two instructions, assuming that register pair R1:R0 and R3:R2 are 16-bit signed or unsigned numbers. Even if the result of "ADD R0, R2" is not zero, zero (Z) flag can be set to '1' if the result of "SBC R1,R3" is zero. Note that zero (Z) flag do not exactly reflect result of 16-bit operation. Therefore when programming 16-bit addition, take care of the change of Z flag.

SL — Shift Left

Format: SL <op>

<op>: GPR

Operation: $C \leftarrow \text{<op>[7]}, \text{<op>} \leftarrow \{\text{<op>[6:0]}, 0\}$

SL shifts <op> to the left by 1 bit. The MSB of the original <op> is copied into carry (C).

Flags: C: set if the MSB of <op> (before shifting) is 1. Reset if not.

Z: set if result is zero. Reset if not.

N: set if the MSB of <op> (after shifting) is 1. Reset if not.

Example: Given: R0 = 01001010b, R1 = 10100101b

SL R0 // N flag is set to '1', R0 \leftarrow 10010100b

SL R1 // C flag is set to '1', R1 \leftarrow 01001010b

SLA — Shift Left Arithmetic

Format: SLA <op>

<op>: GPR

Operation: $C \leftarrow \text{<op>[7]}, \text{<op>} \leftarrow \{\text{<op>[6:0]}, 0\}$

SLA shifts <op> to the left by 1 bit. The MSB of the original <op> is copied into carry (C).

Flags: C: set if the MSB of <op> (before shifting) is 1. Reset if not.

Z: set if result is zero. Reset if not.

V: set if the MSB of the result is different from C. Reset if not.N: set if the MSB of <op> (after shifting) is 1. Reset if not.

Example: Given: R0 = AAh

SLA R0 // C, V, N flags are set to '1', R0 \leftarrow 54h

${\bf SR}-{\bf Shift\ Right}$

Format: SR <op>

<op>: GPR

Operation: $C \leftarrow \text{op>}[0], \text{op>} \leftarrow \{0, \text{op>}[7:1]\}$

SR shifts <op> to the right by 1 bit. The LSB of the original <op> (i.e., <op>[0]) is copied into carry

(C).

Flags: C: set if the LSB of <op> (before shifting) is 1. Reset if not.

Z: set if result is zero. Reset if not.

N: set if the MSB of <op> (after shifting) is 1. Reset if not.

Example: Given: R0 = 01011010b, R1 = 10100101b

SR R0 // No change of flags, R0 \leftarrow 00101101b

SR R1 // C flag is set to '1', R1 \leftarrow 01010010b

SRA — Shift Right Arithmetic

Format: SRA <op>

<op>: GPR

Operation: $C \leftarrow \langle op \rangle [0], \langle op \rangle \leftarrow \{\langle op \rangle [7], \langle op \rangle [7:1]\}$

SRA shifts <op> to the right by 1 bit while keeping the sign of <op>. The LSB of the original <op>

(i.e., <op>[0]) is copied into carry (C).

Flags: C: set if the LSB of <op> (before shifting) is 1. Reset if not.

Z: set if result is zero. Reset if not.

N: set if the MSB of <op> (after shifting) is 1. Reset if not.

NOTE: SRA keeps the sign bit or the MSB (<op>[7]) in its original position. If SRA is executed 'N' times, N

significant bits will be set, followed by the shifted bits.

Example: Given: R0 = 10100101b

STOP — Stop Operation (pseudo instruction)

Format: STOP

Operation: The STOP instruction stops the both the CPU clock and system clock and causes the

microcontroller to enter the STOP mode. In the STOP mode, the contents of the on-chip CPU registers, peripheral registers, and I/O port control and data register are retained. A reset operation or external or internal interrupts can release stop mode. The STOP instruction is a pseudo instruction. It is assembled as "SYS #0Ah", which generates the SYSCP[7-0] signals. These

signals are decoded and stop the operation.

NOTE: The next instruction of STOP instruction is executed, so please use the NOP instruction after the

STOP instruction.

Example:

STOP NOP NOP

•

•

•

In this example, the NOP instructions provide the necessary timing delay for oscillation stabilization before the next instruction in the program sequence is executed. Refer to the timing diagrams of oscillation stabilization, as described in Figure 18-3, 18-4



SUB — Subtract

Format: SUB <op1>, <op2>

<op1>: GPR

<op2>: adr:8, #imm:8, GPR, @idm

Operation: $\langle op1 \rangle \leftarrow \langle op1 \rangle + \langle op2 \rangle + 1$

SUB adds the value of <op1> with the 2's complement of <op2> to perform subtraction on

<op1> and <op2>

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.N: set if result is negative. Reset if not.

Example: Given: IDH:IDL0 = 0150h, DM[0143h] = 26h, R0 = 52h, R1 = 14h, eid = 1

```
SUB
             R0, 43h
                                              // R0 \leftarrow R0 + \sim DM[0143h] + 1 = 2Ch
SUB
             R1, #16h
                                              // R1 ← FEh, N flag is set to '1'
SUB
             R0, R1
                                              // R0 \leftarrow R0 + \sim R1 + 1 = 3Eh
SUB
                                              // R0 \leftarrow R0 + \simDM[0150h] + 1, IDL0 \leftarrow 51h
             R0, @ID0+1
SUB
             R0, @[ID0-2]
                                              // R0 \leftarrow R0 + \sim DM[014Eh] + 1, IDL0 \leftarrow 4Eh
SUB
             R0, @[ID0+3]!
                                              // R0 \leftarrow R0 + \sim DM[0153h] + 1, IDL0 \leftarrow 50h
SUB
             R0, @[ID0-2]!
                                              // R0 \leftarrow R0 + \sim DM[014Eh] + 1, IDL0 \leftarrow 50h
```

In the last two instructions, the value of IDH:IDL0 is not changed. Refer to Table 8-5 for more detailed explanation about this addressing mode. The example in the SBC description shows how SUB and SBC can be used in pair to subtract a 16-bit number from another.

idm = IDx+offset:5, [IDx-offset:5], [IDx+offset:5]!, [IDx-offset:5]! (IDx = ID0 or ID1)

SWAP — Swap

Format: SWAP <op1>, <op2>

<op1>: GPR
<op2>: SPR

Operation: $\langle op1 \rangle \leftarrow \langle op2 \rangle$, $\langle op2 \rangle \leftarrow \langle op1 \rangle$

SWAP swaps the values of the two operands.

Flags: –

NOTE: Among the SPRs, SR0 and SR1 can not be used as <op2>.

Example: Given: IDH:IDL0 = 8023h, R0 = 56h, R1 = 01h

 $\begin{array}{lll} \text{SWAP} & \text{R1, IDH} & \text{// R1} \leftarrow 80\text{h, IDH} \leftarrow 01\text{h} \\ \text{SWAP} & \text{R0, IDL0} & \text{// R0} \leftarrow 23\text{h, IDL0} \leftarrow 56\text{h} \\ \end{array}$

After execution of instructions, index registers IDH:IDL0 (ID0) have address 0156h.

SYS — System

Format: SYS #imm:8

Operation: SYS generates SYSCP[7:0] and nSYSID signals.

Flags: –

NOTE: Mainly used for system peripheral interfacing.

Example:

SYS #0Ah

SYS #05h

In the first example, statement "SYS #0Ah" is equal to STOP instruction and second example "SYS #05h" is equal to IDLE instruction. This instruction does nothing but increase PC by one and generates SYSCP[7:0] and nSYSID signals.

${\bf TM}$ — Test Multiple Bits

Format: TM <op>, #imm:8

<op>: GPR

Operation: TM performs the bit-wise AND operation on <pp> and imm:8 and sets the flags. The content of

<op> is not changed.

Flags: Z: set if result is zero. Reset if not.

N: set if result is negative. Reset if not.

Example: Given: R0 = 01001101b

TM R0, #00100010b // Z flag is set to '1'



XOR — Exclusive OR

Format: XOR <op1>, <op2>

<op1>: GPR

<op2>: adr:8, #imm:8, GPR, @idm

Operation: $\langle op1 \rangle \leftarrow \langle op1 \rangle ^{\land} \langle op2 \rangle$

XOR performs the bit-wise exclusive-OR operation on <op1> and <op2> and stores the result in

<op1>.

Flags: Z: set if result is zero. Reset if not.

N: set if result is negative. Reset if not.

Example: Given: IDH:IDL0 = 8080h, DM[8043h] = 26h, R0 = 52h, R1 = 14h, eid = 1

```
XOR
            R0, 43h
                                            // R0 ← 74h
XOR
            R1, #00101100b
                                            // R1 ← 38h
                                            // R0 ← 46h
XOR
            R0, R1
XOR
            R0, @ID0
                                            // R0 \leftarrow R0 ^ DM[8080h], IDL0 \leftarrow 81h
XOR
            R0, @[ID0-2]
                                            // R0 \leftarrow R0 ^{\circ} DM[807Eh], IDL0 \leftarrow 7Eh
XOR
            R0, @[ID0+3]!
                                            // R0 \leftarrow R0 ^ DM[8083h], IDL0 \leftarrow 80h
XOR
            R0, @[ID0-5]!
                                            // R0 \leftarrow R0 ^ DM[807Bh], IDL0 \leftarrow 80h
```

In the last two instructions, the value of IDH:IDL0 is not changed. Refer to Table 8-5 for more detailed explanation about this addressing mode.

idm = IDx+offset:5, [IDx-offset:5], [IDx+offset:5]!, [IDx-offset:5]! (IDx = ID0 or ID1)

NOTES



S3CB519 CLOCK CIRCUIT

9

CLOCK CIRCUIT

OVERVIEW

The S3CB519 microcontroller has two oscillator circuits: a main system clock circuit and a subsystem clock circuit. The CPU and peripheral hardware operate at the system clock frequency supplied by these circuits. The maximum CPU clock frequency is determined by PCON register setting.

SYSTEM CLOCK CIRCUIT

The system clock circuit has the following components:

- External crystal or ceramic resonator oscillation source (or an external clock source)
- Oscillator stop and wake-up functions
- Programmable frequency divider for the CPU clock (f_{OSC} divided by 1, 2, 4, 8, 16, 32, 64, 128)
- System clock control register, PCON

CLOCK CIRCUIT S3CB519

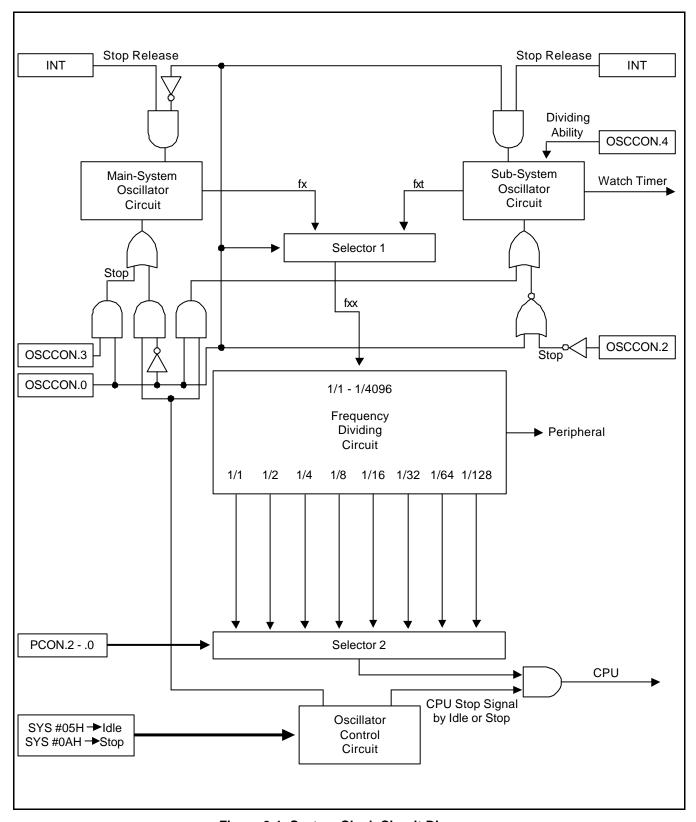


Figure 9-1. System Clock Circuit Diagram



S3CB519 CLOCK CIRCUIT

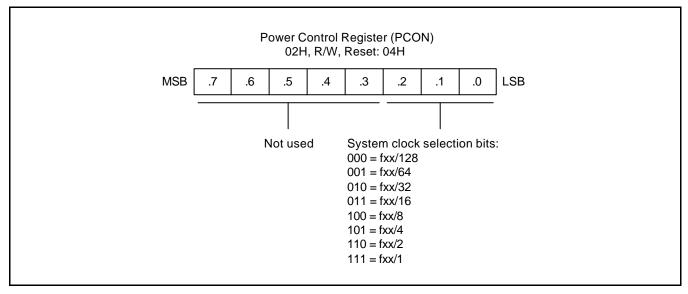


Figure 9-2. Power Control Register (PCON)

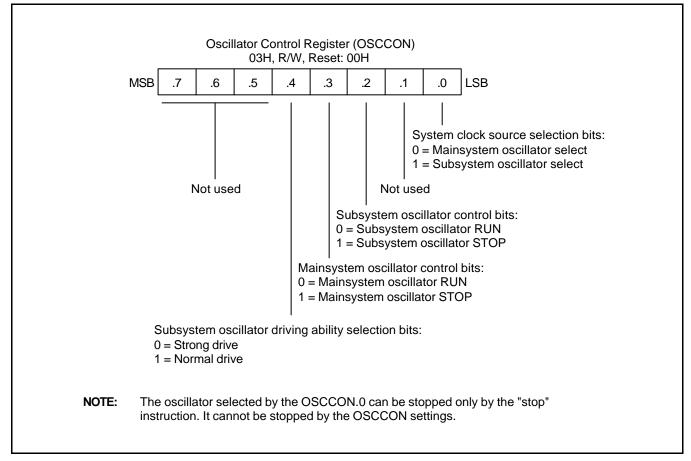


Figure 9-3. Oscillator Control Register (OSCCON)



CLOCK CIRCUIT S3CB519

NOTES



S3CB519 nRESET AND POWER-DOWN

10 nreset and power-down

OVERVIEW

During a power-on reset, the voltage at V_{DD} goes to High level and the nRESET pin is forced to Low level. The reset signal is input through a schmitt trigger circuit where it is then synchronized with the CPU clock. This procedure brings S3CB519 into a known operating status.

For the time for CPU clock oscillation to stabilize, the nRESET pin must be held to low level for a minimum time interval after the power supply comes within tolerance. (For the minimum time interval, see the electrical characteristic).

In summary, the following sequence of events occurs during a reset operation:

- All interrupts are disabled.
- The watchdog function (basic timer) is enabled.
- Ports are set to input mode except port 5 which is set to output mode.
- Peripheral control and data registers are disabled and reset to their default hardware values.
- The program counter (PC) is loaded with the program reset address in the ROM, 00000H.
- When the programmed oscillation stabilization time interval has elapsed, the instruction stored in ROM location 00000H is fetched and executed.

NOTE

To program the duration of the oscillation stabilization interval, make the appropriate settings to the watchdog timer control register, WDTCON, before entering STOP mode.



nRESET AND POWER-DOWN S3CB519

NOTES



S3CB519 VO PORTS

1 1 I/O PORTS

OVERVIEW

The S3CB519 has five I/O ports (P0–P4) for general I/O and one output port (P5) dedicated for the key-strobe with LCD segment data.

PORT 0

Two 8-bit control registers are used to configure the port 0 pins: P0CONH for pins P0.4–P0.6 and P0CONL for pins P0.0–P0.3. Each byte contains four bit-pairs and each bit-pair configures one pin. The P0CONH and the P0CONL registers also control the alternative functions.

For example, when bits 4 and 5 of P0CONL are "00", P0.2 is selected for the input mode. In this mode, you can set P0.2 as a normal input or an interrupt 2 or a timer 0 clock input by controlling P0INT and T0CON.

POINT and POEDGE registers control the interrupt functions for INT0-INT6.

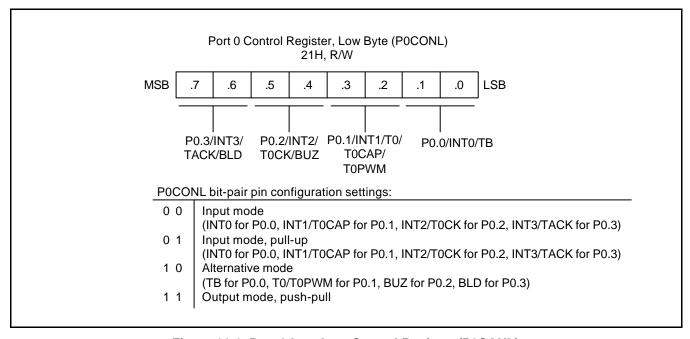


Figure 11-1. Port 0 Low-byte Control Register (P0CONL)



VO PORTS S3CB519

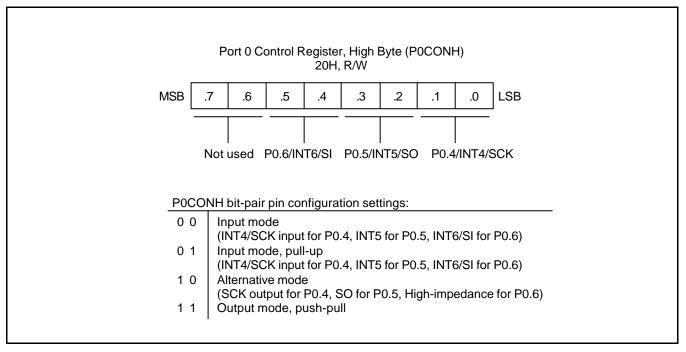


Figure 11-2. Port 0 High-byte Control Register (P0CONH)

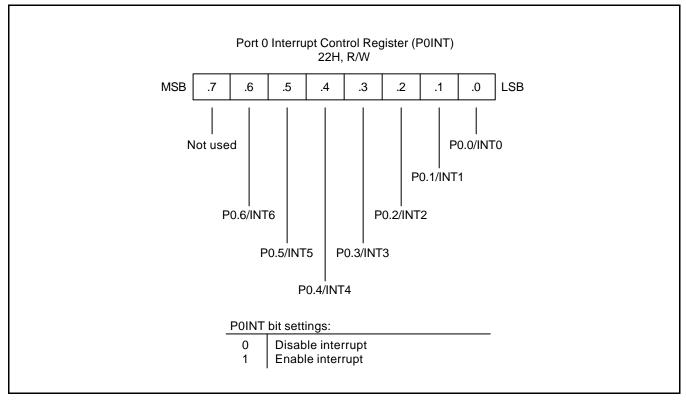


Figure 11-3. Port 0 Interrupt Control Register (P0INT)



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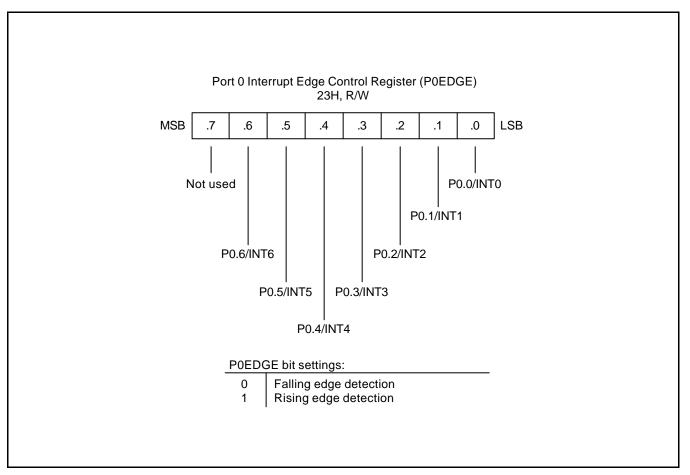


Figure 11-4. Port 0 Interrupt Edge Control Register (P0EDGE)

VO PORTS S3CB519

PORT 1

P1CON contains four bit-pairs and bit-pair configures one pin. P1INT controls the interrupt function for KS0–KS3. When the alternative mode is selected, KS0–KS3 can be used as key scan inputs with P5 (shared with LCD SEG) strobe.

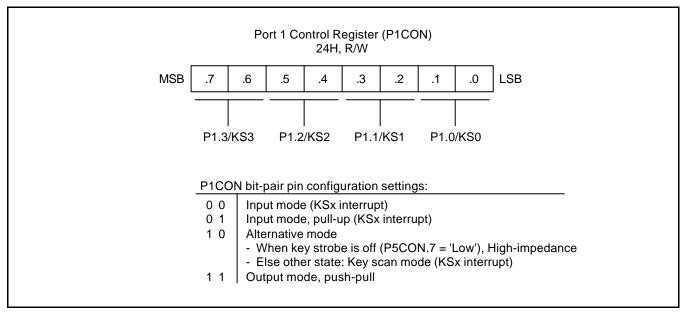


Figure 11-5. Port 1 Control Register (P1CON)

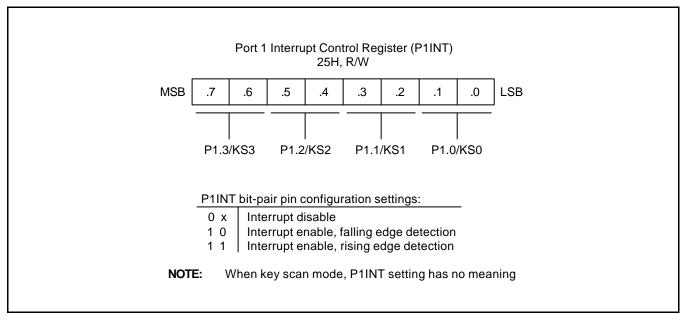


Figure 11-6. Port 1 Interrupt Control Register (P1INT)



S3CB519 VO PORTS

PORT 2

P2CON and P3CON contain two nibbles each and each nibble configures four pins. Port 2 is shared by SEG48–SEG55, and Port 3 is shared by SEG40–SEG47.

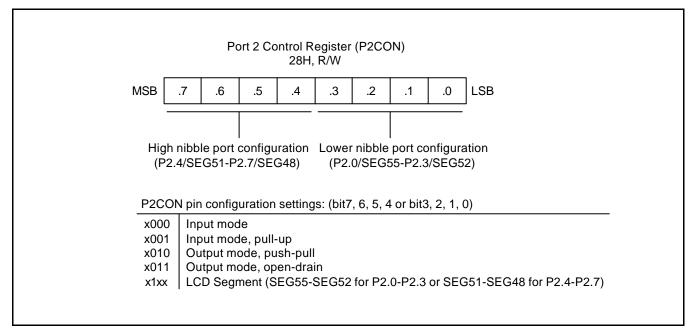


Figure 11-7. Port 2 Control Register (P2CON)

PORT 3

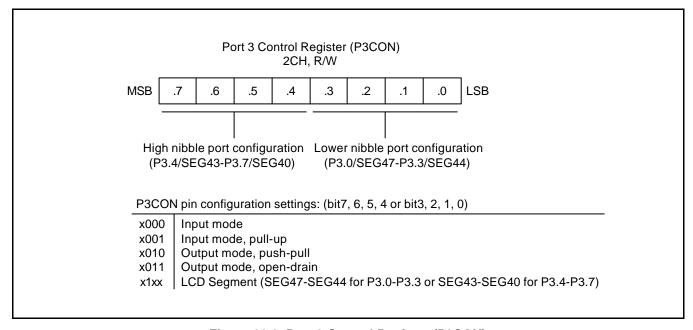


Figure 11-8. Port 3 Control Register (P3CON)



VO PORTS S3CB519

PORT 4

P4CON contains two nibbles and each nibble configures four pins.

Port 4 is shared by COM8–COM15, and I/O and COM switching are up to LMOD register.

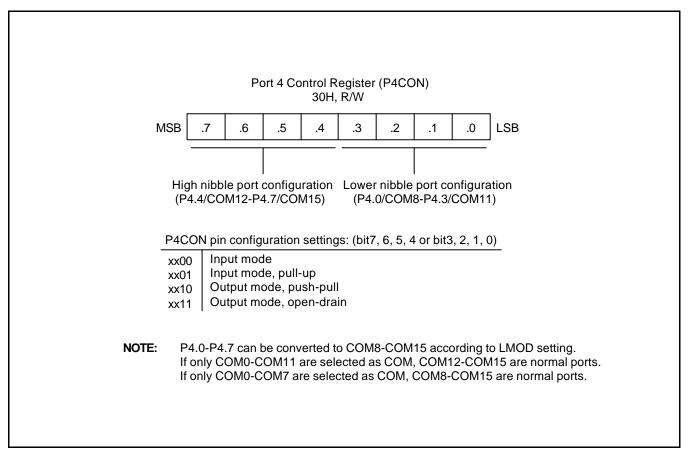


Figure 11-9. Port 4 Control Register (P4CON)

S3CB519 VO PORTS

PORT 5

Port 5, which has 15 pins, can be controlled by P5CON but cannot be used as normal I/O.

Port 5 is shared by SEG pins and makes the key-strobe. (for details, see LCD chapter).

When port 1 is selected as the alternative mode (key scan input) and the key strobe function of port 5 is enabled, port 5 data register has the key-strobe value of the time when the key scan interrupt occurs.

For example, when P5.3 outputs strobe and any of port 1 are "Low"-state, forcing the key scan interrupt, port 5 data register has the value "3". For P5.9, port 5 data register has "9".

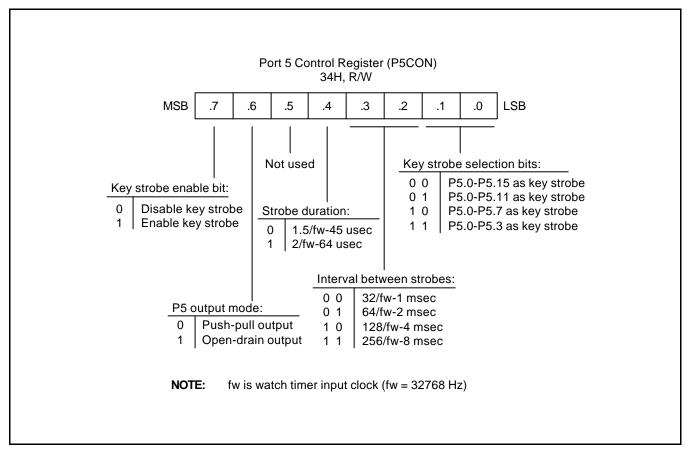


Figure 11-10. Port 5 Control Register (P5CON)

I/O PORTS S3CB519

NOTES



12

BASIC TIMER/WATCHDOG TIMER

OVERVIEW

WDTCON controls basic timer clock selection and watchdog timer clear bit.

Basic timer is used in two different ways:

- As a clock source to watchdog timer to provide an automatic reset mechanism in the event of a system malfunction (When watchdog function is enabled in ROM code option)
- To signal the end of the required oscillation stabilization interval after a reset or stop mode release.

The reset value of basic timer clock selection bits is decided by the ROM code option. (see the section on ROM code option for details). After reset, programmer can select the basic timer input clock using WDTCON.

Watchdog timer provides an automatic reset mechanism in the event of a system malfunction (When watchdog function is enabled in ROM code option)

When watchdog function is enabled by the ROM code option, programmer must set WDTCON.0 periodically within every $2048 \times \text{basic timer}$ input clock time to prevent system reset.

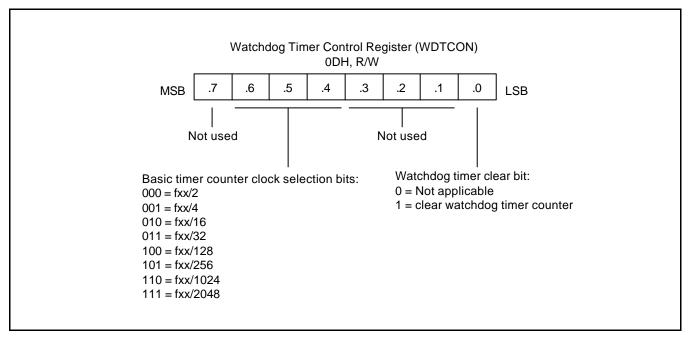


Figure 12-1. Watchdog Timer Control Register (WDTCON)



BLOCK DIAGRAM

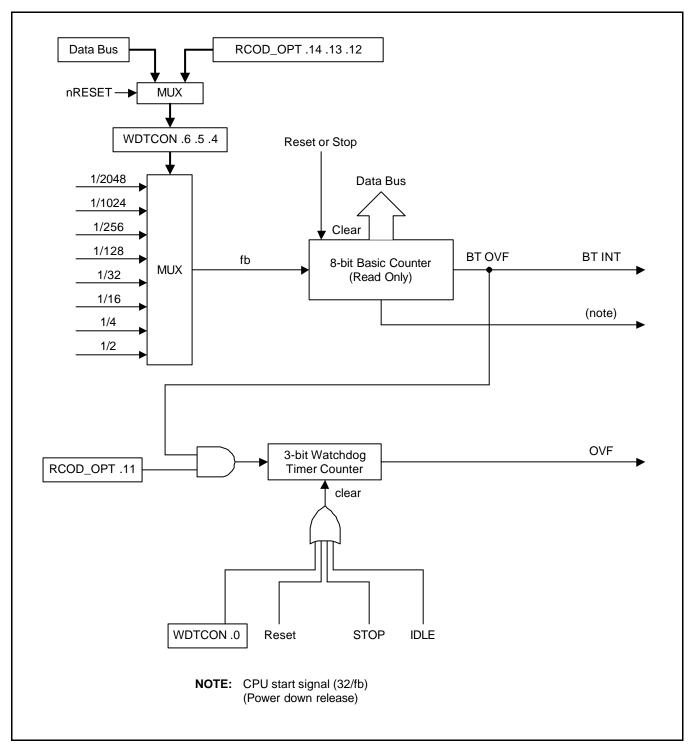


Figure 12-2. Basic Timer & Watchdog Timer Functional Block Diagram



S3CB519 WATCH TIMER

13 WATCH TIMER

OVERVIEW

Watch timer functions include real-time and watch-time measurements.

After the watch timer starts and time elapses, the watch timer interrupt is automatically set to "1", and interrupt requests commence in 3.91 ms, 0.25 s, 0.5 s or 1 second.

The watch timer can generate a steady 0.5 kHz, 1 kHz, 2 kHz or 4 kHz signal to the BUZ output when the main system clock frequency is 4.19 MHz. The watch timer supplies the clock frequency for the LCD controller (f_{LCD}) and BLD. Therefore, if the watch timer is disabled, the LCD and BLD controller do not operate.

- Real-time and Watch-time measurements
- Clock source generation for LCD controller
- Buzzer output frequency generator

Table 13-1. Watch Timer Control Register (WTCON): 8-Bit R/W

Bit Name	Values		Function	Address
WTCON.7	_		Not used	70H
WTCON.6	_		Not used	
WTCON .54	0	0	0.5 kHz buzzer (BUZ) signal output	
	0	1	1 kHz buzzer (BUZ) signal output	
	1	0	2 kHz buzzer (BUZ) signal output	
	1	1	4 kHz buzzer (BUZ) signal output	
WTCON .32	0	0	Set watch timer interrupt to 1 sec.	
	0	1	Set watch timer interrupt to 0.5 sec.	
	1	0	Set watch timer interrupt to 0.25 sec.	
	1	1	Set watch timer interrupt to 3.91 ms.	
WTCON.1	0		Selects (fx/128 or fx/64) as the watch timer clock	
	1		Selects the subsystem clock as watch timer clock	
WTCON.0	0		Stops the watch timer counter; clears the frequency dividing circuits	
			Runs the watch timer counter	

NOTE: Main system clock frequency (fx) is assumed to be 4.19 MHz.



WATCH TIMER S3CB519

WATCH TIMER CIRCUIT DIAGRAM

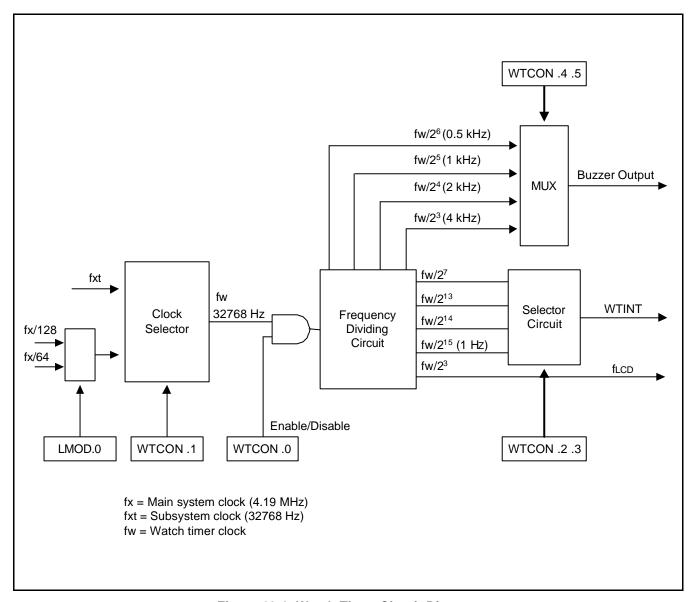


Figure 13-1. Watch Timer Circuit Diagram

14 16-BIT TIMER (8-BIT TIMER A & B)

OVERVIEW

The 16-bit timer is used in one 16-bit timer or two 8-bit timers. When Bit 2 of TBCON is "1", it operates as one 16-bit timer. When it is "0", it operates as two 8-bit timers. When it operates as one 16-bit timer, the TBCNT's clock source can be selected by setting TBCON.3. If TBCON.3 is "0", the timer A's overflow would be TBCNT's clock source. If it is "1", the timer A's interval out would be TBCNT's clock source. The timer clock source can be selected by the S/W.

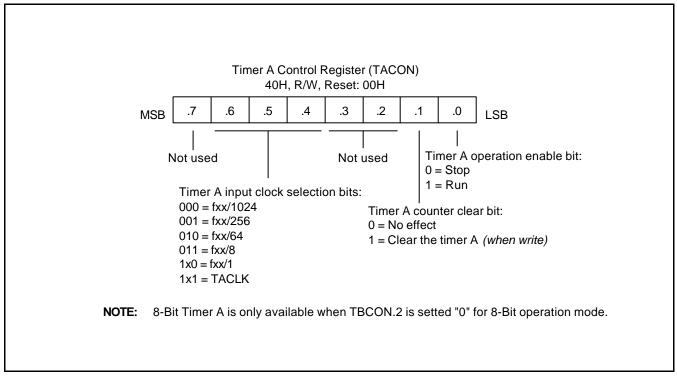


Figure 14-1. Timer A Control Register (TACON)

INTERVAL TIMER FUNCTION

The timer A&B module can generate an interrupt: the Timer A and/or Timer B match interrupt (TAINT, TBINT). In interval timer mode, a match signal is generated when the counter value is identical to the value written to the reference data register, TADATA/TBDATA. The match signal generates Timer A and/or Timer B match interrupt and clears the counter.

TB pin can be toggled whenever the timer B match interrupt occurs if I/O port setting is appropriate.



14-1

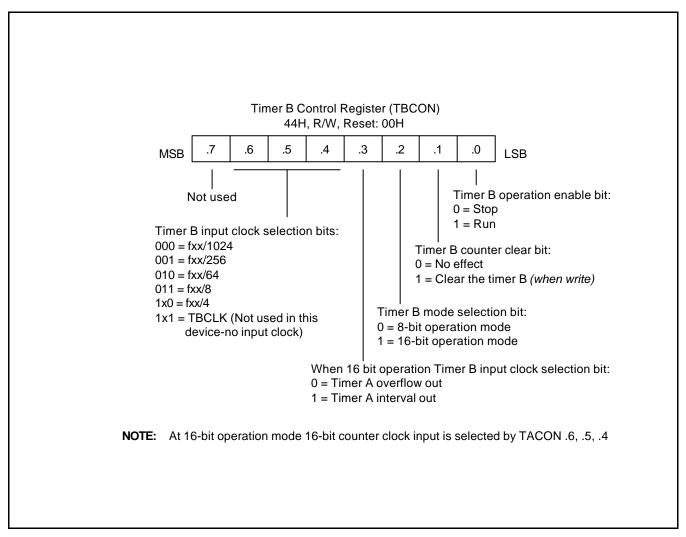


Figure 14-2. Timer B Control Register (TBCON)

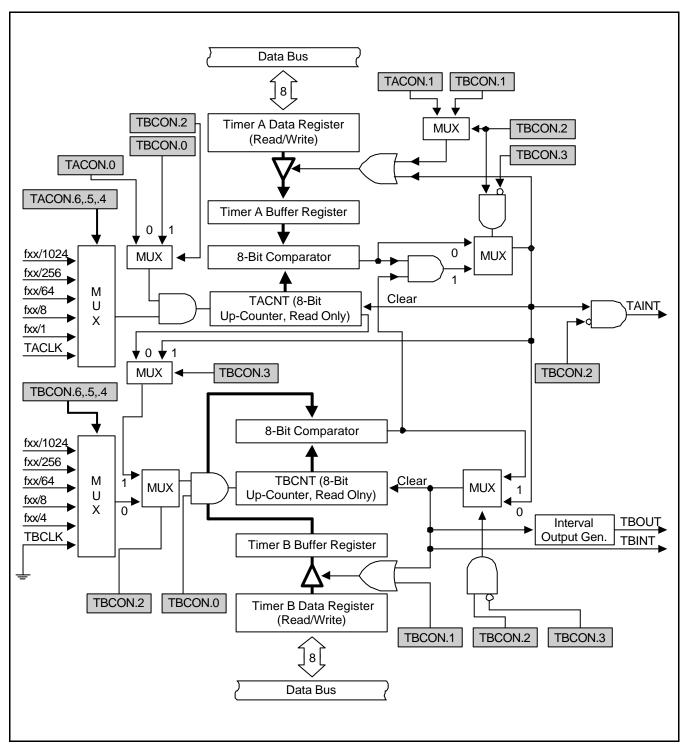


Figure 14-3. Timer A, B Function Block Diagram

NOTES



S3CB519 8-BIT TIMER (TIMER 0)

15 8-BIT TIMER (TIMER 0)

OVERVIEW

The 8-bit timer 0 is an 8-bit general-purpose timer/counter. Timer 0 has three operating modes, one of which you select using the appropriate T0CON setting:

- Interval timer mode (Toggle output at T0 pin)
- Capture input mode with a rising or falling edge trigger at the TOCAP pin
- PWM mode (T0PWM)

8-BIT TIMER (TIMER 0) S3CB519

FUNCTION DESCRIPTION

Timer 0 Interrupts

The Timer 0 module can generate two interrupts: the Timer 0 overflow interrupt (T0OVF), and the Timer 0 match/capture interrupt (T0INT).

Interval Timer Function

The Timer 0 module can generate an interrupt: the Timer 0 match interrupt (T0INT).

In interval timer mode, a match signal is generated(,) and T0 is toggled when the counter value is identical to the value written to the T0 reference data register, T0DATA. The match signal generates a Timer 0 match interrupt and clears the counter.

If, for example, you write the value 10H to T0DATA and 0AH to T0CON, the counter will increment until it reaches 10H. At this point, the T0 interrupt request is generated and the counter value is reset and counting resumes.

Pulse Width Modulation Mode

Pulse width modulation (PWM) mode lets you program the width (duration) of the pulse that is output at the T0PWM pin. As in interval timer mode, a match signal is generated when the counter value is identical to the value written to the Timer 0 data register. In PWM mode, however, the match signal does not clear the counter but can generate a match interrupt. The counter runs continuously, overflowing at FFH, and then repeats the incrementing from 00H. Whenever an overflow occurs, an overflow(OVF) interrupt can be generated.

Although you can use the match or the overflow interrupt in PWM mode, interrupts are not typically used in PWM-type applications. Instead, the pulse at the T0PWM pin is held to High level as long as the reference data value is less than or equal to (\leq) the counter value, and then the pulse is held to Low level for as long as the data value is greater than (>) the counter value. One pulse width is equal to $t_{CLK} \times 256$.

Capture Mode

In capture mode, a signal edge that is detected at the T0CAP pin opens a gate and loads the current counter value into the T0 data register. You can select the rising or falling edges to trigger this operation.

Timer 0 also gives you capture input source: the signal edge at the T0CAP pin. You select the capture input by setting the value of the Timer 0 capture input selection bit in the port control register.

Both kinds of Timer 0 interrupts can be used in capture mode: the Timer 0 overflow interrupt is generated whenever a counter overflow occurs; the Timer 0 match/capture interrupt is generated whenever the counter value is loaded into the T0 data register.

By reading the captured data value in T0DATA and assuming a specific value for the Timer 0 clock frequency, you can calculate the pulse width (duration) of the signal that is being input at the T0CAP pin.



S3CB519 8-BIT TIMER (TIMER 0)

TIMER 0 CONTROL REGISTER (T0CON)

You use the Timer 0 control register, T0CON, to

- Select the Timer 0 operating mode (interval timer, capture mode, or PWM mode)
- Select the Timer 0 input clock frequency
- Clear the Timer 0 counter, T0CNT
- Enable the Timer 0 overflow interrupt or Timer 0 match/capture interrupt

A reset clears T0CON to '00H'. This sets Timer 0 to normal interval timer mode, selects an input clock frequency of $f_{OSC}/1024$, and disables all Timer 0 interrupts. You can clear the Timer 0 counter at any time during normal operation by writing a "1" to T0CON.3.

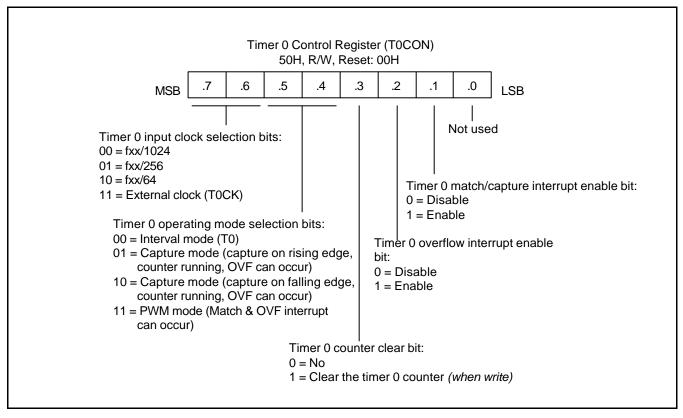


Figure 15-1. Timer 0 Control Register (T0CON)

8-BIT TIMER (TIMER 0) S3CB519

BLOCK DIAGRAM

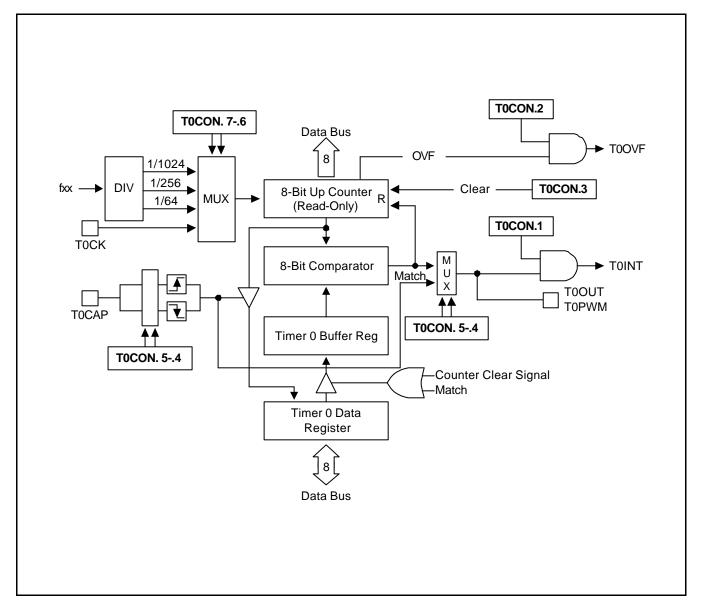


Figure 15-2. Timer 0 Functional Block Diagram

S3CB519 SERIAL VO INTERFACE

16 SERIAL I/O INTERFACE

OVERVIEW

The SIO module can transmit or receive 8-bit serial data at a frequency determined by its corresponding control register settings. To ensure flexible data transmission rates, you can select an internal or external clock source.

PROGRAMMING PROCEDURE

To program the SIO modules, follow these basic steps:

- Configure the I/O pins at port (SO,nSCK, SI) by loading the appropriate value to the P0CONH register, if necessary.
- 2. Load an 8-bit value to the SIOCON register to properly configure the serial I/O module. In this operation, SIOCON.2 must be set to "1" to enable the data shifter.
- 3. For interrupt generation, set the serial I/O interrupt enable bit (SIOCON.1) to "1".
- 4. When you transmit data to the serial buffer, write data to SIODATA and set SIOCON.3 to 1, the shift operation starts.
- 5. When the shift operation (transmit/receive) is completed, the SIO pending bit is set to "1", and a SIO interrupt request is generated.

SERIAL VO INTERFACE S3CB519

SIO CONTROL REGISTER (SIOCON)

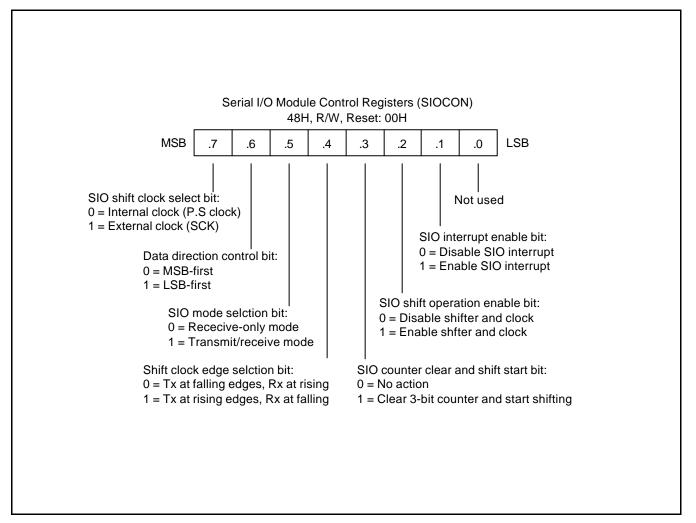


Figure 16-1. Serial I/O Control Register (SIOCON)

S3CB519 SERIAL I/O INTERFACE

SIO PRE-SCALER REGISTER (SIOPS)

The values stored in the SIO pre-scaler registers, SIOPS, lets you determine the SIO clock rate (baud rate) as follows:

Baud rate = Input clock/(Pre-scaler value + 1), or SCLK input clock

where the input clock is fxx/4

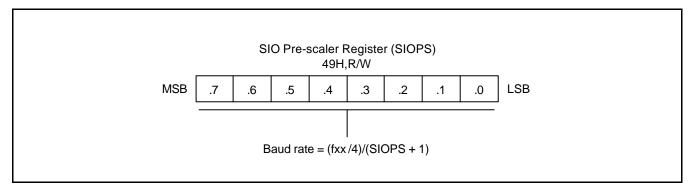


Figure 16-2. SIO Pre-scaler Register (SIOPS)

BLOCK DIAGRAM

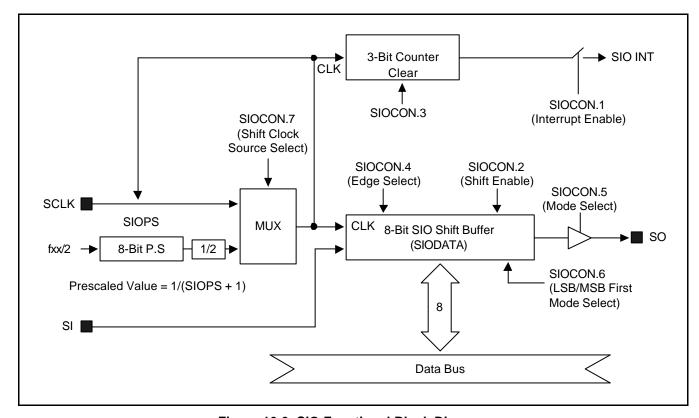


Figure 16-3. SIO Functional Block Diagram



SERIAL I/O INTERFACE S3CB519

SERIAL I/O TIMING DIAGRAMS

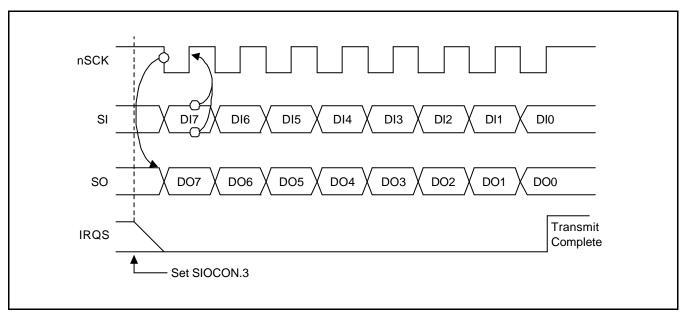


Figure 16-4. Serial I/O Timing in Transmit/Receive Mode (Tx at falling, SIOCON.4 = 0)

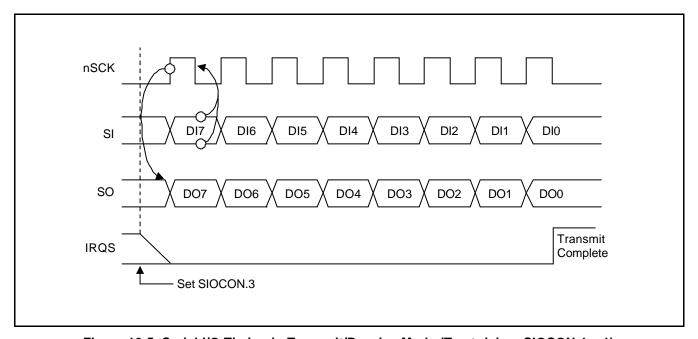


Figure 16-5. Serial I/O Timing in Transmit/Receive Mode (Tx at rising, SIOCON.4 = 1)

S3CB519 BATTERY LEVEL DETECTOR

17

BATTERY LEVEL DETECTOR

OVERVIEW

The S3CB519 microcontroller has a built-in BLD (Battery Level Detector) circuit which allows detection of power voltage drop of an external input level or internal V_{DD} .

When external input is selected by P0CONL, detection voltage level can be adjusted through the external divided resistors ratio on BLD pin. Internal reference voltage is 1.2 V.

After detection, BLD is automatically disabled, and EOBLD bit is set.

Because the clock for BLD comes from the watch timer, watch timer must be enabled to use BLD.

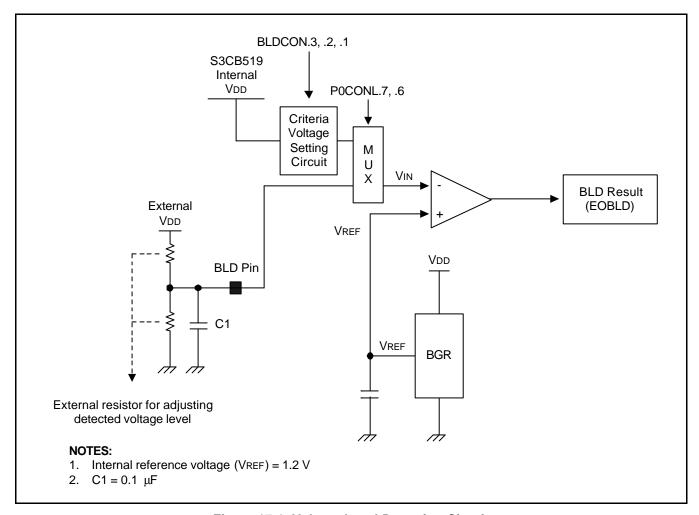


Figure 17-1. Voltage Level Detection Circuit



BATTERY LEVEL DETECTOR S3CB519

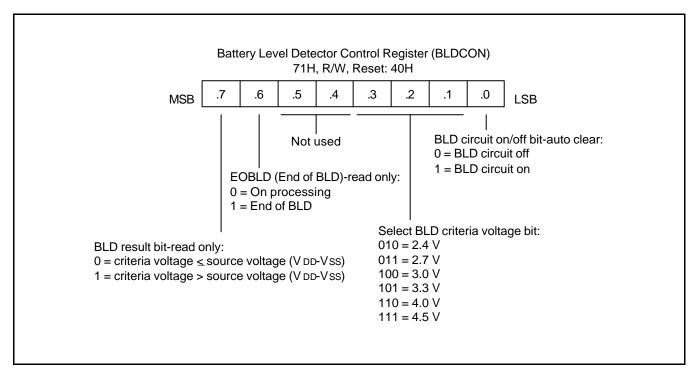


Figure 17-2. Battery Level Detector Control Register (BLDCON)

S3CB519 LCD CONTROLLER/DRIVER

18

LCD CONTROLLER/DRIVER

OVERVIEW

This microcontroller can directly drive the (56 segments × 16 commons) LCD panel. Data written to the LCD display RAM can be transferred to the segment signal pins automatically without program control. When a subsystem clock is selected as the LCD clock source, the LCD display is enabled even during Idle modes.

LCD RAM ADDRESS AREA

LCD RAM can be addressed by 8-bit RAM access instructions. When the bit value of a display segment is "1", the LCD display is turned on; when the bit value is "0", the display is turned off.

Display RAM data are sent out through segment pins SEG0–SEG55 using a direct memory access (DMA) method that is synchronized with the f_{LCD} signal. RAM addresses in this location that are not used for the LCD display can be allocated to general-purpose use.

LCD RAM (RAM BANK 12)

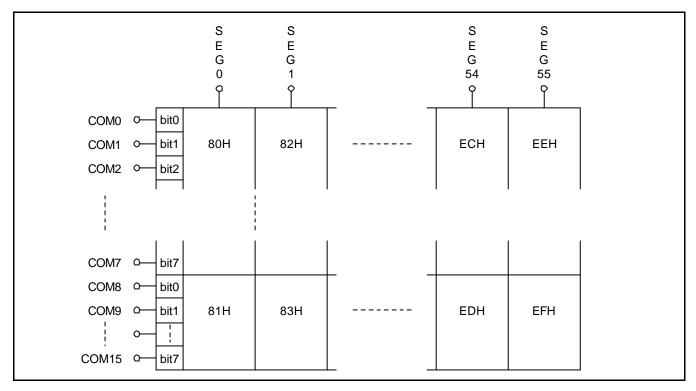


Figure 18-1. LCD Display Data RAM Organization



LCD CONTROLLER/DRIVER S3CB519

LCD CONTROL REGISTER (LCON)

LCON controls LCD dividing resistor and LCD display.

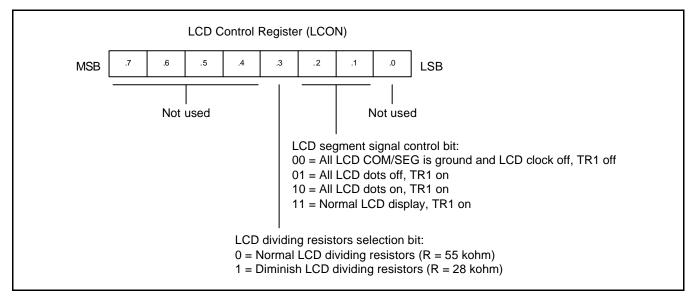


Figure 18-2. LCD Control Register (LCON)

LCD VOLTAGE DIVIDING RESISTORS

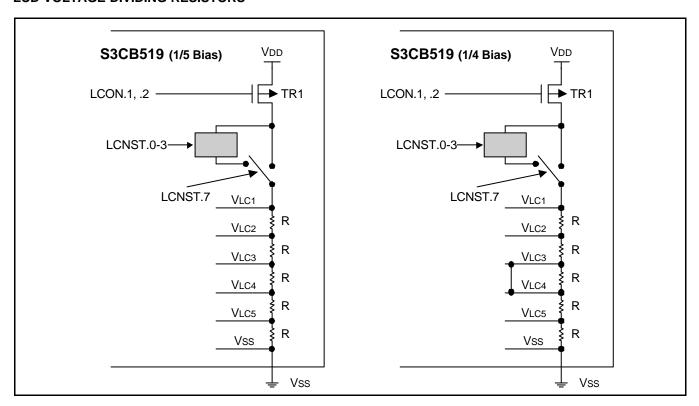


Figure 18-3. Internal Voltage Dividing Resistor Connection



S3CB519 LCD CONTROLLER/DRIVER

LCD MODE REGISTER (LMOD)

LMOD controls LCD bias, duty, and clock.

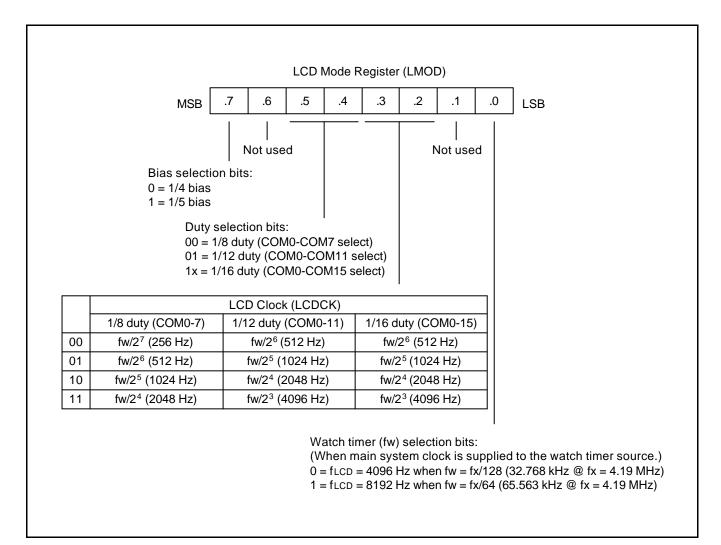


Figure 18-4. LCD Mode Register (LMOD)

LCD CONTROLLER/DRIVER S3CB519

LCD CONTRAST CONTROL REGISTER (LCNST)

LCNST controls LCD contrast.

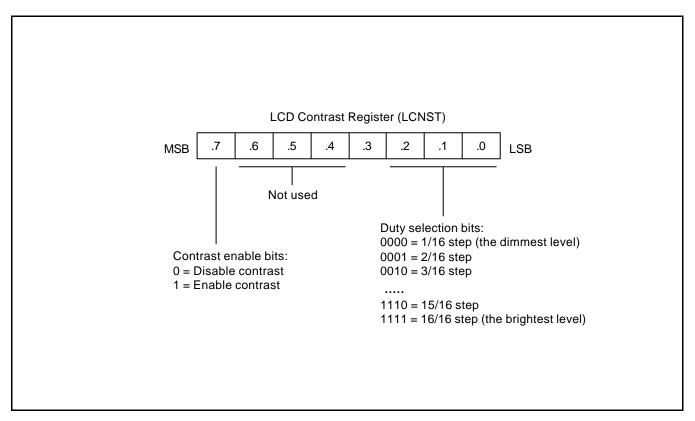


Figure 18-5. LCD Contrast Register (LCNST)

S3CB519 LCD CONTROLLER/DRIVER

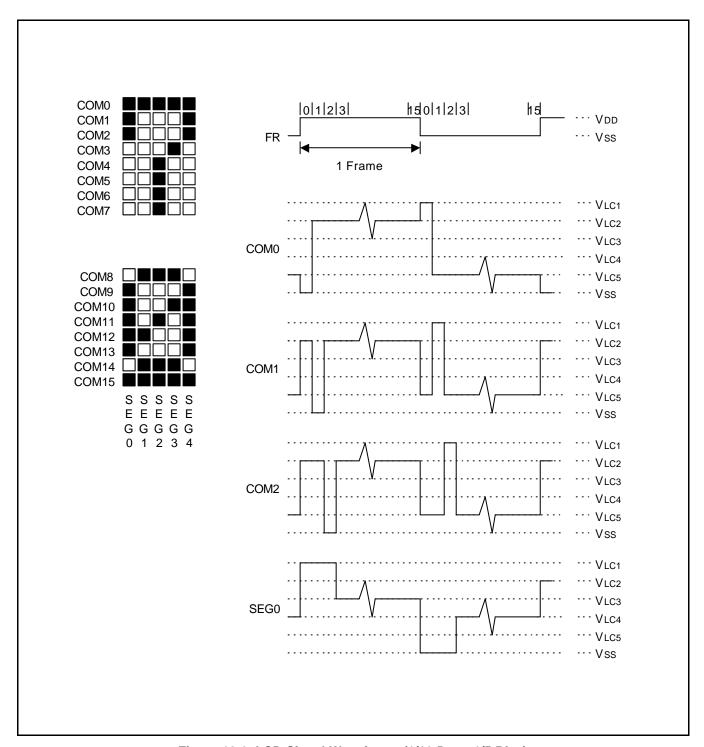


Figure 18-6. LCD Signal Waveforms (1/16 Duty, 1/5 Bias)

LCD CONTROLLER/DRIVER S3CB519

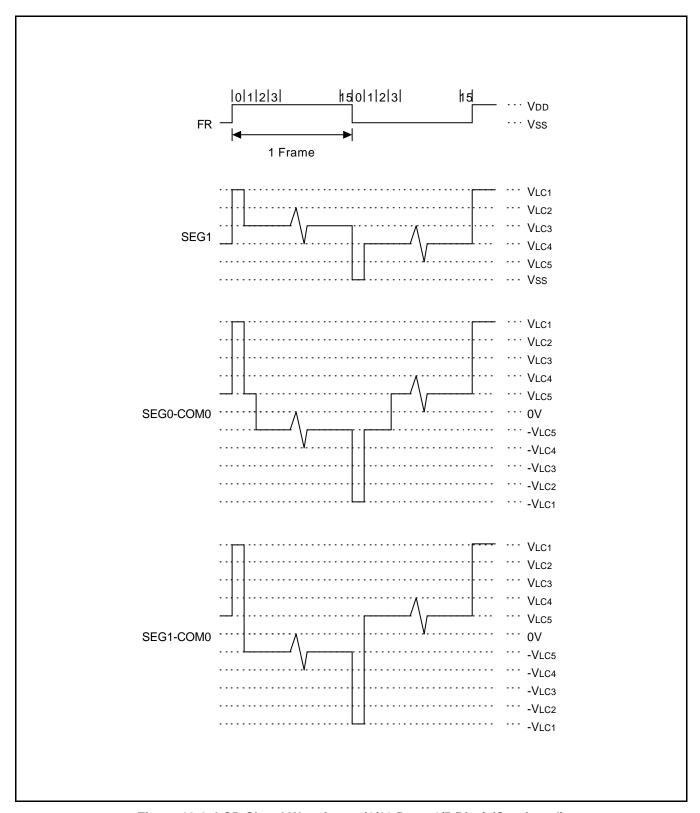


Figure 18-6. LCD Signal Waveforms (1/16 Duty, 1/5 Bias) (Continued)



S3CB519 LCD CONTROLLER/DRIVER

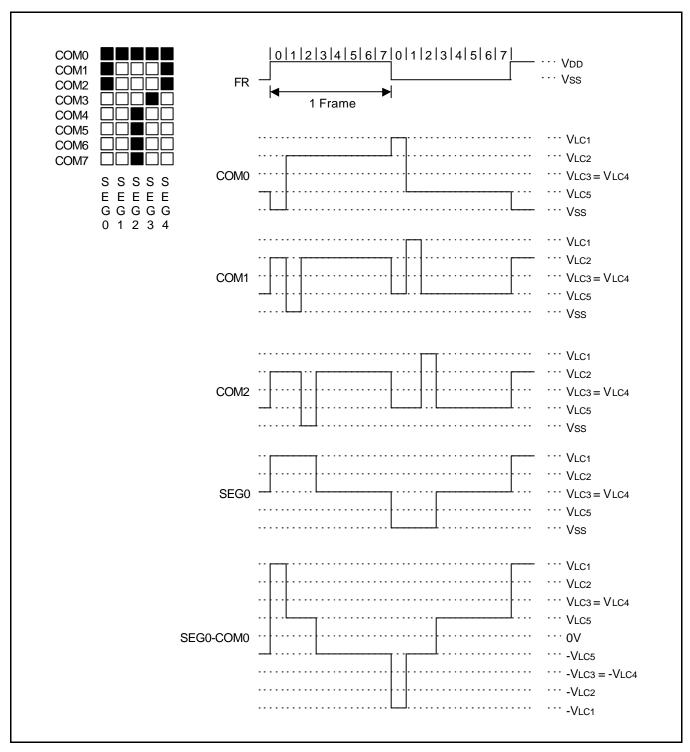


Figure 18-7. LCD Signal Waveforms (1/8 Duty, 1/4 Bias)

LCD CONTROLLER/DRIVER S3CB519

LCD KEY SCAN

When P5CON.7 is set, strobe signal is output to P5.0/SEG39-P5.15/SEG24 during normal SEG output, and the strobe signal number is selected by P5CON setting.

Key input is acquired from KS0/P1.0-KS3/P1.3 and is set in P1CON.

If any pin of P5.0–P5.15 is set only to SEG in P5CON, the selected pin does not output the key strobe signal. If any of P1.0-P1.3 is set to anything other than the alternative mode (key scan mode), the selected pin acts as a normal I/O.

When P5.0/SEG39–P5.15/SEG24 are set as key strobe, selected key strobe is output, pin by pin, continuously with a selected interval and duration.

When KS0/P1.0–KS3/P1.3 are set as an alternative mode (key scan input), KS0–KS3 state is normally high-impedance, and when SEGx strobe is out, KS0/P1.0–KS3/P1.3 setting is changed to input pull-up state. The data (Port 1) is input right before the strobe disappears, and if any "Low" state appears, an interrupt occurs.

When the key scan interrupt occurs, user can read the Interrupt request register for the key input state and the Port 5 data register for the key strobe state. The data of the selected pin, P5, is not changed until next strobe occurs. Port 1 data register has invalid data when in the key input state.

Port 5 data register value is '0' for P5.0 strobe, '1' for P5.1, '2' for P5.2, ...'0FH' for P5.15 strobe.



S3CB519 LCD CONTROLLER/DRIVER

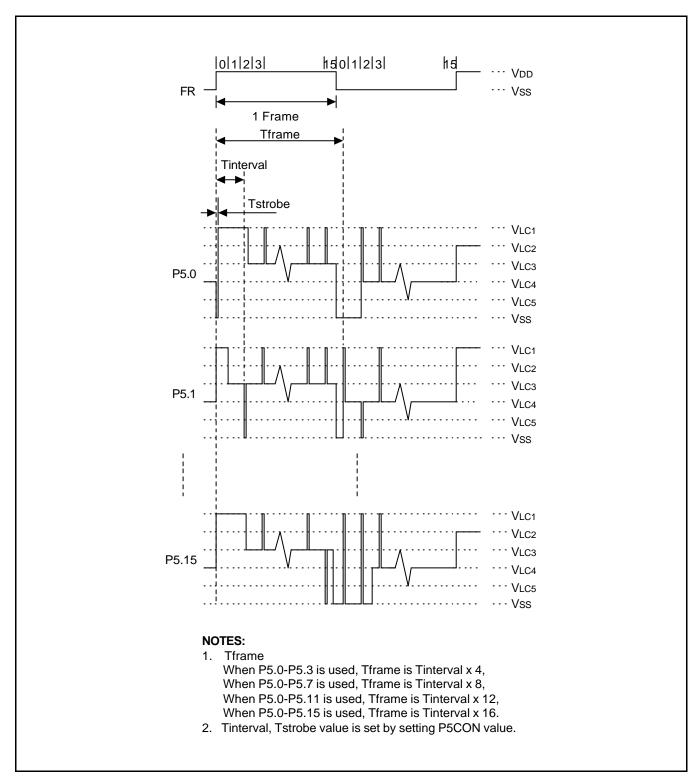


Figure 18-8. LCD Waveform when Key Strobe Signal is Active



LCD CONTROLLER/DRIVER S3CB519

NOTES



S3CB519 A/D CONVERTER

19 A/D CONVERTER

OVERVIEW

The ADC is Sigma-Delta type ADC for speech and telephony applications. The ADC contains both digital IIR/FIR filters, and an on-chip voltage reference circuit is included to allow supply operations.

FEATURES

Sigma Delta ADC.

- 256X oversampling
- On chip decimation filter
- On chip voltage reference circuitry

A/D CONVERTER S3CB519

A/D CONVERTER CONTROL REGISTER (ADCON)

User can select the A/D input clock for dividing higher crystal by controlling ADCON.

A/D converted data are 14-bit resolution and are input to ADDATAH (High byte), ADDATAL (Low byte) in 16-bit data format. Because A/DC use 256X over-sampling, for 8 kHz sampling, when crystal is 2.048 MHz (= $8 \text{ kHz} \times 256$), user must select fx as AD/DA input clock.

And when crystal is 4.096 MHz (= 2×8 kHz \times 256), user must select fx/2 as AD/DA input clock.

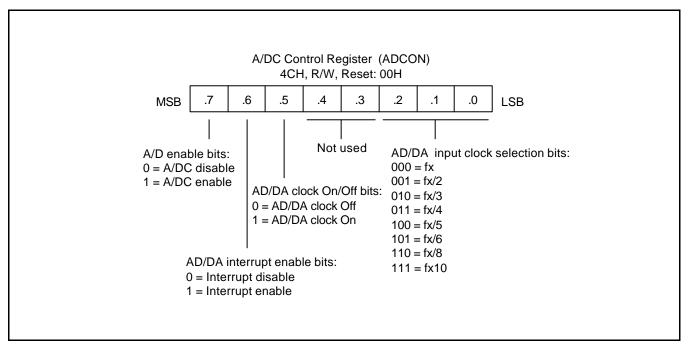


Figure 19-1. A/DC Control Register (ADCON)

S3CB519 A/D CONVERTER

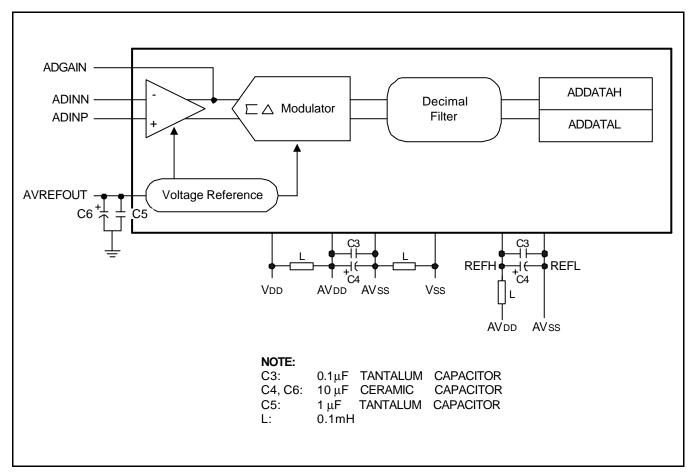


Figure 19-2. A/D Converter Block Diagram

A/D CONVERTER S3CB519

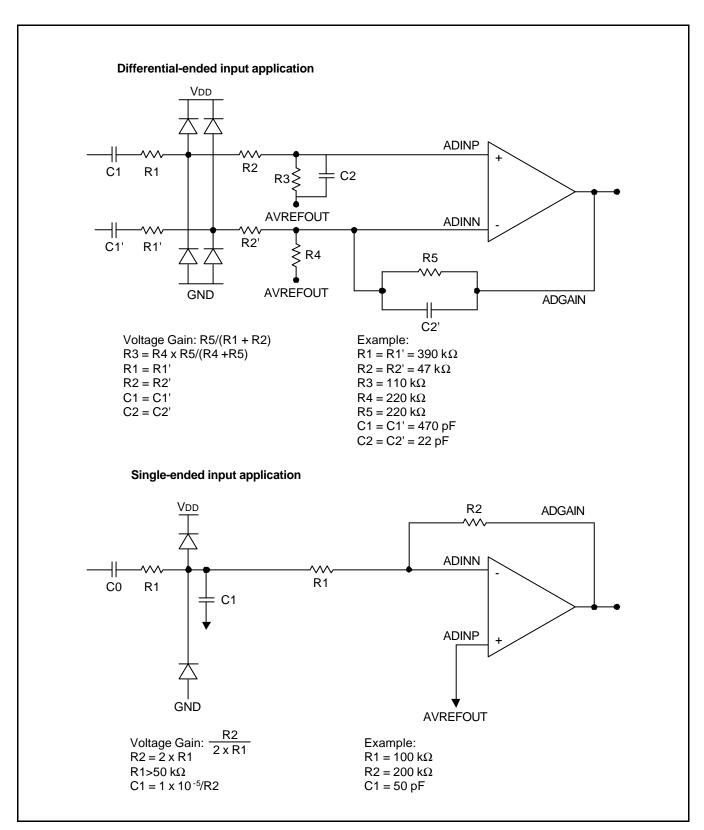


Figure 19-3. Application Example



S3CB519 D/A CONVERTER

20 D/A CONVERTER

OVERVIEW

This MCU has an 8-bit Digital-to-Analog converter with R-2R structure. This DAC (Digital – to Analog converter) is used to generate analog voltage, V_{DA} , with 256-steps (2⁸). This function is controlled by the DAC mode register (DACON).

To enable the converter, the DACON.0 must be set to "1". To generate an analog voltage (V_{DA}), load the appropriate value to DADATA. The level of the analog voltage is determined by DADATA.

When a user writes data to DADATA, the contents of GR13 is shifted to GR14, GR12 to GR13, GR11 to GR12, and DADATA to GR11.

The content of GR24 is output to DAO. When GR24 is output and some time passes, the contents of GR23 is shifted to GR24, GR22 to GR23, GR21 to GR22. After all the contents of GR21–GR24 is out to DAO, GR11–GR14 will be copied to GR21–GR24.

Four consequent DA data will be written to DADATA every AD/DA interrupt. Then the four data will be out with same interval until the next AD/DA interrupt occurs.

The interval between DAO and the next DAO is about 31 µsec when a 4.096 MHz oscillator is used, and ADC clock is fx/2.

The interval clock comes from the ADC. (See ADCON).

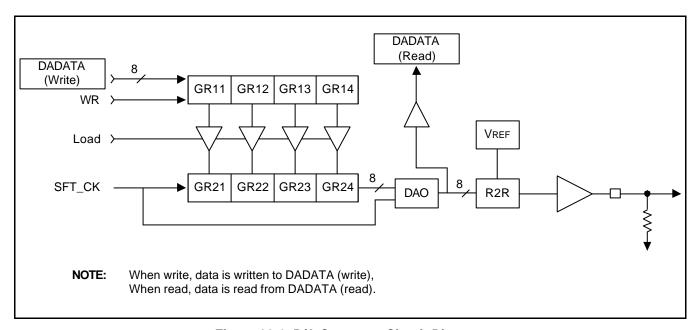


Figure 20-1. D/A Converter Circuit Diagram



D/A CONVERTER S3CB519

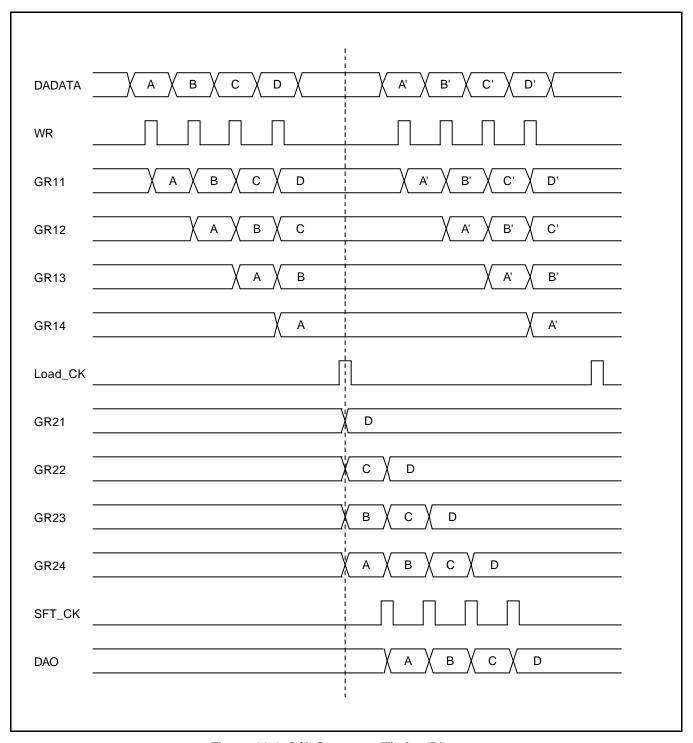


Figure 20-2. D/A Converter Timing Diagram

S3CB519 D/A CONVERTER

D/A CONVERTER DATA REGISTER (DADATA)

The DADATA specifies the digital data to generate analog voltage. nRESET initializes the DADATA value to "00H". The D/A converter output value, V_{DAO} , is calculated by following formula.

 $V_{DAO} = V_{PP} \times (n / 256) + V_{BIAS} - \frac{1}{2} V_{PP}$ (n = 0-255, DADATA value), where, V_{PP} and V_{BIAS} is specified in electrical data and the V_{PP} is a regulated output voltage.

If DADATA value is 0,
$$V_{DAO} = V_{BIAS} - \frac{1}{2} V_{PP}$$

If DADATA value is 128, $V_{DAO} = V_{BIAS}$
If DADATA value is 255, $V_{DAO} = V_{BIAS} + \frac{1}{2} V_{PP}$

D/A CONVERTER CONTROL REGISTER (DACON)

DACON values are set to logic "00H" following nRESET, and this value disables DAC.

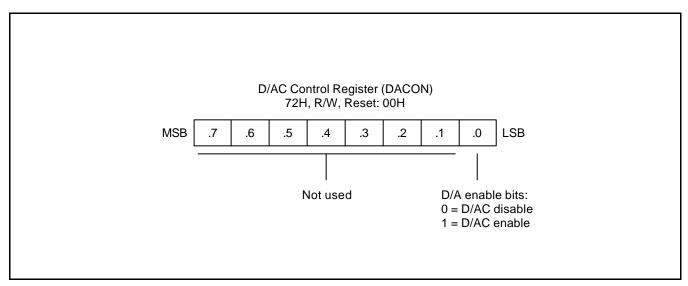


Figure 20-3. D/A Control Register (DACON)

D/A CONVERTER S3CB519

NOTES



S3CB519 MAC816

21 MAC816

MAC816 ARCHITECTURE OVERVIEW

MAC816 is a 16-bit fixed-point DSP coprocessor for low-end DSP applications. It is designed as one of the DSP coprocessor engines for CalmRISC, which targets towards cost-sensitive low-end multimedia DSP applications. The generic coprocessor instructions for CalmRISC are renamed according to the intended operations on MAC816, including the DSP data type, and the DSP addressing mode. Below represented is the top block diagram of MAC816.

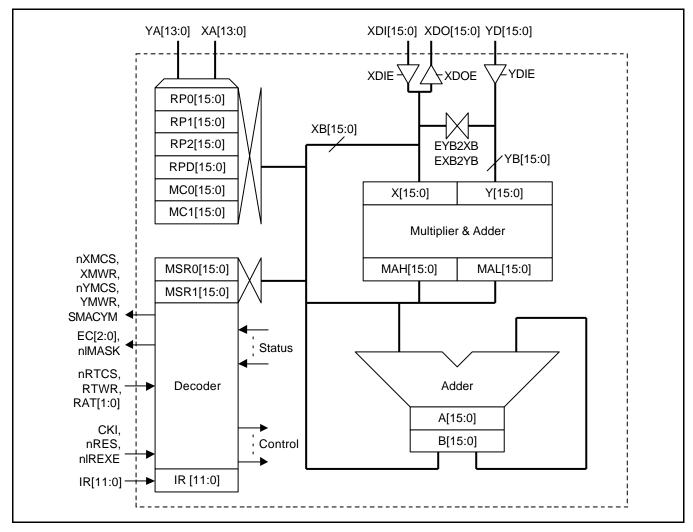


Figure 21-1. Top Block Diagram



MAC816 S3CB519

The MAC816 building blocks consist of:

- Multiplier and Accumulator Unit (MAU)
- Arithmetic Unit (AU)
- RAM Pointer Unit (RPU)
- Interface Unit (IU)

Basically, MAU (Multiplier and Accumulator Unit) is built around an 8-bit by 16-bit parallel multiplier and a 32-bit adder for multiply-and-accumulate (MAC) operations. Hence, 16-bit by 16-bit MAC operations are performed in two cycles in MAC816. AU performs 16-bit arithmetic and shift operations for DSP. RPU of MAC816 consists of 3 data memory pointers and 2 control blocks for the pointer modulo calculation. The pointers are used for accessing the data memory for a 16-bit data operand. Since two 16-bit data operands can be fetched simultaneously in a single cycle through XD[15:0] and YD[15:0] for MAC operation, the data memory should be partitioned into two parts: X and Y memory. IU is for the communication between CalmRISC and MAC816. It decodes coprocessor interface signals from CalmRISC and controls the data paths in MAC816, according to the decoding result.

Most of MAC816 instructions are 1-word instruction, while several instructions which need 16-bit immediate value are 2-word instruction.



S3CB519 MAC816

PROGRAMMER'S MODEL

In this chapter, the important features of MAC816 are discussed in detail. How the data memory is organized is discussed and the explanation of registers follows. Last, the host interface with CalmRISC will be explained.

DATA MEMORY ACCESSES

The total data memory address space for MAC816 is 32K-word. The 32K-word data memory space is physically divided into XM (X area memory) and YM (Y area memory). This memory is actually shared with the host processor (CalmRISC). The host processor accesses the 64K-byte data memory in byte width, otherwise MAC816 accesses it in 2-byte width. MAC816 has two types of addressing modes. RPU can generate two 15-bit addresses every instruction cycle which can be post-modified.

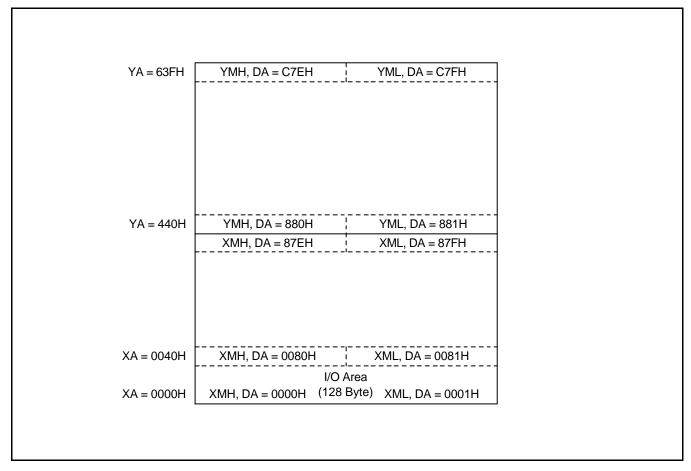


Figure 21-2. Data Memory Organization

MAC816 S3CB519

Table 21-1.	RPU(RAM	Pointer	Unit)	Registers
-------------	---------	---------	-------	-----------

Regi	sters	Mnemonics	Description	Reset Value
Mreg1	RPi	RP0	RAM Pointer register 0	Unknown
		RP1	RAM Pointer register 1	Unknown
		RP2	RAM Pointer register 2	Unknown
		RPD	RAM Pointer for short direct addressing	Unknown
MCi		MC0	Modulo Control register 0 for RP0/RP1	Unknown
		MC1	Modulo Control register 1 for RP2	Unknown

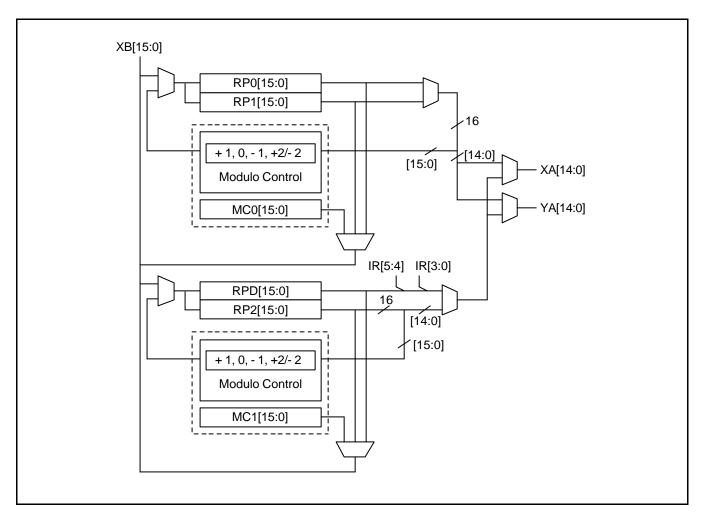


Figure 21-3. RPU (RAM Pointer Unit) Block Diagram

Short Direct Memory Addressing Mode

Six-bits embedded in the instruction code as LSBs and 9-bits from the RPD[14:6] of RPD register as MSB compose the 15-bit address to the data memory address. This can be used with some instructions operating an Ai (A/B register in AU) operand. In "load/store *mreg1*" instruction, a 4-bit embedded in the instruction code as LSBs and 11-bits from the RPD[14:4] of RPD register as MSB compose the 15-bit address to the data memory address. This can be used to load/store RAM pointer register from/to data memory.

Indirect Memory Addressing Mode

The RPi registers of RPU are used as a 15-bit address for indirect addressing XM (X area memory) or YM (Y area memory). Some instructions can simultaneously access the XM and YM, and then RP0 is used for XM and RP2 for YM. In indirect addressing mode, RPi register is modified by +1,-1,-2, and +2 after the addressing. The MSB of RPi register enables modulo operation of the RPi modification. The RPU registers are divided into two groups of simultaneous addressing over XA and YA: X-memory is addressed by RP0 and RP1 with MC0 and Y-memory is addressed by RP2 with MC1. RPi from both groups can be used for both XA and YA for instruction, which uses only one address register. In this instruction the XM and YM can be viewed as a single continuous data memory space.

Table 21-2. RPi register bit information

Bit position	Value	Description
[14:0]	0H-7FFFH	Data memory(XM/YM) address
[15]	0	Modulo mode disable
	1	Modulo mode enable



Modulo Control Registers (MCi)

MCi controls RP0, RP1 and RP2 register modifications after indirect memory accessing. MCi has an upper boundary value in MCi[9:0], a step size in MCi[12:10] and a modulo size information in MCi[15:13]. The upper boundary determines the upper limit of the modulo body. The modulo size information determines the lower limit and size of the modulo body as shown below. For example, assume RP0 = 87FFH and MC0 = 03FFH: If "@RP0+" is used on the operand of the instruction, the data memory contents pointed by "07FFH" is accessed, and RP0 is updated to "8400H" after memory accessing. Assume RP0 = 07FFH and MC0 = 03FFH: If "@RP0+" is used on the operand of the instruction, the data memory contents pointed by "07FFH" is accessed, and RP0 is updated to "0800H" after memory accessing.

Bit position	Value	Description	
[9:0]	0H-3FFH	Upper boundary	
[12:10]	000	Step size = + 2	
	001	Step size = - 2	
	010–111	Reserved	
[15:13]	000	Maximum modulo size = 1024 (0H to 3FFH),	
		Modulo body = RPi[14:10]:0000000000 to RPi[14:10]:MCi[9:0]	
	001	Maximum modulo size = 8 (0H to 7H),	
		Modulo body = RPi[14:3]:000 to RPi[14:3]:MCi[2:0]	
	010	Maximum modulo size = 16 (0H to 0FH),	
		Modulo body = RPi[14:4]:0000 to RPi[14:4]:MCi[3:0]	
	011	Maximum modulo size = 32 (0H to 1FH),	
		Modulo body = RPi[14:5]:00000 to RPi[14:5]:MCi[4:0]	
	100	Maximum modulo size = 64 (0H to 3FH),	
		Modulo body = RPi[14:6]:000000 to RPi[14:6]:MCi[5:0]	
	101	Maximum modulo size = 128 (0H to 7FH),	
		Modulo body = RPi[14:7]:0000000 to RPi[14:7]:MCi[6:0]	
	110	Maximum modulo size = 256 (0H to 0FFH),	
		Modulo body = RPi[14:8]:00000000 to RPi[14:8]:MCi[7:0]	
	111	Maximum modulo size = 512 (0H to 1FFH),	
		Modulo body = RPi[14:9]:000000000 to RPi[14:9]:MCi[8:0]	



COMPUTATION UNIT

The computation unit contains two main units, the Multiplier and Accumulator Unit (MAU) and Arithmetic Unit (AU).

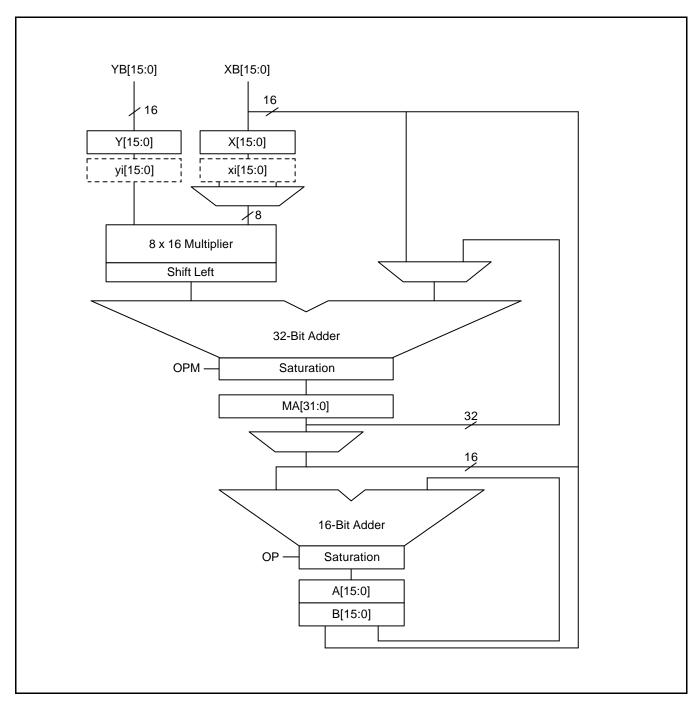


Figure 21-4. Computation Unit Block Diagram

Multiplier and Accumulator Unit (MAU)

The MAU consists of a 8 by 16 to 24 bit parallel multiplier, two 16-bit input registers(X and Y), a product output shifter, and 32-bit product and accumulator register(MA). The multiplier performs signed by signed, signed by unsigned, unsigned by signed, or unsigned by unsigned multiplication. By clearing "MSR1[2] (or M816)", the MAU can perform 16 by 16 to 32 bit parallel multiplication in 2 cycles. After the multiplier instruction, if a read instruction of MA is followed, previous MA register value will be read out because. During 16 by 16 multiplication, in the second cycle of multiplication, the instruction of MA modification can cause illegal multiplication results. Thus, multiplier instruction should not be followed by MA register writing. The "MV" flag is set if arithmetic overflow occurs after an arithmetic operation in the MA register, and if set "OPM", the MA register is saturated to a 32-bit positive (7FFFFFFH) or negative (80000000H). The MA register is not updated by loading X and Y registers. Hence, the X and Y registers can be used as a temporary data registers. The registers in MAU are as shown in the table.

Mnemonics	Description	Reset Value
X	MAU X input register	Unknown
Υ	MAU Y input register	Unknown
MAL	MAU Accumulator register, MA[15:0]	Unknown
MAH or MA	MAU Accumulator register, MA[31:16]	Unknown

Arithmetic Unit (AU)

The AU consists of 16-bit adder, 1-bit shifter, and two result registers (A and B). The AU receives one operand from Ai and another operand from XB or Ai. Operations between the two Ai registers are also possible. The source and destination Ai register of an AU instruction are always the same. The XB bus is used for transferring one of the register content, an immediate operand, or the content of a data memory location as a source operand. The AU results are stored in one of the Ai registers. The AU can perform add, subtract, compare, and shift operations. It uses two's complement arithmetic operations. The AU evaluates the status flags of an arithmetic result. The "V" flag is set if arithmetic overflow occurs after an arithmetic operation in A or B register, and if set to "OPA" or "OPB", the A or B register is saturated to a 16-bit positive (7FFFH) or negative (8000H). Data transfer between MAC816 and the host processor can be achieved via A or B register. The host processor (CalmRISC) can directly access A and B registers of MAC816 through "CLD GPR,imm" or "CLD imm,GPR" instruction.



STATUS REGISTERS

Status Register 0: MSR0

MSR0 is mainly reserved for flagging an AU result, for protecting control overflow, and for indicating test results.

Bit Name	Bit	Description
С	0	Carry flag
V	1	Overflow flag
Z	2	Zero flag
N	3	Negative flag
Т	4	Test result flag
OPA	5	Overflow Protection control for A register
ОРВ	6	Overflow Protection control for B register
_	15–7	Reserved

MSR0[0] (or C) is the carry of AU executions. MSR0[1] (or V) is the overflow flag of AU executions. It is set to 1 if and only if the carry-in into the 16-th bit position of addition/subtraction differs from the carry-out from the 16-th bit position. MSR0[2] (or Z) is the zero flag, which is set to 1 if and only if the AU result is zero. MSR0[3] (or N) is the negative flag. Basically, the most significant bit (MSB) of AU results becomes the N flag. However, if an AU instruction touches the overflow flag (V) like ADD, SUB, CP, *etc*, N flag is updated as exclusive-OR of V and the MSB of the AU result. This implies that even if an AU operation results in overflow, N flag is still valid. T flag is set to 1 if the result of "ETST *cond*." Instruction is true. MSR0[5] (or OPA) or MSR0[6] (or OPB) enables arithmetic saturation when an arithmetic overflow occurs in A or B register.

Status Register 1: MSR1

MSR1 consists of status flags of MAU operation, control bit for MAU, and selection bits of EC[I].

Bit Name	Bit	Description
PSH1	0	Multiplier product 1 bit shift control
ОРМ	1	Overflow Protection control for MA register
M816	2	Multiplication mode control
MV	3	MA overflow flag
SEC0	7–4	EC[0] selection
SEC1	11–8	EC[1] selection
SEC2	15–12	EC[2] selection

MSR1[0] (or PSH1) enables the product to shift by one bit to the left. MSR1[1] (or OPM) controls MA saturation. MSR1[2] (or M816) selects the operating mode for the multiplier. If M816=1, then the multiplier performs 8 by 16 bit to 24 bit multiplication. Otherwise (M816=0), the multiplier performs 16 by 16 bit to 32 bit multiplication in two cycles. MSR1[3] (or MV) is the overflow flag of MAU executions. It is set to 1 if an arithmetic overflow (32-bit overflow) occurs after an arithmetic operation in MAU. It is cleared by a processor reset or "ECR MV" and modified by writing to MSR1. SECi selects the combination of EC[I]. The flag information for the host processor is selected by setting SECi.

Value(of SECi)	Description
0000	EC[I] = Z, Set to 1 if Z flag is 1.
0001	EC[I] = not Z
0010	EC[I] = N
0011	EC[I] = not N
0100	EC[I] = C
0101	EC[I] = not C
0110	EC[I] = V
0111	EC[I] = not V
1000	EC[I] = T
1001	EC[I] = GT
1010	EC[I] = LE
1011	EC[I] = MV
1100	EC[I] = not MV
1101–1111	reserved



HOST INTERFACE

MAC816 is interfaced to the host processor according to CalmRISC coprocessor interface scheme explained below.

CalmRISC supports an efficient and seamless interface with coprocessors. By integrating a MAC (multiply and accumulate) with the CalmRISC core, not only microcontroller functions but also complex digital signal processing algorithms can be implemented in a single development platform (or MDS). CalmRISC has a set of dedicated signal pins, through which data/command/status are exchanged between CalmRISC and a coprocessor. Depicted below are the coprocessor signal pins and a figure of how two processors are interfaced.

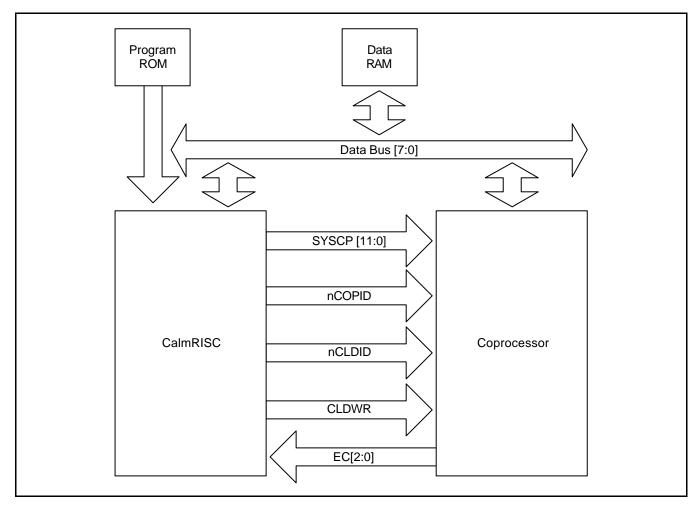


Figure 21-5. Coprocessor Interface Diagram

As shown in the coprocessor interface diagram above, the coprocessor interface signals of CalmRISC are: SYSCP[11:0], nCOPID, nCLDID, nCLDWR, and EC[2:0]. The data are exchanged through the data buses, DI[7:0] and DO[7:0]. CalmRISC issues the command to a coprocessor through SYSCP[11:0] in COP instructions. The status of a coprocessor can be sent back to CalmRISC through EC[2:0], and these flags can be checked in the condition codes of branch instructions. The coprocessor instructions are listed in the following table.

Mnemonic	Op 1	Op 2	Description
COP	#imm:12	Ī	Coprocessor operation
CLD	GPR	imm:8	Data transfer from coprocessor into GPR
CLD	imm:8	GPR	Data transfer of GPR to coprocessor
JP(or JR)	EC2-0	label	Conditional branch with coprocessor status flags
CALL			
LNK			

Table 21-3. Coprocessor instructions

The coprocessor of CalmRISC does not have its own program memory (that is, passive coprocessor) as shown in Figure 7 -1. In fact, the coprocessor instructions are fetched and decoded by CalmRISC, which issues the command to the coprocessor through the interface signals. For example, if "COP #imm:12" instruction is fetched, then the 12-bit immediate value (imm:12) is loaded on \$\textit{SYSCP[11:0]}\$ signal with \$nCOPID\$ active in ID/MEM stage, to request the coprocessor to perform the designated operation. The interpretation of the 12-bit immediate value is totally up to the coprocessor. The instruction set of the coprocessor is determined by arranging the 12 bit immediate field. In other words, CalmRISC only provides a set of generic coprocessor instructions, and its installation to a specific coprocessor instruction set can differ from one coprocessor to another. CLD Write instructions

("CLD imm:8, GPR") put the content of a GPR register of CalmRISC on the data bus \$(DO[7:0])\$ and issue the address(imm:8) of the coprocessor internal register on \$\textit{SYSCP[7:0]}\$ with \$nCLDID\$ active and \$CLDWR\$ active.

CLD Read instructions ("CLD GPR, imm:8" in Table 1) work similarly, except that the content of the coprocessor internal register addressed by the 8-bit immediate value is read into a GPR register through \$DI[7:0]\$ with \$nCLDID\$ active and \$CLDWR\$ inactive.

The timing diagram given below is a coprocessor instruction pipeline and shows the time the coprocessor performs the required operations. Suppose I_2 is a coprocessor instruction. First, it is fetched and decoded by CalmRISC (at t = T(i-1)). Once it is identified as a coprocessor instruction, CalmRISC indicates to the coprocessor the appropriate command through the coprocessor interface signals (at t = T(i)). Then the coprocessor performs the designated tasks at t = T(i) and t = T(i+1). Hence IF from CalmRISC and then ID/MEM and EX from the coprocessor constitute the pipeline for I_2 . Similarly, if I_3 is a coprocessor instruction, the coprocessor's ID/MEM and EX stages replace the corresponding stages of CalmRISC.



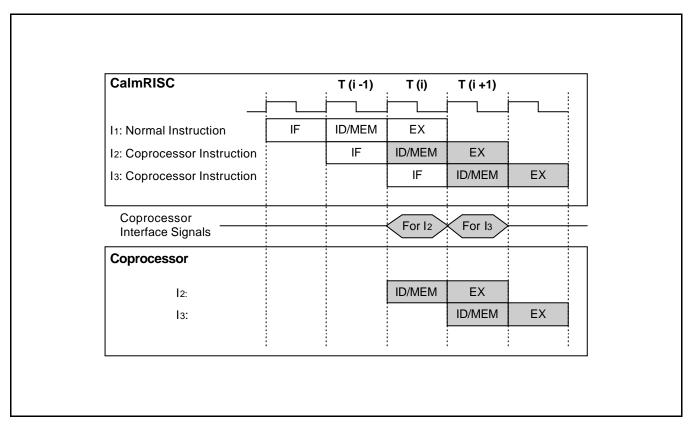


Figure 21-6. Coprocessor Instruction Pipeline

In a multi-processor system, the data transfer between processors is an important factor to determine the efficiency of the overall system. Suppose an input data stream is accepted by a processor, in order to share data with other processors, there should be some efficient mechanism to transfer the data to the processors. In CalmRISC, data is transferred through a single shared data memory. The shared data memory in a multi-processor has some inherent problems such as data hazards and deadlocks. However, the coprocessor in CalmRISC accesses the shared data memory only at the time designated by CalmRISC, a time at which CalmRISC is guaranteed not to access the data memory, and therefore there is no contention over the shared data memory. Another advantage of the proposed scheme is that the coprocessor can access the data memory in its own bandwidth.

INSTRUCTION SET

GLOSSARY

This chapter describes the MAC816 instruction set, and the details of each instruction are listed in alphabetical order . The following notations are used for the description and mnemonics of assembler.

Table 21-4. Notation and Convention

Notation	Interpretation
<opn></opn>	Operand N. N can be omitted if there is only one operand. Typically, <op1> is the destination (and source) operand and <op2> is the source operand.</op2></op1>
adr:N	Content of memory location specified by N-bit address
#imm:N	N-bit immediate number
&	Bit-wise AND
	Bit-wise OR
~	Bit-wise NOT
٨	Bit-wise XOR
N**M	Mth power of N
(N) _M	M-based number N



Table 21-5. MAC816 Registers

Notation	Operand Code	Mnemonic	Descriptions
Mreg	0000-0010	_	Reserved
	0011	MARN	MA[31:16] + MA[15], MA higher word with round-off
	0100	Υ	Y[15:0], multiplier Y input register
	0101	Х	X[15:0], multiplier X input register
	0110	MAL	MA[15:0], multiplier accumulator lower 16-bits
	0111	MAH	MA[31:16], multiplier accumulator higher 16-bits
	1000	RP0	RP0[15:0], RAM pointer register 0
	1001	RP1	RP0[15:0], RAM pointer register 1
	1010	RP2	RP0[15:0], RAM pointer register 2
	1011	RPD	RAM pointer for short direct addressing
	1100	MC0	Modulo control register 0 for RP0/RP1
	1101	MC1	Modulo control register 1 for RP2
	1110	MSR0	MAC816 status register 0
	1111	MSR1	MAC816 status register 1
Ai	0	Α	A[15:0], AU result register A
	1	В	B[15:0], AU result register B
Am	00	Α	A[15:0], AU result register A
	01	В	B[15:0], AU result register B
	10	AC	A[15:0], AU result register A with Carry
	11	ВС	B[15:0], AU result register B with Carry
MAm	00	Α	A[15:0], AU result register A
	01	В	B[15:0], AU result register B
	10	MAL	MA[15:0], multiplier accumulator lower 16-bits
	11	MAH	MA[31:16], multiplier accumulator higher 16-bits

Table 21-5. MAC816 Registers (Continued)

Notation	Operand Code	Mnemonic	Descriptions
Mreg2	000–011	_	Reserved
Mreg2s	100	Υ	Y[15:0], multiplier Y input register
Mreg2d	101	X	X[15:0], multiplier X input register
	110	MAL	MA[15:0], multiplier accumulator lower 16-bits
	111	MAH	MA[31:16], multiplier accumulator higher 16-bits
Mreg1	00	RP0	RP0[15:0], RAM pointer register 0
	01	RP1	RP0[15:0], RAM pointer register 1
	10	RP2	RP0[15:0], RAM pointer register 2
	11	RPD	RAM pointer for short direct addressing
Mreg3	00	MC0	Modulo control register 0 for RP0/RP1
	01	MC1	Modulo control register 1 for RP2
	10	MSR0	MAC816 status register 0
	11	MSR1	MAC816 status register 1

Table 21-6. Data Transfer Registers

Notation	Register Address	Descriptions	
Creg	00	00 A[7:0], AU result register A lower 8-bits	
	01	A[15:8], AU result register A higher 8-bits	
	10	B[7:0], AU result register B lower 8-bits	
	11	B[15:8], AU result register B higher 8-bits	

Table 21-7. Memory Access Mode Information

Notation	Operand Code	Mnemonic	Descriptions
@rpm	0000	@rp0+	Content of memory location specified by RP0, RP0 post-increment by 1 with modulo mode
	0001	@rp0-	Content of memory location specified by RP0, RP0 post-decrement by 1 with modulo mode
	0010	@rp0s	Content of memory location specified by RP0, RP0 post-modification by +2 or -2 with modulo mode
	0011	@rp0	Content of memory location specified by RP0
	0100	@rp1+	Content of memory location specified by RP1, RP1 post-increment by 1 with modulo mode
	0101	@rp1-	Content of memory location specified by RP1, RP1 post-decrement by 1 with modulo mode
	0110	@rp1s	Content of memory location specified by RP1, RP1 post-modification by +2 or -2 with modulo mode
	0111	@rp1	Content of memory location specified by RP1
	1000	@rp2+	Content of memory location specified by RP2, RP2 post-increment by 1 with modulo mode
	1001	@rp2-	Content of memory location specified by RP2, RP2 post-decrement by 1 with modulo mode
	1010	@rp2s	Content of memory location specified by RP2, RP2 post-modification by +2 or -2 with modulo mode
	1011	@rp2	Content of memory location specified by RP2
	1100–1111	-	Reserved
@rp0m	00	@rp0+	Content of memory location specified by RP0, RP0 post-increment by 1 with modulo mode
	01	@rp0-	Content of memory location specified by RP0, RP0 post-decrement by 1 with modulo mode
	10	@rp0s	Content of memory location specified by RP0, RP0 post-modification by +2 or -2 with modulo mode
	11	@rp0	Content of memory location specified by RP0
@rp2m	00	@rp2+	Content of memory location specified by RP2, RP2 post-increment by 1 with modulo mode
	01	@rp2-	Content of memory location specified by RP2, RP2 post-decrement by 1 with modulo mode
	10	@rp2s	Content of memory location specified by RP2, RP2 post-modification by +2 or -2 with modulo mode
	11	@rp2	Content of memory location specified by RP2



Table 21-8. Condition Code Information

Notation	Operand Code	Mnemonic	Descriptions
СС	0000	Z	Z = 1
	0001	NZ	Z = 0
	0010	С	C = 1
	0011	NC	C = 0
	0100	NEG	N = 1
	0101	POS	N = 0
	0110	V1	V = 1
	0111	V0	V = 0
	1000	_	Reserved
	1001	GT	N = 0 and Z = 0
	1010	LE	N = 1 and Z = 1
	1011	MV1	MV = 1
	1100	MV0	MV = 0
	1101–1111	_	Reserved

Table 21-9. Control Bit Code Information

Notation	Operand Code	Mnemonic	Descriptions
bs	000	ОРМ	MSR1[1]
	001	PSH1	MSR1[0]
	010	ME0	RP0[15], RP0 modulo mode enable
	011	ME1	RP1[15], RP1 modulo mode enable
	100	M816	MSR1[2]
	101	ME2	RP2[15], RP2 modulo mode enable
	110	OPA	MSR0[5]
	111	ОРВ	MSR0[6]

Table 21-10. AU operation code information

Notation	Operand Code	Mnemonic	Descriptions
EMOD0	00	ELD/ELDT	Load
	01	EADD/EADDT	Addition
	10	ESUB/ESUBT	Subtraction
	11	ECP/ECPT	Comparison
EMOD1	0000	ERR/ERRT	Rotate right
	0001	ERL/ERLT	Rotate left
	0010	ESR/ESRT	Arithmetic shift right
	0011	ESL/ESLT	Arithmetic shift left
	0100	EINC/EINCT	Increment
	0101	EDEC/EDECT	Decrement
	0110	ENEG/ENEGT	Negation
	0111	ECR/ECRT	Clear
	1000	ENORM/ENORMT	Normalization
	1001	EABS/EABST	Absolution
	1010–1111	-	reserved

Table 21-11. Others

Notation	Operand Code	Mnemonic	Descriptions
sXsY	00	uu	Unsigned by unsigned multiplication
	01	us	Unsigned by signed multiplication
	10	su	Signed by unsigned multiplication
	11	none	Signed by signed multiplication
rs	0	ER	Reset
	1	ES	Set
ts	0	ELD/ EMOD1/ EMOD0	Execute mnemonic always
	1	ELDT/ EMOD1T/ EMOD0T	Execute mnemonic when test result flag (MSR0[4] or T) is set. If T = 0, act as nop.

INSTRUCTION ENCODING

Table 21-12. Instruction Encoding

Instruction	11	10	9	8	7	6	5	4	3	2	1	0	2 nd Word
ELD Mreg2,@rpm		0	0 00		0		Mreg2			rp	m		_
ELD @rpm,Mreg2					1								
ELD Mreg3,@rpm			0.	1	00		Mreg3						
ELD @rpm,Mreg3					0	1							
ELD Mreg1,adr:4					1	0	Mre	g1		adr[3:0]		
ELD adr:4,Mreg1					1	1	Mre	g1	1				
ESEC0 #imm:4			10	0	0	0	0	0		lmm	[3:0]		
ESEC0 #imm:4							0	1					
ESEC0 #imm:4							1	0					
ECR MV							1	1					
ELD Mreg2d,Mreg2s					01 Mreg2		/Ireg2	d Mreg2s					
EMOD0 A,#imm:5					1	EMO	DD0		lmm[4:0]				
ELD adr:6,MAm			1	1	adr[5:4]		MAm			adr[3:0]		
ELD MAm,adr:6	0	1	00	0			MA	١m					
EADD Am,adr:6			0	1			Aı	m					
ESUB Am,adr:6			10	0									
ECP Am,adr:6			1	1									
ELD Mreg,Am	1	0	00	0	0	0				Mr	eg		
ELD Am,Mreg					0	1							
ELD/ELDT @rpm,Am					1	ts				rp	m		
EMOD1/EMOD1T Am			01		0					EMO	DD1		
EMOD0/EMOD0T Am,MAm					1				MA	m	EMC	DD0	
EMOD0/EMOD0T Am,@rpm			1	EMO	OD0					rp	m		

Table 21-12. Instruction Encoding (Continued)

Instruction	11	10	9	8	7	6	5	4	3	2	1	0	2nd Word
ELD Mreg,#imm:16		1 00			Mreg			lmm[15:12]			lmm[11:0]		
EMOD0 Am,#imm:16			01		EMOD0 Am								
EMAD @rp0m,@rp2m,sXsY			10	0	0	0	rp()m	rp2	2m	sX	sY	_
EMSB @rp0m,@rp2m,sXsY					0	1							
EMUL @rp0m,@rp2m,sXsY					1	0							
EMUL Ai,@rp2m,sXsY					1	1	0	Ai					
EMUL X,@rp2m,sXsY							1	0					
EMUL @rp0mY,,sXsY							1	1	rp()m			
EMAD Ai,@rp2m,sXsY			1	1	0	0	0	Ai	rp2	2m			
EMAD X,@rp2m,sXsY							1	0					
EMAD @rp0m,Y,sXsY							1	1	rp()m			
EMSB Ai,@rp2m,sXsY					0	1	0	Ai	rp2	2m			
EMSB X,@rp2m,sXsY							1	0					
EMSB @rp0m,Y,sXsY							1	1	rp()m			
EMAD X,Y,sXsY					1	0	0	0	0	0			
EMSB X,Y,sXsY									0	1			
EMUL X,Y,sXsY									1	0			
ESR MA							0	1	0	0	x	Х	
ESL MA									0	1			
ERND MA									1	0			
ENOP							1		xxxxx				
ERPM rpm							00		rpm				
ER/ES bs					11		01		rs		bs		
ETST cc							1	0		С	С		
ELD RPDN,#imm:4							1	1		lmm	[3:0]		

NOTE: "X" means not applicable.

QUICK REFERENCE

Table 21-13. Quick Reference

Operation	Operand1	Operand2	Function	Flag
ELD EADD ESUB ECP	А	#imm:5	op1 ← op2 op1 ← op1 + op2 op1 ← op1 - op2 op1 - op2	– c.z,v,n c,z,v,n c,z,v,n
ELD	RPDN	#imm:4	RPD[7:4] ← op2	
ELD	Adr:6	Am/MAm	op1 ← op2	
ELD	Am/MAm	Adr:6	op1 ← op2	
EADD ESUB ECP	Am	Adr:6	op1 ← op1 + op2 op1 ← op1 - op2 op1 - op2	c.z,v,n c,z,v,n c,z,v,n
ELD	Mreg1	Adr:4	op1 ← op2	_
ELD	Adr:4	Mreg1	op1 ← op2	-
ELD	Am	Mreg	op1 ← op2	_
ELD	mreg	Am	op1 ← op2	_
ELD	Mreg2d	Mreg2s	op1 ← op2	_
ELD	Mreg2	@rpm	op1 ← op2	_
ELD	@rpm	Mreg2	op1 ← op2	_
ELD EADD ESUB ECP ELDT EADDT ESUBT ECPT	Am	MAm	$\begin{array}{l} \text{op1} \leftarrow \text{op2} \\ \text{op1} \leftarrow \text{op1} + \text{op2} \\ \text{op1} \leftarrow \text{op1} - \text{op2} \\ \text{op1} - \text{op2} \\ \text{op1} - \text{op2} \\ \text{If T=1, same as ELD} \\ \text{If T=1, same as EADD} \\ \text{If T=1, same as ESUB} \\ \text{If T=1, same as ECP} \\ \end{array}$	- c.z,v,n c,z,v,n - c.z,v,n c,z,v,n c,z,v,n
ELD ELDT	@rpm	Am	op1 ← op2 If T=1, same as ELD	_
ELD EADD ESUB ECP ELDT EADDT ESUBT ECPT	Am	@rpm	op1 ← op2 op1 ← op1 + op2 op1 ← op1 - op2 op1 - op2 op1 - op2 If T=1, same as ELD If T=1, same as EADD If T=1, same as ESUB If T=1, same as ECP	- c.z,v,n c,z,v,n c,z,v,n - c.z,v,n c,z,v,n



Table 21-13. Quick Reference (Continued)

Operation	Operand1	Operand2	Function	Flag
ETST	СС	_	MSR0[4] ← cc (condition check)	_
ELD	mreg	#imm:16	op1 ← op2	_
ELD EADD ESUB ECP	А	#imm:16	op1 ← op2 op1 ← op1 + op2 op1 ← op1 - op2 op1 - op2	– C.Z,V,N C,Z,V,N C,Z,V,N
ERPM	rpm	_	RP ← modified RP	-
ER	bs	_	op1 ← 0	_
ES	bs	_	op1 ← 10	_
ESEC0 ESEC1 ESEC2	MSR1	#imm:4	$\begin{array}{l} MSR1[7:4] \leftarrow imm[3:0] \\ MSR1[11:8] \leftarrow imm[3:0] \\ MSR1[15:12] \leftarrow imm[3:0] \end{array}$	_
ERR ERRT	Am	_	when Am!=AC/BC, op \leftarrow {op1}>>1, op1[15] \leftarrow op1[0], c \leftarrow op1[0] when Am=AC/BC, op1 \leftarrow {c:op1}>>1, c \leftarrow op1[0]	c,z,v,n
ERL	Am	_	when t=1, same as ERR when Am!=AC/BC, op \leftarrow {op1}<<1, op1[0] \leftarrow op[15], c \leftarrow op[15], when Am=AC/BC, op1 \leftarrow {op1:c}<<1, c \leftarrow op[15]	c,z,v,n
ERLT			when t=1, same as ERL	c,z,v,n
ESR	Am	_	when Am!=AC/BC, op \leftarrow {op1}>>1, c \leftarrow op1[0] when Am=AC/BC, op1 \leftarrow {c:op1}>>1, c \leftarrow op1[0]	c,z,v,n
ESRT			when t=1, same as ESR	c,z,v,n
ESL	Am	_	when Am!=AC/BC, op1 \leftarrow {op1}<<1, op1[0] \leftarrow 0, c \leftarrow op[15], when Am=AC/BC, op1 \leftarrow {op1:c}<<1, c \leftarrow op[15]	c,z,v,n
EINC	Am	_	when t=1, same as ESL when Am!=AC/BC, op1 ← op1+1	C,Z,V,N
EINCT	AIII	_	when Am=AC/BC, op1 ← op1+c when t=1, same as EINC	c,z,v,n
EDEC	Am	-	when Am!=AC/BC, op1 ← op1+ffffh when Am=AC/BC, op1 ← op1+ffffh+c	c,z,v,n
EDECT			when t=1, same as EDEC	c,z,v,n
ENEG	Am	_	when Am!=AC/BC, op1 \leftarrow ~op1+1 when Am=AC/BC, op1 \leftarrow ~op1+c	c,z,v,n
ENEGT			when t=1, same as ENEG	c,z,v,n
EABS EABST	Am	_	when Am!=AC/BC, if op[15]=1, op1 \leftarrow ~op1+1 when Am=AC/BC, op[15]=1, op1 \leftarrow ~op1+c when t=1, same as EABS	c,z,v,n
ENORM ENORMT	Am	-	when Am!=AC/BC, if op1[15]^op1[14]=0, op1 \leftarrow {op1}<<1, op1[0] \leftarrow 0, RP0 \leftarrow RP0+1 when Am=AC/BC, if op1[15]^op1[14]=0, op1 \leftarrow {op1:c}<<1, RP0 \leftarrow RP0+1 when t=1, same as ENORMT	c,z,v,n c,z,v,n
ECR ECRT	Am	_	op1 \leftarrow 0 when t=1, same as ECR	_

Table 21-13. Quick Reference (Concluded)

Operation	Operand1	Operand2	Operand3	Function	Flag
ESR	MA	-	-	op1 ← op1>>1	_
ESL	MA	-	-	op1 ← op1<<1	MV
ERND	MA	-	-	MA[31:16] ← MA[31:16] + MA[15]	MV
EMAD	MA	@rp0m	@rp2m	X-reg ← @rp0m, Y-reg ← @rp2m,	MV
				$MA \leftarrow MA + X^*Y$	
EMSB	MA	@rp0m	@rp2m	X-reg ← @rp0m, Y-reg ← @rp2m,	MV
				MA ← MA-X*Y	
EMUL	MA	@rp0m	@rp2m	X-reg ← @rp0m, Y-reg ← @rp2m,	_
				$MA \leftarrow (X^*Y)$	
EMAD	MA	Ai	@rp2m	X-reg ← op2, Y-reg ← @rp2m,	MV
				$MA \leftarrow MA + X^*Y$	
EMSB	MA	Ai	@rp2m	X-reg ← op2, Y-reg ← @rp2m,	MV
				$MA \leftarrow MA-X*Y$	
EMUL	MA	Ai	@rp2m	X-reg ← op2, Y-reg ← @rp2m,	-
				$MA \leftarrow (X^*Y)$	
EMAD	MA	Х	@rp2m	Y-reg ← @rp2m,	MV
				MA ← MA+X*Y	
EMSB	MA	Х	@rp2m	Y-reg ← @rp2m,	MV
				MA ← MA-X*Y	
EMUL	MA	Х	@rp2m	Y-reg ← @rp2m,	_
				$MA \leftarrow (X^*Y)$	
EMAD	MA	@rp0m	Υ	X-reg ← @rp0m,	MV
				MA ← MA+X*Y	
EMSB	MA	@rp0m	Υ	X-reg ← @rp0m,	MV
				MA ← MA-X*Y	
EMUL	MA	@rp0m	Υ	X-reg ← @rp0m,	_
				$MA \leftarrow (X^*Y)$	
EMAD	MA	Х	Υ	MA ← MA+X*Y	MV
EMSB	MA	Х	Υ	MA ← MA-X*Y	MV
EMUL	MA	Х	Υ	$MA \leftarrow (X^*Y)$	-

MAC816 INSTRUCTION DESCRIPTION

EABS — Absolute

Format: EABS <op>

<op>: Am

Operation: If the MSB of $\langle op \rangle$ is 1, $\langle op \rangle \leftarrow \langle op \rangle +1$ when $\langle op \rangle$ is A or B.

If the MSB of $\langle op \rangle$ is 1, $\langle op \rangle \leftarrow \langle op \rangle + C$ when $\langle op \rangle$ is AC or BC.

EABS adds the values 0 and the 2's complement of <op>.

Flags: C: set if the borrow of result is zero. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.N: exclusive OR of V and MSB of result.

EABST — Absolute conditional

Format: EABST <op>

<op>: Am

Operation: If T=1, then same as EABS, else no operation

Flags: If T=1, then same as EABS, else no operation



EADD — Add

Format: EADD <op1>, <op2>

<op1>: Am: A, B, AC, BC

<op2>: adr:6, @rpm, Ai, Mreg, #imm:16, #imm:5

Operation: $\langle op1 \rangle \leftarrow \langle op1 + \langle op2 \rangle$ when $\langle op1 \rangle$ is A or B.

 $\langle op1 \rangle \leftarrow \langle op1 + \langle op2 \rangle + C$ when $\langle op1 \rangle$ is AC or BC.

EADD adds the values in <op1> and <op2> and stores the result in <op1>.

Flags: C: set if the carry of result is 1. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.N: exclusive OR of V and MSB of result.

NOTE: If <op1> is B, <op2> can not be #imm:5.

EADDT — Add conditional

Format: EADDT <op1>, <op2>

<op1>: Am: A, B, AC, BC
<op2>: @rpm, Ai, MAH,MAL

Operation: If T=1, then same as EADD, else no operation

Flags: If T=1, then same as EADD, else no operation



${\sf ECP}-{\sf Compare}$

Format: ECP <op1>, <op2>

<op1>: Am

<op2>: adr:6, @rpm, Ai, Mreg, #imm:16, #imm:5

Operation: $\langle op1 \rangle + \langle op2 \rangle + 1$ when $\langle op1 \rangle$ is A or B.

 $<op1> + \sim <op2> +C$ when <op1> is AC or BC.

ECP compares the values of <op1> and <op2> by subtracting <op2> from <op1>.

Contents of <pp1> and <pp2> are not changed.

Flags: C: set if the borrow of result is zero. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.
N: exclusive OR of V and MSB of result.

NOTE: If <op1> is B, <op2> can not be #imm:5.

ECPT — Compare conditional

Format: ECPT <op1>, <op2>

<op1>: Am: A, B, AC, BC
<op2>: @rpm, Ai, MAH,MAL

Operation: If T=1, then same as ECP, else no operation

Flags: If T=1, then same as ECP, else no operation



ECR — Clear

Format: ECRT <op>

<op>: Ai, MV

Operation: $\langle op \rangle \leftarrow 0$

ECRT clears Ai or MV.

ECRT — Clear

Format: ECRT <op>

<op>: Ai

Operation: If T=1, $<op> \leftarrow 0$

ECRT clears Ai when T=1.



EDEC — Decrement

Format: EDEC <op>

<op>: Am

Operation: $\langle op \rangle \leftarrow \langle op \rangle + 0xffff \text{ when } \langle op \rangle \text{ is A or B.}$

<op> \leftarrow <op> + 0xffff + C when <op> is AC or BC.

EDEC decrements the value in <op>.

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.N: exclusive OR of V and MSB of result.

EDECT — Decrement conditional

Format: EDECT <op>

<op>: Am

Operation: If T=1, then same as EDEC, else no operation

Flags: If T=1, then same as EDEC, else no operation



EINC — Increment

Format: EINC <op>

<op>: Am

Operation: $\langle op \rangle \leftarrow \langle op \rangle + 1$ when $\langle op \rangle$ is A or B.

<op> \leftarrow <op> + C when <op> is AC or BC.

EINC increments the value in <op>.

Flags: C: set if carry is generated. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.N: exclusive OR of V and MSB of result.

EINCT — Increment conditional

Format: EINCT <op>

<op>: Am

Operation: If T=1, then same as EINC, else no operation

Flags: If T=1, then same as EINC, else no operation



ELD Adr — Load Adr

Format: ELD <op1>, <op2>

<op1>,<op2>: adr:6, MAi / adr:4,Mreg1

Operation: $< op1 > \leftarrow < op2 >$

ELD Adr loads a value specified by <pp2> into the memory location determined by <pp1>

ELD Ai - Load Ai

Format: ELD <op1>, <op2>

<op1>: Ai: A, B

<op2>: adr:6, @rpm, Ai, Mreg, #imm:5, #imm:16

Operation: Ai \leftarrow <op2>

ELD Ai loads a value specified by <pp2> into the register designated by Ai.

NOTE: If <op1> is B, <op2> can not be #imm:5.



ELD Mreg — Load Mreg

Format: ELD <op1>, <op2>

<op1>: Mreg
<op2>: Ai

Operation: Mreg \leftarrow Ai

ELD Mreg loads a value specified by <pp2> into the register designated by Mreg.

ELD Mreg1 — Load Mreg1

Format: ELD <op1>, <op2>

<op1>: Mreg1: RP0, RP1, RP2, RPD

<op2>: adr:4

Operation: Mreg1 \leftarrow adr:4

ELD Mreg1 loads the content of memory location determined by adr:4 into the register

designated by Mreg1.



ELD Mreg2 — Load Mreg2

Format: ELD <op1>, <op2>

<op1>: Mreg2: X, Y, MAH, MAL

<op2>: @rpm

Operation: $Mreg2 \leftarrow @rpm, rpi \leftarrow post-modified rpi$

ELD Mreg2 loads the content of memory location determined by @rpm into the register

designated by Mreg2.

ELD Mreg3 — Load Mreg3

Format: ELD <op1>, <op2>

<op1>: Mreg3: MC0, MC1, MSR0, MSR1

<op2>: @rpm

Operation: Mreg3 \leftarrow @rpm

ELD Mreg3 loads the content of memory location determined by @rpm into the register

designated by Mreg3.



ELD @ rpm - Load into memory indexed

Format: ELD <op1>, <op2>

<op1>: @rpm

<op2>: Ai, Mreg2, Mreg3

Operation: @rpm \leftarrow <op2>, rpi \leftarrow post-modified rpi

ELD @rpm loads the value of <op2> into the memory location determined by @rpm.

$\pmb{EMAD} - \text{Multiplication and Addition}$

Format: EMAD <p1>, <p2>,sXsY

<op1>,<op2>: @rp0m,@rp2m / Ai,@rp2m / X,@rp2m / @rp0m,Y / X,Y

Operation: $X \leftarrow \text{-op1>}, Y \leftarrow \text{-op2>}, MA \leftarrow MA + \{\text{sign}, X\}^* \{\text{sign}, Y\}$

EMAD multiplies the values in <op1> and <op2> and adds the result in MA.

Flags: MV: Set if the arithmetic overflow occurs in MA after this instruction.

EMSB = Multiplication and Subtraction

Format: EMSB <op1>, <op2>,sXsY

 $<\!op1>, <\!op2>: @rp0m, @rp2m / Ai, @rp2m / X, @rp2m / @rp0m, Y / X, Y$

 $\textbf{Operation:} \hspace{0.5cm} X \leftarrow <op1>, \ Y \leftarrow <op2>, \ MA \leftarrow MA - \{sign,X\}^* \{sign,Y\}$

EMAD multiplies the values in <op1> and <op2> together and subtracts the result in MA.

Flags: MV: Set if the arithmetic overflow occurs in MA after this instruction.

$\pmb{\mathsf{EMUL}} = \mathsf{Multiply}$

Format: EMUL <pp1>, <pp2>,sXsY

<op1>,<op2>: @rp0m,@rp2m / Ai,@rp2m / X,@rp2m / @rp0m,Y / X,Y

EMUL multiplies the values in <op1> and <op2> and stores the result in MA.



ENEG — Negate

Format: ENEG <op>

<op>: Am

Operation: $\langle op \rangle \leftarrow \langle op \rangle +1$ when $\langle op \rangle$ is A or B.

<op> \leftarrow \sim <op> +C when <op> is AC or BC.

ESUB adds the values 0 and the 2's complement of <op> to to negate <op>.

Flags: C: set if the borrow of result is zero. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.N: exclusive OR of V and MSB of result.

$\pmb{\mathsf{ENEGT}} = \mathsf{Negate} \ \mathsf{conditional}$

Format: ENEGT <op>

<op>: Am

Operation: If T=1, then same as ENEG, else no operation

Flags: If T=1, then same as ENEG, else no operation



${\sf ENOP}-{\sf No}$ operation

Format: ENOP

Operation: No operation

Flags: No operation

${f ENORM}$ — Normalization step

Format: ENORM <op>

<op>: Am

Operation: If $\langle op \rangle [15] == \langle op \rangle [14]$, $\langle op \rangle \leftarrow \langle op \rangle \langle \langle 1, RP0 \leftarrow RP0+1 \text{ when } \langle op \rangle \text{ is A or B.}$

If $\langle op \rangle$ [15] == $\langle op \rangle$ [14], $\langle op \rangle \leftarrow \{\langle op \rangle, C\} \langle \langle 1, RP0 \leftarrow RP0 + 1 \text{ when } \langle op \rangle \text{ is AC or BC.}$

Flags: **C**: <op>[15] ^ <op>[14]

Z: set if result is zero. Reset if not

V: reset to zero.

N: set if the MSB of result is 1. Reset if not



ENORMT - Normalization step conditional

Format: ENORMT <op>

<op>: Am

Operation: If T=1, then same as ENORM, else no operation

Flags: If T=1, then same as ENORM, else no operation

ER — Bit Reset

Format: ER bs

ES resets the specified bit.



ERL — Rotate Left

Format: ERL <op>

<op>: Am

Operation: $\langle op \rangle \leftarrow \{\langle op \rangle [14:0], \langle op \rangle [15]\}, C \leftarrow \langle op \rangle [15] \text{ when Am is A or B.}$

<op> ← ${<}$ op>[14:0],C ${}$, C ← ${<}$ op>[15] when Am is AC or BC.

ERL rotates the value of <op> to the left and stores the result back into <op>.

The original MSB of <op> is copied into carry (C).

Flags: C: set if the MSB of <op> (before shifting) is 1. Reset if not

Z: set if result is zero. Reset if not

V: reset to zero.

N: set if the MSB of result is 1. Reset if not

ERLT — Rotate Left conditional

Format: ERLT <op>

<op>: Am

Operation: If T=1, then same as ERL, else no operation

Flags: If T=1, then same as ERL, else no operation



ERND — Round off

Format: ERND MA

Operation: $MA[31:16] \leftarrow MA[31:16] + MA[15], MA[15:0] \leftarrow 0$

ERND adds 0x8000 to the lower 16-bit position of MA and stores the result in MA.

Flags: MV: set if overflow is generated. Reset if not

${\sf ERPM} - {\sf Modify Ram pointer}$

Format: ERPM rpm

Operation: $rpi \leftarrow modified rpi$

ERPM modifies a rpi by rpm.

NOTE: It does not generate a cycle of RAM access.



ERR — Rotate Right

Format: ERR <op>

<op>: Am

Operation: $\langle op \rangle \leftarrow \{\langle op \rangle [0], \langle op \rangle [15:1] \}$, $C \leftarrow \langle op \rangle [0]$ when Am is A or B.

<op> \leftarrow {C, <op>[15:1]}, C \leftarrow <op>[0] when Am is AC or BC.

RR rotates the value of <op> to the right and stores the result back into <op>.

The original LSB of <op> is copied into carry (C).

Flags: C: set if the LSB of (before shifting) is 1. Reset if not

Z: set if result is zero. Reset if not

V: reset to zero.

N: set if the MSB of result is 1. Reset if not

$\pmb{\mathsf{ERRT}} = \mathsf{Rotate}\,\mathsf{Right}\,\mathsf{conditional}$

Format: ERRT <op>

<op>: Am

Operation: If T=1, then same as ERR, else no operation

Flags: If T=1, then same as ERR, else no operation



${\sf ES}-{\sf Bit\,Set}$

Format: ES bs

Operation: bs $\leftarrow 1$

ES sets the specified bit.

ESEC0 / ESEC1 / ESEC2 — Set SECi

Format: ESEC0 #imm:4

ESEC1 #imm:4 ESEC2 #imm:4

Operation: ESEC0: SEC0[3:0] \leftarrow #imm:4

 $\begin{aligned} & \texttt{ESEC1: SEC1[3:0]} \leftarrow \texttt{\#imm:4} \\ & \texttt{ESEC2: SEC2[3:0]} \leftarrow \texttt{\#imm:4} \end{aligned}$



ESL — Shift Left

Format: ESL <op>

<op>:Am

Operation: $\langle op \rangle \leftarrow \{\langle op \rangle [14:0], 0\}, C \leftarrow \langle op \rangle [15] \text{ when } \langle op \rangle \text{ is A or B.}$

<op> \leftarrow $\{<$ op>[14:0],C $\}$, C \leftarrow <op>[15] when <op> is AC or BC.

ESL shifts to the left by 1 bit. The MSB of the original <op> is copied into carry(C).

Flags: C: set if the MSB of <op>(before shifting) is 1. Reset if not

Z: set if result is zero. Reset if not

V: set if overflow is generated. Reset if not.N: exclusive OR of V and MSB of result.

ESLT — Shift Left conditional

Format: ESLT <op>

<op>: Am

Operation: If T=1, then same as ESL, else no operation

Flags: If T=1, then same as ESL, else no operation



$\pmb{\mathsf{ESR}} = \mathsf{Shift}\,\mathsf{Right}$

Format: ESR <op>

<op>:Am

Operation: $\langle op \rangle \leftarrow \{\langle op \rangle [15], \langle op \rangle [15:1]\}, C \leftarrow \langle op \rangle [0] \text{ when } \langle op \rangle \text{ is A or B.}$

<op> \leftarrow {C,<op>[15:1]}, C \leftarrow <op>[0] when <op> is AC or BC.

ESR shifts to the right by 1 bit. The LSB of the original <op> is copied into carry(C).

Flags: C: set if the LSB of <op>(before shifting) is 1. Reset if not

Z: set if result is zero. Reset if not

V: set to zero

N: set if result is negative. Reset if not

$\pmb{\mathsf{ESRT}} = \mathsf{Shift} \, \mathsf{Right} \, \mathsf{conditional}$

Format: ESRT <op>

<op>: Am

Operation: If T=1, then same as ESR, else no operation

Flags: If T=1, then same as ESR, else no operation



ESUB — Subtract

Format: ESUB <op1>, <op2>

<op1>: Am

<op2>: adr:6, @rpm, Ai, Mreg, #imm:16, #imm:5

Operation: $\langle op1 \rangle \leftarrow \langle op1 \rangle + \langle op2 \rangle + 1$ when $\langle op1 \rangle$ is A or B.

 $\langle op1 \rangle \leftarrow \langle op1 \rangle + \langle op2 \rangle + C$ when $\langle op1 \rangle$ is AC or BC.

ESUB adds the values in <op1> and the 2's complement of <op2>,

to perform subtraction on <op1> and <op2>.

Flags: C: set if the borrow of result is zero. Reset if not.

Z: set if result is zero. Reset if not.

V: set if overflow is generated. Reset if not.
N: exclusive OR of V and MSB of result.

NOTE: If <op1> is B, <op2> can not be #imm:5.

ESUBT — Subtract conditional

Format: ESUBT <op1>, <op2>

<op1>: Am

<op2>: @rpm, Ai, MAH, MAL

Operation: If T=1, then same as ESUB, else no operation

Flags: If T=1, then same as ESUB, else no operation



ETST — Test Condition

Format: ETST cc

cc: Z, NZ, C, NC, NEG, POS, V1, V0, GT, LE, MV1, MV0

Operation: $T \leftarrow \text{test result}$

ETST tests the specified condition of a flag.

Flags: T: set if test result is true. Reset if not

NOTES



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OVERVIEW

Table 22-1. Absolute Maximum Ratings

 $(T_A = 25 \,^{\circ}C)$

Parameter	Symbol	Conditions	Rating	Unit
Supply voltage	V _{DD}	-	-0.3 to +6.5	V
Input voltage	V _I	-	-0.3 to V _{DD} + 0.3	V
Output voltage	Vo	-	-0.3 to V _{DD} + 0.3	V
Output current high	I _{OH}	One I/O pin active	-18	mA
		All I/O pins active	-60	
Output current low	I _{OL}	One I/O pin active	+ 30	mA
		Total pin current for port	+ 100	
Operating temperature	T _A	-	-25 to +85	°C
Storage temperature	T _{STG}	-	-65 to +150	°C

Table 22-2. D.C. Electrical Characteristics

 $(T_A = -25 \,^{\circ}C \text{ to } + 85 \,^{\circ}C, \, V_{DD} = 2.2 \, V \text{ to } 5.5 \, V)$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Operating voltage	V_{DD}	fxx = 8.2 MHz	3.0	_	5.5	V
		fxx = 4.1 MHz	2.2	-	5.5	
Input high voltage	V _{IH1}	All input pins except V _{IH2}	0.8 V _{DD}	_	V_{DD}	V
	V _{IH2}	X_{IN}, XT_{IN}	V _{DD} -0.1			
Input low voltage	V _{IL1}	All input pins except V _{IL2}	_	_	0.2 V _{DD}	V
	V _{IL2}	X _{IN} , XT _{IN}			0.1	

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Table 22-2. D.C. Electrical Characteristics (Continued)

 $(T_A = -25 \,^{\circ}\text{C to} + 85 \,^{\circ}\text{C}, \, V_{DD} = 2.2 \,^{\circ}\text{V to} \, 5.5 \,^{\circ}\text{V})$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Output high voltage	V _{OH1}	$V_{DD} = 5 \text{ V}; I_{OH} = -1 \text{ mA}$ All output pins except V_{OH2}	V _{DD} -1.0	-	I	V
	V _{OH2}	$V_{DD} = 5 \text{ V}; I_{OH} = -15 \text{ mA}$ Port 5	V _{DD} -1.0	-	-	
Output low voltage	V _{OL1}	V _{DD} = 4.5-5.5 V; I _{OL} = 15 mA	_	0.4	2	V
Input high leakage current	I _{LIH1}	$V_{IN} = V_{DD}$ All input pins except I_{LIH2}	-	-	3	μА
	I _{LIH2}	$V_{IN} = V_{DD}$ $X_{IN}, XT_{IN}, X_{OUT}, XT_{OUT}$			20	
Input low leakage current	I _{LIL1}	$V_{IN} = 0 V$ All input pins except I_{LIL2}	-	-	-3	
	I _{LIL2}	$V_{IN} = 0 V$ $X_{IN}, XT_{IN}, X_{OUT}, XT_{OUT}, nRESET$			-20	
Output high leakage current	I _{LOH}	V _{OUT} = V _{DD} All I/O pins and Output pins	_	_	3	
Output low leakage current	I _{LOL}	V _{OUT} = 0 V All I/O pins and Output pins	_	-	-3	
Pull-up resistor	R _{L1}	V_{IN} = 0 V; V_{DD} = 5 V ± 10% All port, T_A = 25 $^{\circ}$ C	30	50	70	kΩ
	R _{L2}	V_{IN} = 0 V; V_{DD} = 5 V ± 10% T_A = 25 °C, nRESET only	110	210	310	

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Table 22-2. D.C. Electrical Characteristics (Concluded)

(T_A = -25 $^{\circ}$ C to + 85 $^{\circ}$ C, V_{DD} = 2.2 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
V _{DD} -COMi	V_{DC}	$V_{DD} = 2.7 \text{ to } 5.5 \text{ V}$	-	-	120	mV
voltage drop (I=0-15)		-15 uA per common pin LCNST = 00000000b				
V _{DD} -SEGi	V _{DS}	$V_{DD} = 2.7$ to 5.5 V	_	_	120	mV
voltage drop (I=0-55)		-15 uA per segment pin LCNST = 00000000b				
LCD voltage dividing resistor	R _{LCD1}	$V_{LCD} = 2.7$ to 5.5 V; LCON.3 = 0	40	55	70	kΩ
	R _{LCD2}	$V_{LCD} = 2.7$ to 5.5 V; LCON.3 = 1	20	28	35	
Total contrast resistor	R _{CNST}	V _{LCD} = 2.7 to 5.5 V; LCNST = 10000000b	_	140	-	
VLC Output voltage	V _{LC1}	V _{LCD} = 2.7 to 5.5 V	V _{DD} -0.2	V_{DD}	V _{DD} +0.2	٧
	V _{LC2}	LCD clock = 0 Hz	0.8V _{DD} -0.2	0.8 V _{DD}	0.8V _{DD} +0.2	
	V _{LC3}	LCNST = 00000000b	0.6V _{DD} -0.2	0.6 V _{DD}	0.6V _{DD} +0.2	
	V _{LC4}		0.4V _{DD} -0.2	0.4 V _{DD}	0.4V _{DD} +0.2	
	V _{LC5}		0.2V _{DD} -0.2	0.2 V _{DD}	0.2V _{DD} +0.2	
Supply current (1)	I _{DD1}	Run mode; V _{DD} = 5 V ± 10%	_	4	8	mA
		6 MHz crystal oscillator				
		4 MHz crystal oscillator		2.7	5.4	
		V _{DD} = 3 V ± 10%	_	2	4	mΑ
		6 MHz crystal oscillator				
		4 MHz crystal oscillator		1.3	2.6	
	I _{DD2}	Idle mode: $V_{DD} = 5 V \pm 10 \%$	_	1.2	2.5	mA
		6 MHz crystal oscillator				
		4 MHz crystal oscillator		1.0	2.0	
		Idle mode: V _{DD} = 3 V± 10 %		0.5	1.5	mA
		6 MHz crystal oscillator				
		4 MHz crystal oscillator		0.4	1.0	
	I _{DD3}	Sub-run mode; V _{DD} = 3 V± 10 %	_	17	34	μΑ
		Main stop, 32 kHz sub-osc.				
	I _{DD4}	Sub-idle mode; V _{DD} = 3 V± 10 %	-	4.8	10	μΑ
		Main stop, 32 kHz				
	I _{DD5}	Stop mode; $V_{DD} = 5 V \pm 10 \%$,	_	0.2	3	μΑ
		$T_A = 25^{\circ}C$				
		$V_{DD} = 3 \text{ V} \pm 10 \text{ %}, T_{A} = 25^{\circ}\text{C}$		0.1	2	

NOTE: Supply current does not include current drawn through internal pull-up resistors or external output current loads and ADC, DAC, BLD, LCD voltage dividing resistor.



ELECTRICAL DATA S3CB519

Table 22-3. A.C. Electrical Characteristics

(T_A = -25 °C to + 85 °C, V_{DD} = 2.2 V to 5.5 V)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Interrupt input high, low width	t _{INTH} , t _{INTL}	P0, P1 V _{DD} = 5 V	-	200	-	ns
nRESET input low width	t _{RSL}	$V_{DD} = 5 V \pm 10 \%$	5	-	_	μs

NOTE: User must keep a larger value than the min value.

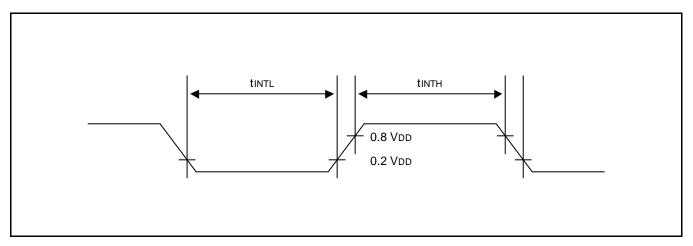


Figure 22-1. Input Timing for External Interrupts (Port 0, Port 1)

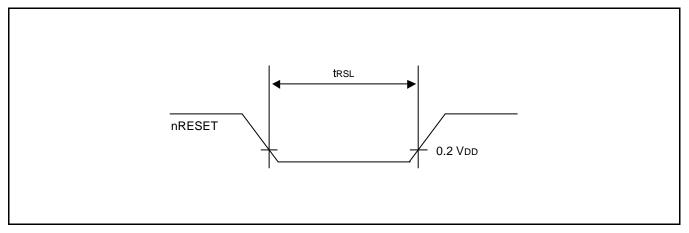


Figure 22-2. Input Timing for nRESET



S3CB519 ELECTRICAL DATA

Table 22-4. Data Retention Supply Voltage in Stop Mode

 $(T_A = -25 \, ^{\circ}C \text{ to + } 85 \, ^{\circ}C)$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Data retention supply voltage	V_{DDDR}	-	2.2	-	5.5	V
Data retention supply current	I _{DDDR}	V _{DDDR} = 2.2 V	I	_	2	μΑ

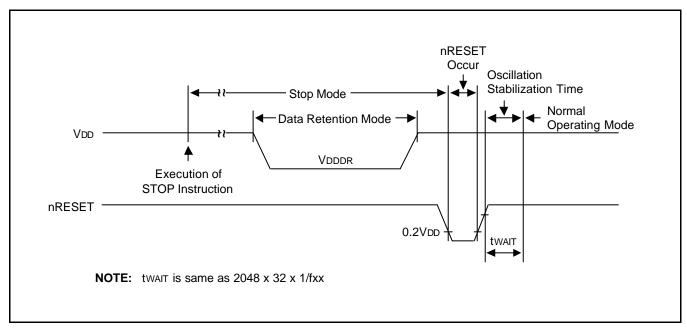


Figure 22-3. Stop Mode Release Timing When Initiated by a nRESET

ELECTRICAL DATA S3CB519

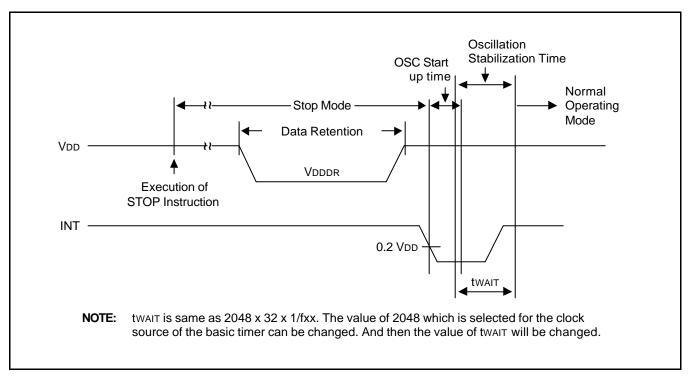


Figure 22-4. Stop Mode (Main) Release Timing Initiated by Interrupts

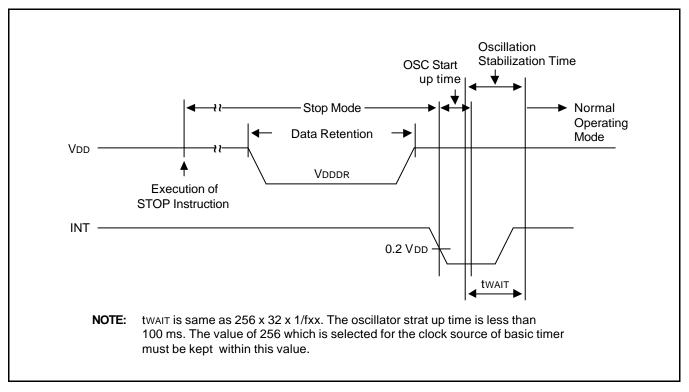


Figure 22-5. Stop Mode (Sub) Release Timing Initiated by Interrupts

S3CB519 ELECTRICAL DATA

Table 22-5. Synchronous SIO Electrical Characteristics

(T_A = -25 $^{\circ}$ C to + 85 $^{\circ}$ C, V_{DD} = 4.5 V to 5.5 V, V_{SS} = 0 V, fxx = 10 MHz oscillator)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
SCK Cycle time	t _{CYC}	-	200	_	_	ns
Serial Clock High Width	t _{SCKH}	_	60	_	-	
Serial Clock Low Width	t _{SCKL}	-	60	_	_	
Serial Output data delay time	t _{OD}	-	-	-	50	
Serial Input data setup time	t _{ID}	-	40	-	_	
Serial Input data Hold time	t _{IH}	-	100	-	_	

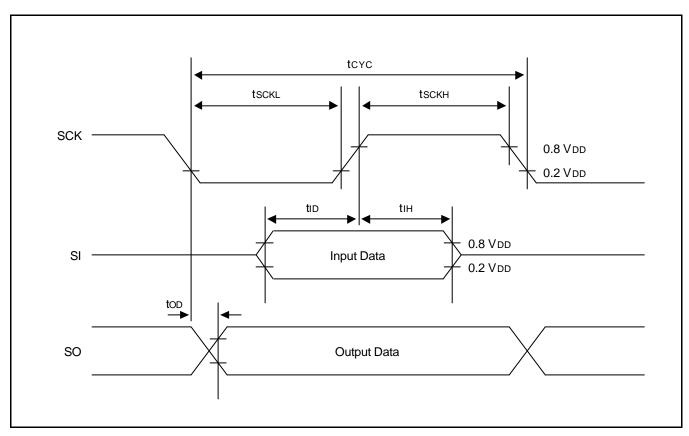


Figure 22-6. Serial Data Transfer Timing

ELECTRICAL DATA S3CB519

Table 22-6. BLD Electrical Characteristics

(T_A = 25 °C, V_{DD} = 2.2 V to 5.5 V, V_{SS} = 0 V)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
BLD Voltage	VB0	Internal V _{DD} mode	Typ-0.15	2.4	Typ+0.15	V
	VB1			2.7		
	VB2			3.0		
	VB3			3.3		
	VB4		Typ-0.3	4.0	Typ+0.3	
	VB5			4.5		
	VB6	External Input mode,	Typ-0.15	1.2	Typ+0.15	
		V _{DD} = 2.2 V–3.0 V				
	VB7	External Input mode,	Typ-0.3	1.2	Typ+0.3	
		V _{DD} = 3.0 V–5.5 V				
BLD Current	IBLD	V _{DD} = 5.5 V	_	50	100	μΑ
BLD Response	TB	V _{DD} = 5.5 V	_	1/fw ^(note)	_	μs

NOTE: The fw must be greater than $10 \mu sec.$

Table 22-7. ADC Electrical Characteristics

 $(T_A = -25~^{\circ}C \text{ to + }85~^{\circ}C,~V_{DD} = 3.0~V~\text{ to }5.5~V,~V_{SS} = 0~V)$

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
ADC Current	IADC	V _{DD} = 3.3 V	_	1.5	3	mA
Sampling Frequency	_	-	_	8	11	kHz
Resolution	-	Measurement Bandwidth: 20 Hz-4 kHz, Full scale input sine wave: 1 kHz, Sampling frequency: 8 kHz	_	14	_	bits
Signal to Distortion ratio	_		70	75	-	dB
Offset Error	_		_	_	±20	mV
Input Voltage Range	_	V _{DD} = 3.3 V	_	2	-	V _{PP}

NOTE: All the data in this ADC characteristics is measured in the condition of $V_{DD} = 3.3 \text{ V}$



S3CB519 ELECTRICAL DATA

Table 22-8. DAC Electrical Characteristics

 $(T_A = -25$ °C to + 85 °C, $V_{DD} = 2.4$ V to 5.5 V, $V_{SS} = 0$ V)

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
DAC Current	IDAC	V _{DD} = 5.5 V	-	1.5	3.0	mA
Resolution	-	-	_	8	-	bits
Absolute Accuracy	_		-3	_	3	LSB
Differential Linearity Error	DLE		-1.5	_	1.5	LSB
Output Delay	_		_	_	250	μs
Output Load Resistance	Ro		_	10	_	kΩ
Output Level (peak to peak)	_	$T_A = -30 ^{\circ}\text{C}$ to $+60 ^{\circ}\text{C}$	1.2	1.5	1.88	V _{PP}
Regulator Bias voltage	_	V _{DD} = 3.3 V	-	V _{DD} /2	-	V
Output Interval	_	OSC = 4.096 MHz; AD/DA clock input = 8 kHz	-	31	_	μs

ELECTRICAL DATA S3CB519

Table 22-9. Main Oscillator Frequency (f_{OSC}1)

(T_A = -25 $^{\circ}$ C to + 85 $^{\circ}$ C V_{DD} = 2.2 V to 5.5 V)

Oscillator	Clock Circuit	Test Condition	Min	Тур	Max	Unit
Crystal/Ceramic	XIN XOUT C1 C2	V _{DD} = 2.2 V–5.5 V	0.4	-	4.1	MHz
		V _{DD} = 2.5 V–5.5 V			6.2	
		V _{DD} = 3.0 V–5.5 V			8.2	
External clock	XIN XOUT	V _{DD} = 2.2 V–5.5 V	0.4	-	4.1	MHz
		V _{DD} = 2.5 V–5.5 V			6.2	
		V _{DD} = 3.0 V–5.5 V			8.2	
RC	XIN XOUT	R = 20 Kohm, V _{DD} = 5 V	_	2	_	MHz

NOTE: Oscillation frequency and Xin input frequency data are for oscillator characteristics only.

Table 22-10. Main Oscillator Clock Stabilization Time (T_{ST1})

 $(T_A = -25 \, ^{\circ}C + 85 \, ^{\circ}C, \, V_{DD} = 4.5 \, V \text{ to } 5.5 \, V)$

. //	, DB ,				
Oscillator	Test Condition	Min	Тур	Max	Unit
Crystal	V _{DD} = 4.5 V to 5.5 V	_	ı	10	ms
Ceramic	Stabilization occurs when V_{DD} is equal to the minimum oscillator voltage range. V_{DD} = 4.5 V to 5.5 V	_	ı	4	ms
External clock	X_{IN} input high and low level width (t_{XH}, t_{XL})	50	_	_	ns

NOTE: Oscillation stabilization time (T_{ST1}) is the time required for the CPU clock to return to its normal oscillation frequency after a power-on occurs, or when Stop mode is ended by a nRESET signal.



S3CB519 ELECTRICAL DATA

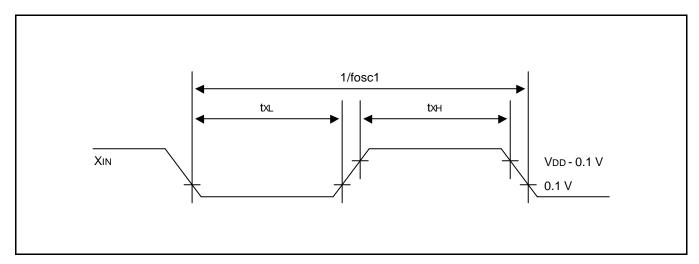


Figure 22-7. Clock Timing Measurement at X_{IN}

Table 22-11. Sub Oscillator Frequency (f_{OSC2})

$$(T_A = -25~^{\circ}C + 85~^{\circ}C, V_{DD} = 2.2~V \text{ to } 5.5~V)$$

Oscillator	Clock Circuit	Test Condition	Min	Тур	Max	Unit
Crystal	XT IN XT OUT R C1 C2	Crystal oscillation frequency $C1 = 22 \text{ pF}, C2 = 33 \text{ pF}$ $R = 39 \text{ k}\Omega$	32	32.768	35	kHz

NOTE: Oscillation frequency and XTin input frequency data are for oscillator characteristics only.

Table 22-12. Sub Oscillator (Crystal) Start up Time (t_{ST2})

(T_A = -25
$$^{\circ}$$
C + 85 $^{\circ}$ C, V_{DD} = 2.2 V to 5.5 V)

Oscillator	Test Condition	Min	Тур	Max	Unit
Normal mode	$V_{DD} = 4.5 \text{ V} \text{ to } 5.5 \text{ V}$	_	1	2	sec
	$V_{DD} = 2.2 \text{ V} \text{ to } 4.5 \text{ V}$	-	-	10	
Strong mode	V _{DD} = 3.0 V to 5.5 V	-	-	6	
	V _{DD} = 2.2 V to 3.0 V	_	_	2	

NOTE: Oscillation stabilization time (t_{ST2}) is the time required for the oscillator to it's normal oscillation when stop mode is released by interrupts.



ELECTRICAL DATA S3CB519

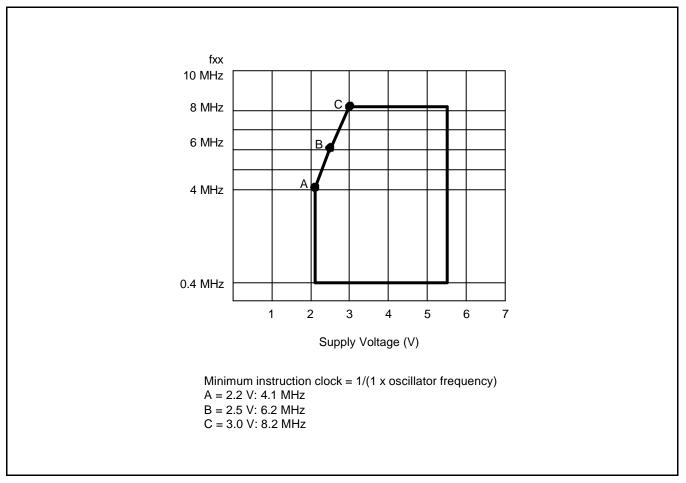


Figure 22-8. Operating Voltage Range

S3CB519 MECHANICAL DATA

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OVERVIEW

The S3CB519 microcontroller is currently available in a 100-pin QFP and TQFP package.

MECHANICAL DATA S3CB519

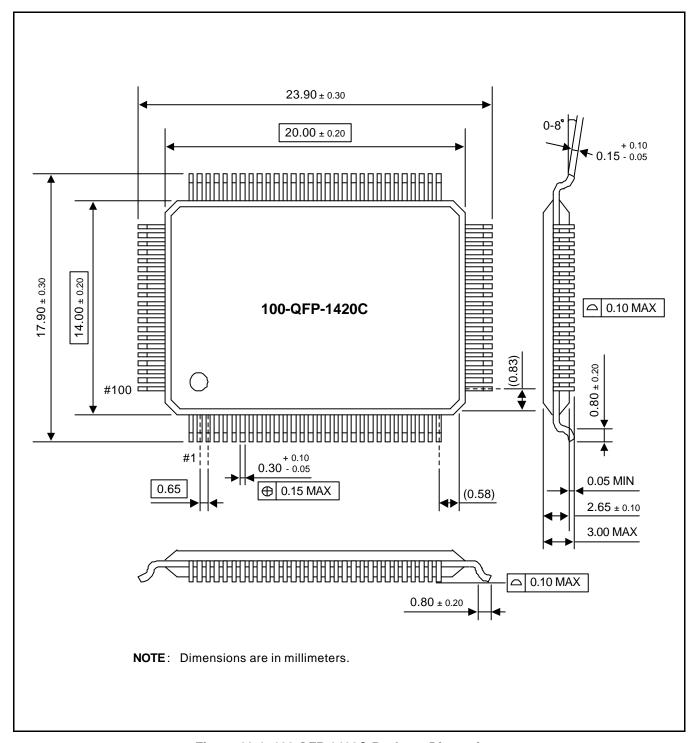


Figure 23-1. 100-QFP-1420C Package Dimensions

S3CB519 MECHANICAL DATA

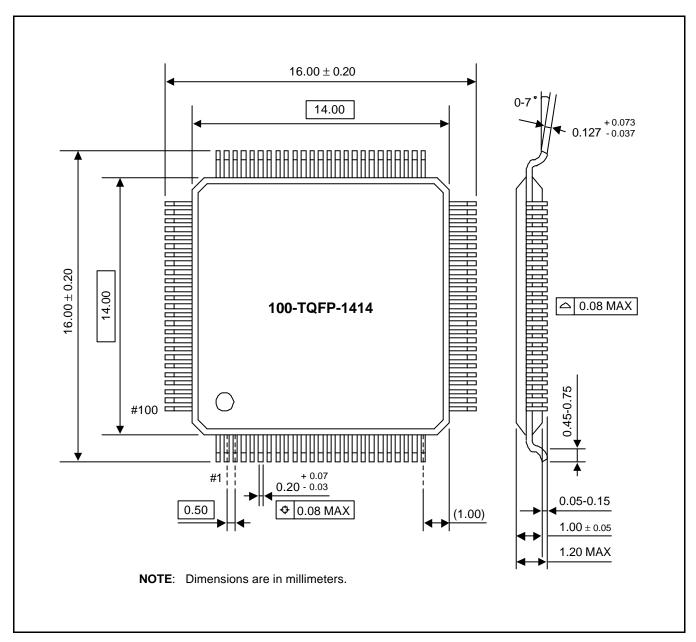


Figure 23-2. 100-TQFP-1414 Package Dimensions

MECHANICAL DATA S3CB519

NOTES



S3CB519 DEVELOPMENT TOOLS

24 DEVELOPMENT TOOLS

OVERVIEW

Samsung provides a powerful and easy-to-use development support system in turnkey form. The development support system is configured with a host system, debugging tools, and support software. For the host system, any standard computer that operates with windows95/98/NT as its operating system can be used. One type of debugging tool including hardware and software is provided: the effective cost and powerful in-circuit emulator, InvisibleMDS, for CalmRISC8. Samsung also offers support software that includes debugger, Compiler, Assembler, and a program for setting options.

CALMSHINE: IDE(INTEGRATED DEVELOPMENT ENVIRONMENT)

CalmRISC8 Samsung Host Interface for In-circuit Emulator, CalmSHINE, is a multi window based debugger for CalmRISC8. CalmSHINE provides pull-down, pop-up and tool-bar menus, mouse support, function/hot keys, syntax highlight, tool-tip, drag-and-drop and context-sensitive hyper-linked help. It has an advanced, multiple-windowed user interface that emphasizes ease of use. Each window can be sized, moved, scrolled, highlighted, added or removed, docked or undocked completely.

INVISIBLE MDS: IN-CIRCUIT EMULATOR

The evaluation chip of CalmRISC8 has a basic debugging utility block. Using this block, evaluation chip directly interfaces with host through only communication wire. So, InvisibleMDS offers simple and powerful debugging environment.

CALMRISC8 C-COMPILER: CALM8CC

The CalmRISC8 Compiler offers the standard features of the C language, plus many extensions for MCU applications, such as interrupt handling in C and data placement controls, designed to take fully advantage of CalmRISC8 facilities. It conforms to the ANSI specification. It supports standard library of functions applicable to MCU systems. The standard library also conforms to the ANSI standard. It generates highly size-optimized code for CalmRISC8 by fully utilizing CalmRISC8 architecture. It is available in a Windows version integrated with the CalmSHINE.

CALMRISC8 RELOCATABLE ASSEMBLER: CALM8ASM

The CalmRISC8 Assembler is a relocatable assembler for Samsung's CalmRISC8 MCU and its MAC816 and MAC2424 coprocessors. It translates a source file containing assembly language statements into a relocatable machine object code file in Samsung format. It runs on WINDOWS95 compatible operating systems. It supports macros and conditional assembly. It produces the relocatable object code only, so the user should link object files. Object files can be linked with other object files and loaded into memory.

CALMRISC8 LINKER: CALM8LINK

The CalmRISC8 Linker combines Samsung object format files and library files and generates absolute, machine-code executable hex programs or binary files for CalmRISC8 MCU and its MAC816 and MAC2424 coprocessors. It generates the map file, which shows the physical addresses to which each section and symbol is bounded, start addresses of each section and symbol, and size of them. It runs on WINDOWS95 compatible operating systems.



DEVELOPMENT TOOLS S3CB519

EMULATION PROBE BOARD CONFIGURATION

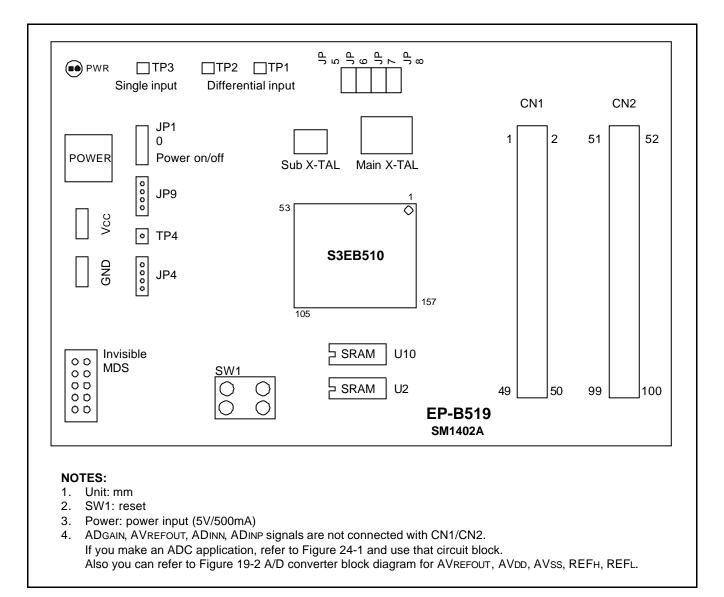


Figure 24-1. Emulation Probe Board Configuration

Invisible MDS Connector = 10-pin/normal Pitch (2.54mm)

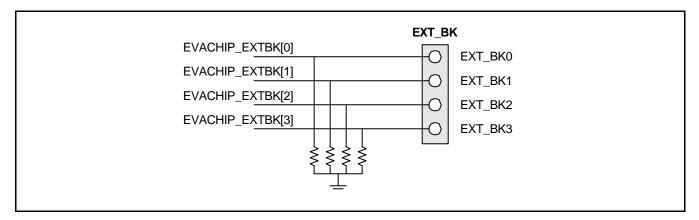
Pin No.	Pin Name	Pin No.	Pin Name
1	V_{DD}	6	PTD0_TxD
2	PNTRST_NINIT	7	GND
3	PTCK_MCLK	8	UCLK
4	PTMS	9	JTAGSEL
5	PTDI_RxD	10	_



S3CB519 DEVELOPMENT TOOLS

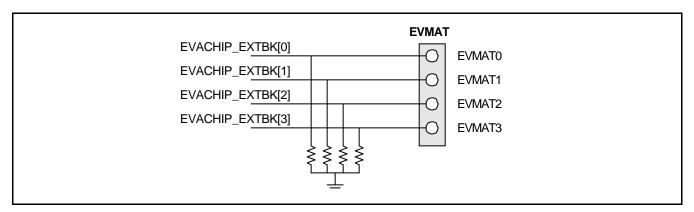
EXTERNAL EVENT INPUT HEADERS (JP4)

These input headers are used to add the break condition to the core status externally when the break using CalmBreaker occurs in the evaluation chip.



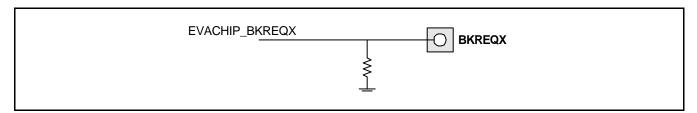
EVENT MATCH OUTPUT HEADERS (JP9)

Four event match signals and one combination event signal are occurred by the CalmBreaker in the evaluation chip. These signals are transmitted through the evaluation chip.



EXTERNAL BREAK INPUT HEADERS (TP4)

This input pin is used to break during the evaluation chip run.



DEVELOPMENT TOOLS S3CB519

A/D CONVERTER FUNCTION BLOCK

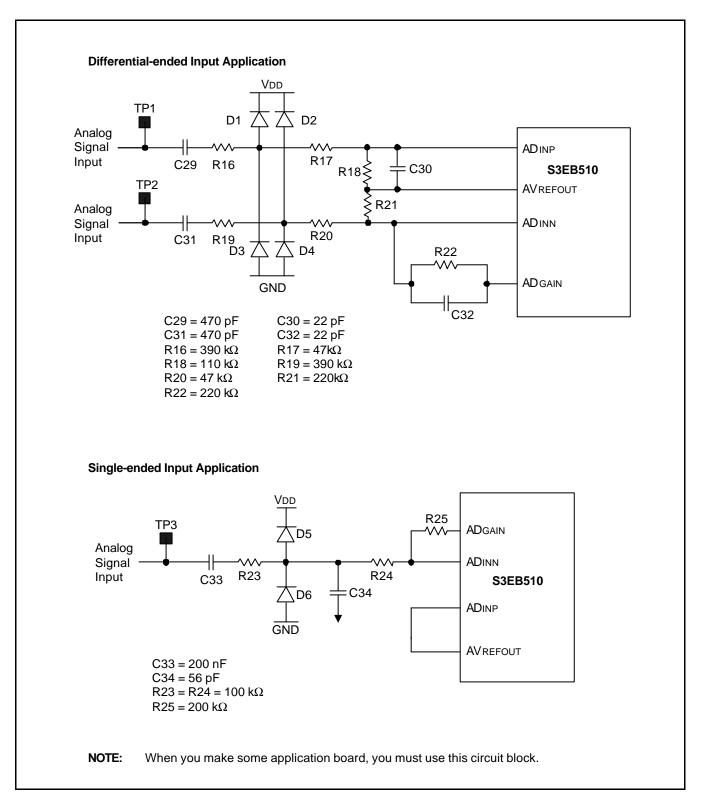


Figure 24-2. A/D converter Function Block Diagram



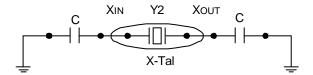
S3CB519 DEVELOPMENT TOOLS

COMMUNICATION SELECTION

JP5-JP8 State	Description
Differential Differential Differential Single Single Single JP5	When differential-ended input application is used for the ADC, JP5–JP8 must be set.
Differential Differential Differential Differential DP5	When Single-ended input application is used for the ADC, JP5–JP8 must be set.

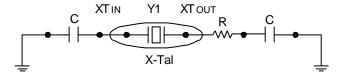
USE CLOCK SETTING FOR EXTERNAL CLOCK MODE

Proper crystal and capacitors for main clock should be inserted into pin socket on the IE Board as follows;



SUB CLOCK SETTING

For sub-clock mode a crystal, 32.768 kHz and capacitors should be inserted into pin socket on the IE Board as follows;



NOTE: The value of resistor is 39 k Ω .

DEVELOPMENT TOOLS S3CB519

CN1, CN2 PIN ASSIGNMENT

CN1,2 are the signals of IE-B519 and their pin assignment is the same as the pin of S3CB519.

CN1	Function	CN1	Function	CN2	Function	CN2	Function
1	P4.1/COM9	2	P4.2/COM10	51	P3.7/SEG40	52	P5.0/SEG39
3	P4.3/COM11	4	P4.4/COM12	53	P5.1/SEG38	54	P5.2/SEG37
5	P4.5/COM13	6	P4.6/COM14	55	P5.3/SEG36	56	P5.4/SEG35
7	P4.7/COM15	8	P0.0	57	P5.5/SEG34	58	P5.6/SEG33
9	P0.1	10	P0.2	59	P5.7/SEG32	60	P5.8/SEG31
11	P0.3	12	P0.4	61	P5.9/SEG30	62	P5.10/SEG29
13	P0.5	14	P0.6	63	P5.11/SEG28	64	P5.12/SEG27
15	VDD	16	VSS	65	P5.13/SEG26	66	P5.14/SEG25
17	NC	18	NC	67	P5.15/SEG24	68	SEG23
19	NC	20	NC	69	SEG22	70	SEG21
21	NC	22	RSSETB EXT	71	SEG20	72	SEG19
23	DAC	24	NC	73	SEG18	74	SEG17
25	NC	26	NC	75	CKSEG16	76	PDSEG15
27	NC	28	NC	77	PDSEG14	78	PDSEG13
29	NC	30	NC	79	PDSEG12	80	PDSEG11
31	NC	32	P1.0	81	PDSEG10	82	PDSEG9
33	P1.1	34	P1.2	83	PDSEG8	84	PDSEG7
35	P1.3	36	P2.0/SEG55	85	PDSEG6	86	PDSEG5
37	P2.1/SEG54	38	P2.2/SEG53	87	PDSEG4	88	PDSEG3
39	P2.3/SEG54	40	P2.4/SEG51	89	PDSEG2	90	PDSEG1
41	P2.5/SEG54	42	P2.6/SEG49	91	PDSEG0	92	СОМО
43	P2.7/SEG54	44	P3.0/SEG47	93	COM1	94	COM2
45	P3.1/SEG54	46	P3.2/SEG45	95	COM3	96	COM4
47	P3.3/SEG54	48	P3.4/SEG43	97	COM5	98	COM6
49	P3.5/SEG54	50	P3.6/SEG41	99	COM7	100	P4.0/COM8



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов:
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001:
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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